















ADS52J90

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ADS52J90 10ビット、12ビット、14ビットのマルチチャネル、 低消費電力、LVDSおよびJESD出力搭載の高速ADC

特長

- 16チャネルADCで、8、16、32ビットの入力を 変換するよう構成可能
- 10、12、14ビット分解能のモード
- 最大ADC変換速度:
 - 10ビット・モードで100MSPS
 - 12ビット・モードで80MSPS
 - 14ビット・モードで65MSPS
- 16個のADCを、次の変換用に構成可能:
 - 8入力でサンプリング速度が ADC変換速度の2倍
 - 16入力でサンプリング速度が ADC変換速度の1倍
 - **32**入力でサンプリング速度が ADC変換速度の0.5倍
- 16X、14X、12X、10Xシリアル化によるLVDS 出力
- 5GbpsのJESDインターフェイス:
 - 16入力および32入力モードでサポート
 - JESD204Bサブクラス0、1、2
 - JESDレーンごとに2、4、8チャネル
- オプションのデジタルI-Q復調器(1)
- 電源: 1.2V、1.8V
- 2Vpp差動入力、0.8V同相
- 差動またはシングル・エンド入力クロック
- 信号対雑音比(SNR):
 - 10ビット・モードで61dBFS
 - 12ビット・モードで70dBFS
 - 14ビット・モードで73.5dBFS
- 100MSPS時の消費電力: 41mW/チャネル
- パッケージ: NFBGA-198 (9mm×15mm)
- 鉛フリー(RoHS準拠)およびグリーン

アプリケーション

- **超音波イメージング**
- ポータブル機器
- ソナーおよびレーダー
- 高速のマルチチャネル・データ収集
- 本書では詳説しません。詳細情報については、工場にお問い合わ せください。

3 概要

ADS52J90は低消費電力、高性能、16チャネルのアナロ グ/デジタル・コンバータ(ADC)です。各ADCの変換速度 は、10ビット・モードで最高100MSPSです。ADC分解能 が高い値に設定された場合、最大変換速度は低下しま す。

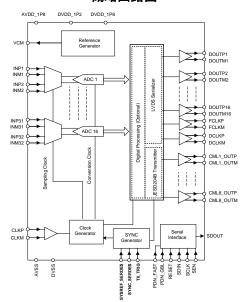
このデバイスは、8、16、32の入力を受け付けるよう構成可 能です。32入力のモードでは、各ADCがそれぞれ2つの 異なる入力を交互にサンプリングおよび変換するため、実 質的なサンプリング速度はADC変換速度の半分です。8 入力のモードでは、2つのADCが同じ入力をインターリー ブ形式で変換し、実質的なサンプリング速度はADC変換 速度の2倍です。ADCは、変換速度に応じて電力をス ケーリングするよう設計されています。

製品情報

型番	パッケージ	本体サイズ(公称)
ADS52J90	NFBGA (198)	9.00mm×15.00mm

(1) 利用可能なすべてのパッケージについては、このデータシートの末 尾にある注文情報を参照してください。

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	HPF_ROUND_EN_CH9-16 bits in last paragraph of Digi			
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	追加 Interfacing SYNC~ and SYSREF Between the FPG	A and ADC	s section	65
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	変更 bit 5 from <i>HPF_ROUND_EN</i> to <i>HPF_ROUND_EN_</i>	<i>CH1-8</i> in Re	ble egister 15	85 99 109
		<i>CH1-8</i> in Re	ble egister 15	85 99 109
	変更 bit 5 from <i>HPF_ROUND_EN</i> to <i>HPF_ROUND_EN_</i>	<i>CH1-8</i> in Roter 2Dh	bleegister 15	85 99 109 123
	変更 bit 5 from <i>HPF_ROUND_EN</i> to <i>HPF_ROUND_EN_</i> 変更 bit 5 from 0 to <i>HPF_ROUND_EN_CH9-16</i> in Regist 変更 description for JESD_RESET1 in Register 70	<i>CH1-8</i> in Roter 2Dh	bleegister 15	85 99 109 123 135
	変更 bit 5 from <i>HPF_ROUND_EN</i> to <i>HPF_ROUND_EN_</i> 変更 bit 5 from 0 to <i>HPF_ROUND_EN_CH9-16</i> in Regist	<i>CH1-8</i> in Roter 2Dh	bleegister 15	85 99 109 123 135
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<u></u>	
Added SPI_DIG_EN to Digital Inputs section title of Digital Characteristics table	
Changed V _{OC-CML} parameter name in <i>JESD Interface Timing Requirements</i> table	
Added 47	25
Added LVDS, JESD discussion to second paragraph of Overview section	51
• 「コミュニティ・リソース」セクションを追加	149
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5 概要(続き)

ADC出力はシリアル化され、低電圧差動信号(LVDS)インターフェイスにより、フレーム・クロックおよび高速ビット・クロックとともに出力されます。

このデバイスにはオプションのJESD204Bインターフェイスもあり、16入力および32入力モードで使用できます。このインターフェイスは、最高5Gbpsで動作します。

ADS52J90は9mm×15mm、0.8mmピッチのNFBGA-198パッケージで供給され、-40 $^{\circ}$ ~+85 $^{\circ}$ の温度範囲で動作が規定されています。



6 Pin Configuration and Functions

ZZE Package NFBGA-198 (15 mm × 9 mm) Top View

	1	2	3	4	5	6	7	8	9	10	11
Α	INM2	INP2	INP1	AVDD_1P8	SDIN	RESET	DVDD_1P2	DVSS	CML1_OUTP	CML1_OUTM	CML2_OUTP
В	INM3	INP3	INM1	AVSS	SEN	SPI_DIG_EN	SCLK	DVDD_1P2	DOUTP1	DOUTM1	CML2_OUTM
С	INM5	INP5	INP4	AVSS	SDOUT	PDN_FAST	PDN_GBL	DVDD_1P2	DOUTP2	DOUTM2	CML3_OUTP
D	INM6	INP6	INM4	AVSS	NC	TX_TRIG	DVSS	DVDD_1P2	DOUTP3	DOUTM3	CML3_OUTM
E	INM7	INP7	INM8	INP8	NC	AVDD_1P8	DVSS	DVDD_1P8	DOUTP4	DOUTM4	CML4_OUTP
F	INM9	INP9	INM10	INP10	VCM	AVDD_1P8	DVDD_1P2	DVDD_1P8	DOUTP5	DOUTM5	CML4_OUTM
G	INM11	INP11	INM12	INP12	AVDD_1P8	AVDD_1P8	DVDD_1P2	DVDD_1P8	DOUTP6	DOUTM6	DOUTM8
н	INM13	INP13	INM14	INP14	AVSS	AVSS	DVSS	DVSS	DOUTP7	DOUTM7	DOUTP8
J	INM15	INP15	INM16	INP16	AVSS	AVSS	DVSS	DVSS	FCLKP	DVDD_1P8	DCLKP
K	INM17	INP17	INM18	INP18	AVSS	AVSS	DVSS	DVSS	FCLKM	DVSS	DCLKM
L	INM19	INP19	INM20	INP20	AVSS	AVSS	DVSS	DVSS	DOUTP10	DOUTM10	DOUTP9
М	INM21	INP21	INM22	INP22	AVDD_1P8	AVDD_1P8	DVDD_1P2	DVDD_1P8	DOUTP11	DOUTM11	DOUTM9
N	INM23	INP23	INM24	INP24	NC	AVDD_1P8	DVDD_1P2	DVDD_1P8	DOUTP12	DOUTM12	CML8_OUTM
Р	INM25	INP25	INM26	INP26	NC	AVDD_1P8	SYNCM_ SERDES	DVDD_1P8	DOUTP13	DOUTM13	CML8_OUTP
R	INM27	INP27	INM28	AVSS	AVSS	DVSS	SYNCP_ SERDES	DVDD_1P2	DOUTP14	DOUTM14	CML7_OUTM
Т	INM29	INP29	INP28	AVSS	AVSS	DVDD_1P2	SYSREFM_ SERDES	DVDD_1P2	DOUTP15	DOUTM15	CML7_OUTP
U	INM30	INP30	INM32	AVSS	CLKM	AVSS	SYSREFP_ SERDES	DVDD_1P2	DOUTP16	DOUTM16	CML6_OUTM
٧	INM31	INP31	INP32	AVDD_1P8	CLKP	AVSS	DVDD_1P2	DVSS	CML5_OUTP	CML5_OUTM	CML6_OUTP



Pin Functions⁽¹⁾

Pin Functions ⁽¹⁾					
	PIN	I/O	DESCRIPTION		
NAME	NO.		DESCRIPTION		
AVDD_1P8	A4, E6, F6, G5, G6, M5, M6, N6, P6, V4	Р	1.8-V analog supply voltage		
AVSS	B4, C4, D4, H5, H6, J5, J6, K5, K6, L5, L6, R4, R5, T4, T5, U4, U6, V6	G	Analog ground		
CLKM	U5		Differential clock input pins. A single-ended clock is also supported.		
CLKP	V5	ı	See the Clock Input section for further details.		
CML1_OUTM	A10	0	IFOD subsublings 4		
CML1_OUTP	A9	0	JESD output lane 1		
CML2_OUTM	B11		1500		
CML2_OUTP	A11	0	JESD output lane 2		
CML3_OUTM	D11		1500		
CML3_OUTP	C11	0	JESD output lane 3		
CML4_OUTM	F11	_			
CML4_OUTP	E11	0	JESD output lane 4		
CML5_OUTM	V10				
CML5_OUTP	V9	0	JESD output lane 5		
CML6_OUTM	U11				
CML6_OUTP	V11	0	JESD output lane 6		
CML7_OUTM	R11				
CML7_OUTP	T11	0	JESD output lane 7		
CML8_OUTM	N11				
CML8_OUTP	P11	0	JESD output lane 8		
DCLKM	K11				
DCLKP	J11	0	LVDS bit clock output		
DOUTM1	B10				
DOUTP1	B9	0	LVDS data lane 1		
DOUTM2	C10				
DOUTP2	C9	0	LVDS data lane 2		
DOUTM3	D10				
DOUTP3	D9	0	LVDS data lane 3		
DOUTM4	E10				
DOUTP4	E9	0	LVDS data lane 4		
DOUTM5	F10				
DOUTP5	F9	0	LVDS data lane 5		
DOUTM6	G10				
DOUTP6	G9	0	LVDS data lane 6		
DOUTM7	H10				
DOUTP7	H9	0	LVDS data lane 7		
DOUTM8	G11				
DOUTP8	H11	0	LVDS data lane 8		
DOUTM9	M11				
DOUTP9	L11	0	LVDS data lane 9		
DOUTM10	L10				
DOUTP10	L9	0	LVDS data lane 10		
DOUTM11	M10				
DOUTP11	M9	0	LVDS data lane 11		
DOUTM12	N10				
DOUTP12	N10 N9	0	LVDS data lane 12		
DOUTF 12	INS				

⁽¹⁾ If the JESD interface is not used, then do not connect the CMLx, SYNCx, and SYSREFx pins. If the LVDS interface is not used, then do not connect DOUTx, DCLKx, and FCLKx.



Pin Functions⁽¹⁾ (continued)

D	IN		,
NAME	NO.	I/O	DESCRIPTION
DOUTM13	P10	0	LVDS data lane 13
DOUTP13 DOUTM14	P9 R10		
DOUTP14	R9	0	LVDS data lane 14
DOUTM15	T10	0	LVDS data lane 15
DOUTP15	T9		
DOUTM16 DOUTP16	U10 U9	0	LVDS data lane 16
DVDD_1P2	A7, B8, C8, D8, F7, G7, M7, N7, R8, T6, T8, U8,	Р	1.2-V digital supply voltage
DVDD_1P8	E8, F8, G8, J10, M8, N8, P8	Р	1.8-V digital supply voltage
DVSS	A8, D7, E7, H7, H8, J7, J8, K7, K8, K10, L7, L8, R6, V8	G	Digital ground
FCLKM	K9	0	LVDS frame clock output
FCLKP	J9	0	LVDS frame clock output
INM1	B3	ı	Differential analog input 1 pins; see 表 1 for mapping to external inputs in 8-, 16-, and
INP1	A3	ı	32-input modes
INM2	A1	ı	Differential analog input 2 pins; see 表 1 for mapping to external inputs in 8-, 16-, and
INP2	A2	'	32-input modes
INM3	B1	ı	Differential analog input 3 pins; see 表 1 for mapping to external inputs in 8-, 16-, and
INP3	B2	I	32-input modes
INM4	D3		Differential analog input 4 pins; see 表 1 for mapping to external inputs in 8-, 16-, and
INP4	C3	I	32-input modes
INM5	C1	ı	Differential analog input 5 pins; see 表 1 for mapping to external inputs in 8-, 16-, and
INP5	C2	ļ	32-input modes
INM6	D1	I	Differential analog input 6 pins; see 表 1 for mapping to external inputs in 8-, 16-, and
INP6	D2	ļ	32-input modes
INM7	E1	I	Differential analog input 7 pins; see 表 1 for mapping to external inputs in 8-, 16-, and
INP7	E2	-	32-input modes
INM8	E3	ı	Differential analog input 8 pins; see 表 1 for mapping to external inputs in 8-, 16-, and
INP8	E4	ļ	32-input modes
INM9	F1	ı	Differential analog input 9 pins; see 表 1 for mapping to external inputs in 8-, 16-, and
INP9	F2		32-input modes
INM10	F3	I	Differential analog input 10 pins; see 表 1 for mapping to external inputs in 8-, 16-, and
INP10	F4	'	32-input modes
INM11	G1	ı	Differential analog input 11 pins; see 表 1 for mapping to external inputs in 8-, 16-, and
INP11	G2	ı	32-input modes
INM12	G3	ı	Differential analog input 12 pins; see 表 1 for mapping to external inputs in 8-, 16-, and
INP12	G4	ı	32-input modes
INM13	H1	ı	Differential analog input 13 pins; see 表 1 for mapping to external inputs in 8-, 16-, and
INP13	H2	ı	32-input modes
INM14	H3	ı	Differential analog input 14 pins; see 表 1 for mapping to external inputs in 8-, 16-, and
INP14	H4	'	32-input modes
INM15	J1	I	Differential analog input 15 pins; see 表 1 for mapping to external inputs in 8-, 16-, and
INP15	J2		32-input modes
INM16	J3	ı	Differential analog input 16 pins; see 表 1 for mapping to external inputs in 8-, 16-, and
INP16	J4		32-input modes
INM17	K1	ı	Differential analog input 17 pins; see 表 1 for mapping to external inputs in 8-, 16-, and
INP17	K2	'	32-input modes



Pin Functions⁽¹⁾ (continued)

Pin Functions ⁽¹⁾ (continued)						
	PIN	1/0	DESCRIPTION			
NAME	NO.					
INM18	K3	- 1	Differential analog input 18 pins; see 表 1 for mapping to external inputs in 8-, 16-, and 32-input modes			
INP18	K4		32-input modes			
INM19	L1	- 1	Differential analog input 19 pins; see 表 1 for mapping to external inputs in 8-, 16-, and 32-input modes			
INP19	L2		<u>'</u>			
INM20	L3	- 1	Differential analog input 20 pins; see 表 1 for mapping to external inputs in 8-, 16-, and 32-input modes			
INP20	L4					
INM21	M1	- 1	Differential analog input 21 pins; see 表 1 for mapping to external inputs in 8-, 16-, and 32-input modes			
INP21	M2		<u>'</u>			
INM22	M3	- 1	Differential analog input 22 pins; see 表 1 for mapping to external inputs in 8-, 16-, and 32-input modes			
INP22	M4		'			
INM23	N1	- 1	Differential analog input 23 pins; see 表 1 for mapping to external inputs in 8-, 16-, and 32-input modes			
INP23	N2		<u> </u>			
INM24	N3	- 1				
INP24	N4		<u> </u>			
INM25	P1	- 1	Differential analog input 25 pins; see 表 1 for mapping to external inputs in 8-, 16-, and 32-input modes			
INP25	P2					
INM26	P3	- 1	Differential analog input 26 pins; see 表 1 for mapping to external inputs in 8-, 16-, and			
INP26	P4		<u> </u>			
INM27	R1	- 1	Differential analog input 27 pins; see 表 1 for mapping to external inputs in 8-, 16-, and 32-input modes			
INP27	R2		<u> </u>			
INM28	R3	- 1	Differential analog input 28 pins; see 表 1 for mapping to external inputs in 8-, 16-, and 32-input modes			
INP28	T3		<u> </u>			
INM29	T1	- 1	Differential analog input 29 pins; see 表 1 for mapping to external inputs in 8-, 16-, and 32-input modes			
INP29	T2					
INM30	U1	- 1	Differential analog input 30 pins; see 表 1 for mapping to external inputs in 8-, 16-, and 32-input modes			
INP30	U2					
INM31	V1	- 1				
INP31	V2		<u> </u>			
INM32	U3	- 1				
INP32	V3 D5, E5, N5, P5		'			
NC	D5, E5, N5, P5	_				
PDN_FAST	C6	I	For active high, a 1.8-V logic level is recommended.			
PDN_GBL	C7	I	Global power-down control input (active high) with an internal pulldown resistor of 20 kΩ. For active high, a 1.8-V logic level is recommended.			
SPI_DIG_EN	B6	I	Reserved for digital functionality. This pin can be left floating or be connected to the 1.8-V supply. This pin has an internal pullup resistor of 20 k Ω .			
RESET	A6	1	Hardware reset pin (active high) with an internal pulldown resistor of 20 k Ω . For active high, a 1.8-V logic level is recommended.			
SCLK	В7	1	Serial interface clock input with an internal pulldown resistor of 20 k Ω . For active high, a 1.8-V logic level is recommended.			
SDIN	A5	ı	Serial interface data input with an internal pulldown resistor of 20 k Ω . For active high, a			
SDOUT	C5	0	Serial interface data readout. High impedance when readout is disabled. 1.8-V logic			
SEN	B5	I	Serial interface enable with an internal pullup resistor of 20 kΩ. 1.8-V logic level is			
TX_TRIG	D6	ı	1.8-V logic; a pulse on TX_TRIG must be applied after power-up to ensure that all			
IN_INIO	50	'	Differential analog input 24 pins; see 表 1 for mapping to external inputs in 8-, 10 32-input modes Differential analog input 25 pins; see 表 1 for mapping to external inputs in 8-, 10 32-input modes Differential analog input 26 pins; see 表 1 for mapping to external inputs in 8-, 10 32-input modes Differential analog input 27 pins; see 表 1 for mapping to external inputs in 8-, 10 32-input modes Differential analog input 28 pins; see 表 1 for mapping to external inputs in 8-, 10 32-input modes Differential analog input 29 pins; see 表 1 for mapping to external inputs in 8-, 10 32-input modes Differential analog input 30 pins; see 表 1 for mapping to external inputs in 8-, 10 32-input modes Differential analog input 31 pins; see 表 1 for mapping to external inputs in 8-, 10 32-input modes Differential analog input 32 pins; see 表 1 for mapping to external inputs in 8-, 10 32-input modes Differential analog input 32 pins; see 表 1 for mapping to external inputs in 8-, 10 32-input modes Differential analog input 32 pins; see 表 1 for mapping to external inputs in 8-, 10 32-input modes Differential analog input 32 pins; see 表 1 for mapping to external inputs in 8-, 10 32-input modes Differential analog input 32 pins; see 表 1 for mapping to external inputs in 8-, 10 32-input modes Differential analog input 32 pins; see 表 1 for mapping to external inputs in 8-, 10 32-input modes Differential analog input 32 pins; see 表 1 for mapping to external inputs in 8-, 10 32-input modes Differential analog input 32 pins; see 表 1 for mapping to external inputs in 8-, 10 32-input modes Differential analog input 32 pins; see 表 1 for mapping to external inputs in 8-, 10 32-input modes Differential analog input 30 pins; see 表 1 for mapping to external inputs in 8-, 10 32-input modes Differential analog input 30 pins; see 表 1 for mapping to external inputs in 8-, 10 32-input modes Differential analog input 30 pins; see 表 1 for mapping to external inputs in 8-, 10 32-input modes Differential analog input 20 pins; see 表 1 f			
SYNCM_SERDES	P7		Erama aunahranization input on par IESDOAD standard			
SYNCP_SERDES	R7	- 1	Frame synumonization input as per JESD204B standard			

(2) See the Device Synchronization Using TX_TRIG section for more details on synchronization using TX_TRIG.



Pin Functions⁽¹⁾ (continued)

P	IN	I/O	DESCRIPTION
NAME	NO.	1/0	DESCRIPTION
SYSREFM_SERDES	T7		Frame clock and local multiframe clock (LMFC) synchronization input as per
SYSREFP_SERDES	U7		JESD204B, subclass 1 standard
VCM	F5	0	Common-mode output pin for biasing analog input signals. Connect a 10-µF capacitor to ground.

7 Specifications

7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1)

		MIN	MAX	UNIT
	AVDD_1P8	-0.3	2.2	
Voltage	DVDD_1P2	-0.3	1.35	V
	DVDD_1P8	-0.3	2.2	
Analog input pins (INM _i ,	INP _i)	-0.3	Minimum [2.2, (AVDD_1P8 + 0.3)]	V
CLKP, CLKM		-0.3	.3 Minimum [2.2, (AVDD_1P8 + 0.3)]	
Digital control pins	PDN_GBL, PDN_FAST, RESET, SCLK, SDIN, SEN, TX_TRIG, SPI_DIG_EN, SYNCM_SERDES, SYNCP_SERDES, SYSREFM_SERDES, SYSREFP_SERDES	-0.3	Minimum [2.2, (DVDD_1P8 + 0.3)]	V
Maximum operating jund	ction temperature, T _{JMax}		105	°C
Storage temperature, T _s	tg	-55	150	°C

⁽¹⁾ Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

7.2 ESD Ratings

			VALUE	UNIT
V	Floatroatatio dipohorgo	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 (1)	±1000	
V _(ESD)	Electrostatic discharge	Charged device model (CDM), per JEDEC specification JESD22-C101 (2)	±250	V

⁽¹⁾ JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

⁽²⁾ JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



7.3 Recommended Operating Conditions

	PARAMETER	TEST CONDITIONS	MIN	NOM	MAX	UNIT	
TEMPERATURE	<u> </u>		•				
T _A	Ambient		-40		85	°C	
SUPPLIES							
V _(AVDD_1P8)	1.8-V analog supply voltage		1.7	1.8	1.9	V	
V _(DVDD_1P8)	1.8-V digital supply voltage		1.7	1.8	1.9	V	
V _(DVDD_1P2)	1.2-V digital supply voltage		1.15	1.2	1.25	V	
ANALOG INPUT	Г						
V _(INx)	Voltage range at analog input pins		VCM - 0.5		VCM + 0.5	V	
V _{IN(CM)}	Input common-mode range at analog input pins		0.7	0.8	0.9	V	
V _{IN(FS)}	Input differential full-scale voltage			2		V_{PP}	
F _{IN}	Analog input frequency range (1)		0		70	MHz	
ANALOG OUTP	PUT						
I _(VCM)	External loading on VCM pin	±50-mV change in VCM			100	μA	
CLOCK INPUT							
	System clock frequency	16-input mode, 10-bit ADC resolution	5		100		
		16-input mode, 12-bit ADC resolution	5		80	MSPS	
		16-input mode, 14-bit ADC resolution	5		65		
f_S		32-input mode, 10-bit ADC resolution	5		100		
		32-input mode, 12-bit ADC resolution	5		80		
		32-input mode, 14-bit ADC resolution	5		65		
		8-input mode, 10-bit ADC resolution	10		200		
		Sine-wave, ac-coupled	0.7				
$V_{CLKP} - V_{CLKM}$	Differential clock amplitude	LVPECL, ac-coupled		1.6		V_{PP}	
		LVDS, ac-coupled	0.35	0.7			
V _{CLKP}	Single-ended clock amplitude	LVCMOS on CLKP with CLKM grounded		1.8		V_{PP}	
	Input clock duty cycle		40%	50%	60%		
DIGITAL INPUT	s						
V _{IH}	Digital input minimum, high level		0.75 × DVDD_1P8	1.8		V	
V _{IL}	Digital input maximum, low level			0	0.25 × DVDD_1P8	V	
DIGITAL OUTP	UT (LVDS)						
R _{LOAD}	Differential load resistance	Between DOUTP and DOUTM		100		Ω	
DIGITAL OUTP	UT (CML)			-		-	
R _{CML}	Load resistance from each CML outp	out to a common mode		50		Ω	

⁽¹⁾ Performance degradation may be seen at high input frequencies.

7.4 Thermal Information

711 1110							
		ADS52J90					
	THERMAL METRIC ⁽¹⁾	ZZE (NFBGA)	UNITS				
		198 PINS					
$R_{\theta JA}$	Junction-to-ambient thermal resistance	33.7	°C/W				
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	4.9	°C/W				
$R_{\theta JB}$	Junction-to-board thermal resistance	14.1	°C/W				
ΨЈТ	Junction-to-top characterization parameter	0.1	°C/W				
ΨЈВ	Junction-to-board characterization parameter	14.1	°C/W				
R ₀ JC(bot)	Junction-to-case (bottom) thermal resistance	N/A	°C/W				

⁽¹⁾ For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.



7.5 Electrical Characteristics

Typical values are across ADC resolution and input modes, unless otherwise specified. Typical values are at 25°C, AVDD_1P8 = DVDD_1P8 = 1.8 V, DVDD_1P2 = 1.2 V. External $100-\Omega$ differential load between LVDS outputs, 4-pF load capacitor from each LVDS output to ground, and 1X data rate mode.

All ADCs are powered up and the input signal is a -1-dBFS tone at 5 MHz applied on one channel at a time.

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
ADC							
N	ADC resolution	32-channel input, 16-channel input	10		14	Bits	
N _{adc}	ADC resolution	8-channel input		10		DIIS	
	Number of ADCs			16		ADCs	
CLOCK DOM	AINS						
		10-bit ADC resolution			100		
f _C	Conversion rate of each ADC (conversion clock frequency)	12-bit ADC resolution 80		MSPS			
	(,)	14-bit ADC resolution			65		
		16-input mode		$f_{\mathbb{C}}$			
f _s	System clock frequency in terms of f _C	32-input mode f _C			MSPS		
		8-input mode		$2 \times f_C$			
		16-input mode		$f_{\mathbb{C}}$			
SAMP	Effective sampling rate of each input channel in terms of f _C	32-input mode		0.5 × f _C		MSPS	
	at anamas at torrito of it	8-input mode		$2 \times f_C$			
PERFORMAN	ICE						
O Coin matabian		Same device, across channels		±0.1		۲D	
G _{MATCH}	Gain matching	Same channel, across devices		±0.1		dB	
G _{DRIFT}	Gain drift with temperature over full temperature range	0.1			dB		
V _{OFF}	Offset error			-7 to 7		mV	
	Differential nonlinearity of the ADC	10-bit resolution	-0	.5 to 0.5			
		12-bit resolution	-0	.9 to 0.9		LSB	
		14-bit resolution		-1 to 2			
		10-bit resolution	-0	.5 to 0.5			
INL	Integral nonlinearity of the ADC	12-bit resolution		-1 to 1		LSB	
	,	14-bit resolution		-3 to 3			
		10-bit, 16-channel input mode, f _{SAMP} = 100 MSPS		61.3			
		10-bit, 32-channel input mode, f _{SAMP} = 50 MSPS		61.3			
		10-bit mode, 8-channel input, f _{SAMP} = 200 MSPS	56	60			
		10-bit mode, 8-channel input, f _{SAMP} = 130 MSPS	58.2	61			
0110	Signal-to-noise ratio: excludes first 9 harmonics as	12-bit mode, 16- channel input, f _{SAMP} = 80 MSPS		69.5		15.50	
SNR	well as spurs at $(f_S / 2 \pm f_{IN})$,	12-bit mode, 32-channel input, f _{SAMP} = 40 MSPS	65	69.5		dBFS	
	$(f_S / 4 \pm f_{IN}), f_S / 2, \text{ and } f_S / 4$	12-bit mode, 32-channel input, f _{SAMP} = 20 MSPS	67.5	70.2			
		14-bit mode, 16- channel input, f _{SAMP} = 65 MSPS	65.9	72.5			
		14-bit mode, 16- channel input, f _{SAMP} = 50 MSPS	67.9	73.5			
		14-bit mode, 32-channel input, f _{SAMP} = 32.5 MSPS		73			
HD2	Second-order harmonic distortion	All input modes and resolutions	-80			dBc	
HD3	Third-order harmonic distortion	All input modes and resolutions	-80		dBc		
THD	Total harmonic distortion	All input modes and resolutions		-76		dBc	
	Magnitude of spur at	16-input mode; 10-,12-,14-bit resolutions		-73			
	$(f_S / 2 \pm f_{IN})$	8-input mode, 10-bit resolution		-62		dBc	
	Magnitude of spur at (f _S / 4 ± f _{IN})	8-input mode, 10-bit resolution		-65		dBc	
	""	Input spur on neighboring channel with one channel					



Electrical Characteristics (continued)

Typical values are across ADC resolution and input modes, unless otherwise specified. Typical values are at 25°C, AVDD_1P8 = DVDD_1P8 = 1.8 V, DVDD_1P2 = 1.2 V. External $100-\Omega$ differential load between LVDS outputs, 4-pF load capacitor from each LVDS output to ground, and 1X data rate mode.

All ADCs are powered up and the input signal is a -1-dBFS tone at 5 MHz applied on one channel at a time.

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
PERFORMAN	ICE (continued)						
PSRR _{100kHz}	AC power-supply rejection ratio: tone at output relative to tone on supply	100-mV _{PP} , 100-kHz tone on supply		-70		dBc	
PSMR _{100kHz}	AC power-supply modulation ratio: intermodulation tone at output resulting from tones at supply and input measured relative to input tone	100-mV _{PP} , 100-kHz tone on supply and –1-dBFS, 5-MHz tone on input	-80			dBc	
CMRR	AC common-mode rejection ratio: tone at output relative to the common-mode tone applied at the analog input pins	50-mV _{PP} common-mode tone at input pins with a frequency of 5 MHz	-40		dBc		
TRANSIENT	BEHAVIOR						
N _{OVERLOAD}	Input overload recovery	5-MHz overload input, 6-dBFS overload		1		Conversion clock	
t _{PDN_GBL}	Recovery time from global power-down mode	PDN_GBL from high to low		1		ms	
t _{PDN_FAST}	Recovery time from fast power- down mode (standby mode)	PDN_FAST from high to low	15			Conversion clocks	
CURRENT CO	ONSUMPTION WITH LVDS INTER	FACE ENABLED					
	Current consumption in global	AVDD_1P8 current		3			
	power-down mode	DVDD_1P8 current		3		mA	
	(PDN_GBL = 1)	DVDD_1P2 current		25			
	Current consumption in standby	AVDD_1P8 current		80			
	mode (PDN_FAST = 1) at	DVDD_1P8 current		35		mA	
	$f_C = 100 \text{ MSPS}$	DVDD_1P2 current		70			
		AVDD_1P8 current		190			
	Current consumption in active mode at f _C = 100 MSPS ⁽¹⁾	DVDD_1P8 current		100		mA	
		DVDD_1P2 current		110			
	Power dissipation in active	16-channel input mode		41			
P_{CH}	mode per input channel at	32-channel input mode		20.5		mW/channel	
	$f_C = 100 \text{ MSPS}$	8-channel input mode		82			
CURRENT CO	ONSUMPTION WITH JESD INTER	FACE ENABLED					
	Supply currents: JESD204B	AVDD_1P8 current ⁽¹⁾		170			
I _{JESD}	interface enabled, LVDS interface disabled at 12-bit, 80-	DVDD_1P2 current ⁽¹⁾		260		mA	
	MSPS, 4 ADCs per lane mode	DVDD_1P8 current ⁽¹⁾		40			
	Power dissipation in active	16-channel input mode		43.1			
P _{JESD_CH} mode per input channel: f _C = 80 MSPS, 12-bit mode, LVDS interface disabled, JESD interface enabled (4 ADCs per lane mode)		32-channel input mode		21.6		mW/channel	

⁽¹⁾ See the *Power Supply Recommendations* section for guidelines on designing the supplies.



7.6 Digital Characteristics

The dc specifications refer to the condition where the digital outputs are not switching, but are permanently at a valid logic level 0 or 1. Typical values are at 25°C, AVDD_1P8 = DVDD_1P8 = 1.8 V, DVDD_1P2 = 1.2 V, and external differential load resistance between the LVDS output pair ($R_{LOAD} = 100 \Omega$), unless otherwise noted.

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT			
DIGITA	DIGITAL INPUTS (PDN_FAST, PDN_GBL, RESET, SCLK, SDIN, SEN, TX_TRIG, SPI_DIG_EN)								
V _{IH}	High-level input voltage		1.35			V			
V _{IL}	Low-level input voltage				0.45	V			
I _{IH}	High-level input current			150		μΑ			
I _{IL}	Low-level input current			150		μΑ			
C _i	Input capacitance			4		pF			
DIGITAI	L OUTPUTS (SDOUT)								
V _{OH}	High-level output voltage		1.6	1.8		V			
V _{OL}	Low-level output voltage			0	0.2	V			
z _o	Output impedance			50		Ω			
LVDS DIGITAL OUTPUTS (DOUTPI, DOUTMI) ⁽¹⁾									
V _{OD}	Output differential voltage	100-Ω external load connected differentially across DOUTP _I and DOUTM _I	320	400	480	mV			
Vos	Output offset voltage (common-mode voltage of DOUTP _I and DOUTM _I)	100-Ω external load connected differentially across DOUTP _I and DOUTM _I	0.9	1.03	1.15	٧			

⁽¹⁾ All digital specifications are characterized across operating temperature range but are not tested at production.



7.7 Timing Requirements: Signal Chain

Typical values are at 25°C. AVDD_1P8 = DVDD_1P8 = 1.8 V, DVDD_1P2 = 1.2 V, and external differential load resistance between the LVDS output pair (R_{LOAD} = 100 Ω), unless otherwise noted. A capacitive load of 4 pF is on the LVDS outputs.

			MIN	TYP	MAX	UNIT	
GENERAL							
t _{AP}	Aperture delay			1.6		ns	
δt _{AP}	Aperture delay variation (at same temperature a			±0.5		ns	
t _{APJ}	Aperture jitter with LVPI	ECL clock as input clock		0.5		ps	
ADC TIMING							
	ADC later av	Default after reset		8.5		Conversion	
N_{LAT}	ADC latency	Low-latency mode		4.5		clocks	
LVDS TIMING	ì				·		
	Frame clock frequency			$f_{\mathbb{C}}$		MUL	
f _F	Frame clock frequency	32-input mode		f _C / 2		MHz	
D _{FRAME}	Frame clock duty cycle			50%			
N _{SER}	Number of bits serializa	tion of each ADC word	10		16	Bits	
£	Output rate of serialized data for 1X output data rate mode, 16-, 8 and 32-input modes Output rate of serialized data for 2X output data rate mode, 16-input and 8-input modes			N _{SER} × f _C	1000	Mbps	
f _D			2 ×	N _{SER} × f _C	1000		
f _B	Bit clock frequency			f _D / 2	500	MHz	
D _{BIT}	Bit clock duty cycle			50%			
t _D	Data bit duration		1	1000 / f _D		ns	
t _{PROP}	Clock propagation delay	, ⁽¹⁾		6 × t _D + 5		ns	
δt_{PROP}	Clock propagation delay (at same temperature a	variation from device to device nd supply)		±2		ns	
t _{ORF}	DOUT, DCLK, FCLK ris between –100 mV and	e and fall time, transition time +100 mV		0.2		ns	
tosu	Minimum serial data, se	rial clock setup time ⁽²⁾	t _c	$\frac{1}{2}$ / 2 – 0.4		ns	
t _{OH}	Minimum serial data, se	rial clock hold time (2)	t	/ 2 – 0.4		ns	
t _{DV}	Minimum data valid win	dow ⁽³⁾⁽²⁾		t _D - 0.65		ns	
TX_TRIG TIM	ING						
t _{TX_TRIG_DEL}	Delay between TX_TRI	G and TX_TRIGD ⁽⁴⁾	0.5		$0.4 \times t_{S}^{(5)}$	ns	
t _{SU_TX_TRIGD}	Setup time related to lar	tching TX_TRIG relative to the m clock		0.6		ns	
t _{H_TX_TRIGD}	Hold time related to late rising edge of the system	hing TX_TRIG relative to the m clock		0.4		ns	
		1					

¹⁾ See \boxtimes 64 to \boxtimes 68 for the definition of t_{PROP} in various operating modes.

⁽²⁾ See 🗵 1.

⁽³⁾ The specification for the minimum data valid window is larger than the sum of the minimum setup and hold times because there can be a skew between the ideal transitions of the serial output data with respect to the transition of the bit clock. This skew can vary across channels and across devices. A mechanism to correct this skew can therefore improve the setup and hold timing margins. For example, the LVDS_DCLK_DELAY_PROG control can be used to shift the relative timing of the bit clock with respect to the data.

⁽⁴⁾ TX_TRIGD is the internally delayed version of TX_TRIG that gets latched on the rising edge of the system clock.

⁽⁵⁾ t_S is the system clock period in ns.



7.8 Timing Requirements: JESD Interface

Typical values are at T_A = 25°C, AVDD_1P8 = 1.8 V, DVDD_1P2 = 1.2 V, DVDD_1P8 = 1.8 V, differential ADC clock, R_{LOAD} = 50 Ω from each CML pin to DVDD_1P2, 12-bit ADC resolution, sample rate, and f_C = 80 MSPS, unless otherwise noted. Minimum and maximum values are across the full temperature range of T_{MIN} = -40°C to T_{MAX} = 85°C. The JESD204B interface operates in default mode after setting the JESD_EN bit to 1 (12-bit ADC resolution, 12-bit serialization, 4 ADCs per lane, and scrambling disabled).

	crambling disabled).	MIN	TYP	MAX	UNIT	
		IVIIIN	ITP	WAX	UNII	
TIMING CH	ARACTERISTICS				I	
f _{JESD}	Serial output data rate in terms of F (number of octets per frame) and f _C (ADC clock frequency in MHz)	0.01 × F × f _C		Gbps		
UI	Unit interval	200 10	000 / f _{JESD}	2000	ps	
Tj	Total jitter: f _{JESD} = 5 Gbps, PRE_EMP = 7, INC_JESD_VDD = 1		0.27		p-p UI	
t _R , t _F	Rise and fall time: 20% to 80%, each pin loaded by C_{LOAD} = 1.2 pF to DVDD_1P2		85		ps	
SAMPLING	TIMING				1.	
t _{SU_S}	Setup time for SYSREF with respect to the device clock rising edge		3		ns	
t _{H_S}	Hold time for SYSREF with respect to the device clock rising edge		2		ns	
t _{SU_T}	Setup time for SYNC~ with respect to the device clock rising edge 3		ns			
t _{H_T}	Hold time for SYNC~ with respect to the device clock rising edge	2		ns		
JESD LATE	ENCY					
N _{A_SYNC~}	Latency from SYNC~ assertion (falling) edge to start of CGS phase (K28.5) in subclass 0, 1, and 2	17			Device clock cycles	
N _{D_SYNC~}	Latency from the first LMFC boundary after SYNC~ deassertion (rising) edge to start of ILA phase (K28.0) in subclass 1	11		Device clock cycles		
N _{LAT_JESD}	Latency from the device clock falling edge sampling the analog input of ADC1 to the appearance of the corresponding octets on the JESD outputs			Device clock cycles		
JESD DIGIT	TAL OUTPUTS					
V _{OH-CML}	High-level output voltage of the CML output (CMLx_OUTP, CMLx_OUTM)	D	VDD_1P2		V	
V _{OL-CML}	Low-level output voltage of the CML output (CMLx_OUTP, CMLx_OUTM) DVDD_1P2 - 0.4		V			
V _{OD-CML}	Differential output voltage of CMLx_OUT		0.4		V	
V _{OC-CML}	Common-mode output voltage of CMLx_OUTP, CMLx_OUTM	DVDD_	1P2 – 0.2		V	
z _{OS}	Single-ended output impedance		50 ± 25%		Ω	
C _{CML}	Output capacitance inside device from either CML output to ground	1		either CML output to ground 1		pF
	Transmitter short-circuit current: transmitter terminals shorted to any voltage between –0.25 V and 1.45 V		±100		mA	

7.9 Timing Requirements: Serial Interface (1)(2)

		MIN	TYP	MAX	UNIT
t _{SCLK}	SCLK period	50			ns
t _{SCLK_H}	SCLK high time	20			ns
t _{SCLK_L}	SCLK low time	20			ns
t _{DSU}	Data setup time	5			ns
t _{DHO}	Data hold time	5			ns
t _{SEN_SU}	SEN falling edge to SCLK rising edge	8			ns
t _{SEN_HO}	Time between last SCLK rising edge to SEN rising edge	8			ns
t _{OUT_DV}	SDOUT delay	12	20	28	ns

⁽¹⁾ Characterized in lab over operating temperature range, not tested at production testing.

⁽²⁾ See 🗵 92 and 🗵 93.



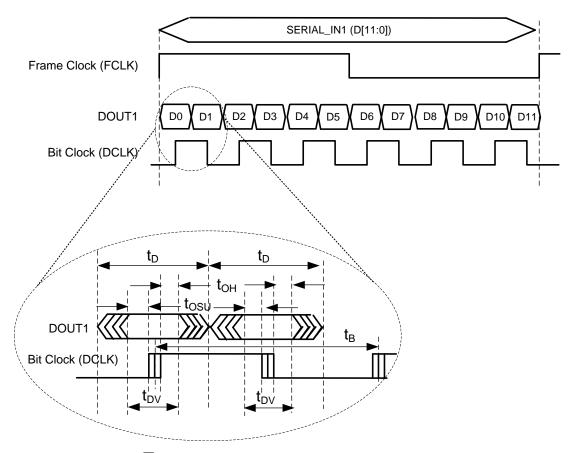
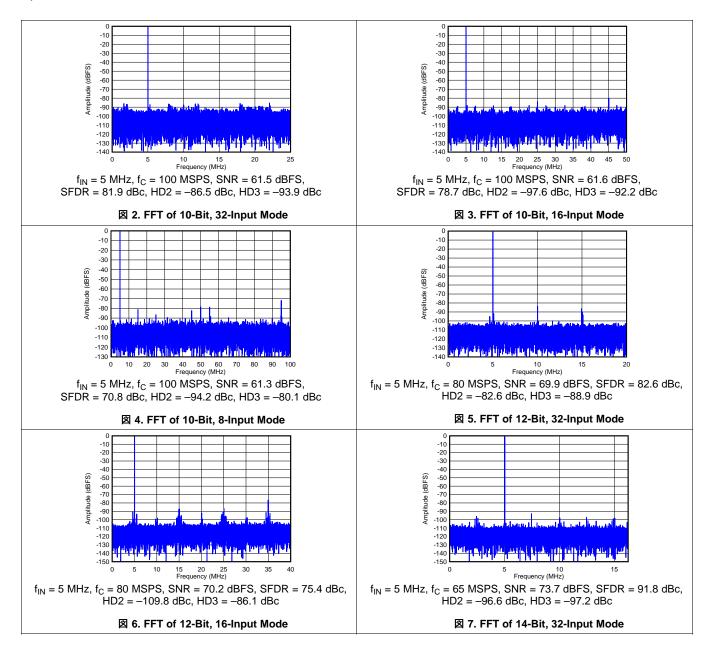


図 1. LVDS Output Signals Timing Diagram in 16-Input Mode with 12-Bit Serialization, LSB-First, 1X Data Rate Mode



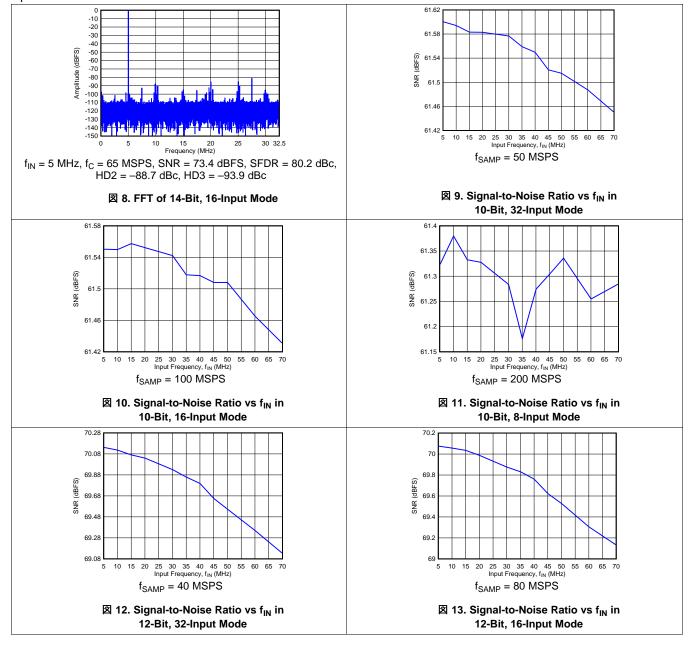
7.10 Typical Characteristics

At 25°C, AVDD_IP8 = DVDD_1P8 = 1.8 V, and DVDD_1P2 = 1.2 V, unless otherwise noted. All LVDS outputs are active with $100-\Omega$ differential terminations and a 4-pF load capacitor from each LVDS output pin to ground. A -1-dBFS input signal at 5 MHz is applied to the input channel under test. SNR is computed by ignoring the power contained in the first nine harmonic bins, the $f_S/2$ and $f_S/4$ frequency bins as well as the bins corresponding to the intermodulation frequencies between the input and the clock. A LVPECL clock is used as the clock source.



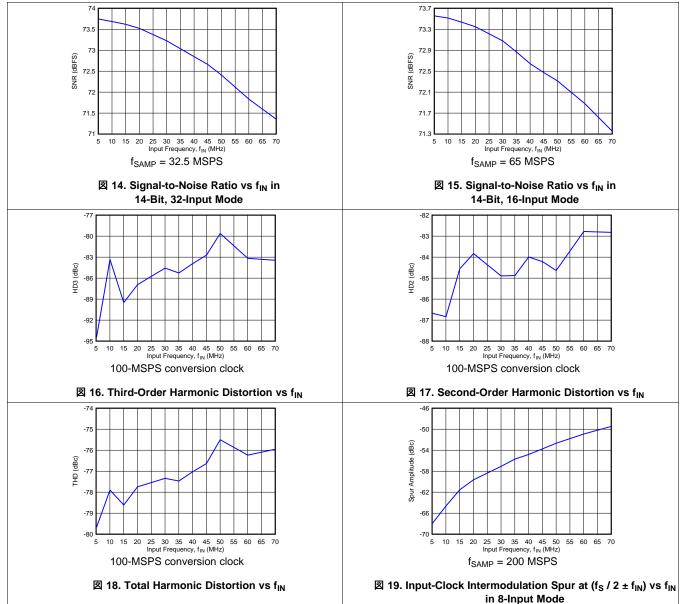


At 25°C, AVDD_IP8 = DVDD_1P8 = 1.8 V, and DVDD_1P2 = 1.2 V, unless otherwise noted. All LVDS outputs are active with $100-\Omega$ differential terminations and a 4-pF load capacitor from each LVDS output pin to ground. A -1-dBFS input signal at 5 MHz is applied to the input channel under test. SNR is computed by ignoring the power contained in the first nine harmonic bins, the $f_S/2$ and $f_S/4$ frequency bins as well as the bins corresponding to the intermodulation frequencies between the input and the clock. A LVPECL clock is used as the clock source.



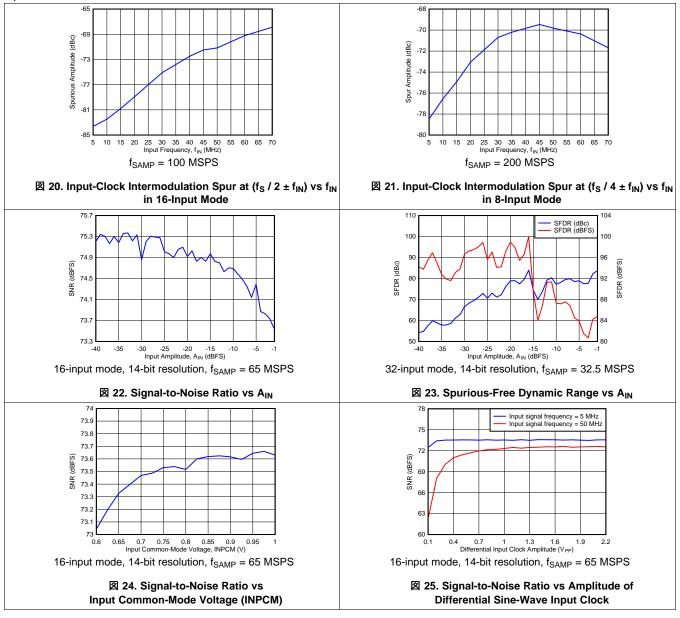


At 25°C, AVDD_IP8 = DVDD_1P8 = 1.8 V, and DVDD_1P2 = 1.2 V, unless otherwise noted. All LVDS outputs are active with $100-\Omega$ differential terminations and a 4-pF load capacitor from each LVDS output pin to ground. A -1-dBFS input signal at 5 MHz is applied to the input channel under test. SNR is computed by ignoring the power contained in the first nine harmonic bins, the f_S / 2 and f_S / 4 frequency bins as well as the bins corresponding to the intermodulation frequencies between the input and the clock. A LVPECL clock is used as the clock source.



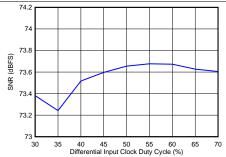


At 25°C, AVDD_IP8 = DVDD_1P8 = 1.8 V, and DVDD_1P2 = 1.2 V, unless otherwise noted. All LVDS outputs are active with $100-\Omega$ differential terminations and a 4-pF load capacitor from each LVDS output pin to ground. A -1-dBFS input signal at 5 MHz is applied to the input channel under test. SNR is computed by ignoring the power contained in the first nine harmonic bins, the $f_S/2$ and $f_S/4$ frequency bins as well as the bins corresponding to the intermodulation frequencies between the input and the clock. A LVPECL clock is used as the clock source.

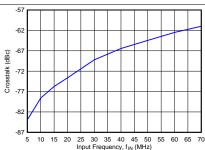




At 25°C, AVDD_IP8 = DVDD_1P8 = 1.8 V, and DVDD_1P2 = 1.2 V, unless otherwise noted. All LVDS outputs are active with $100-\Omega$ differential terminations and a 4-pF load capacitor from each LVDS output pin to ground. A -1-dBFS input signal at 5 MHz is applied to the input channel under test. SNR is computed by ignoring the power contained in the first nine harmonic bins, the $f_S/2$ and $f_S/4$ frequency bins as well as the bins corresponding to the intermodulation frequencies between the input and the clock. A LVPECL clock is used as the clock source.

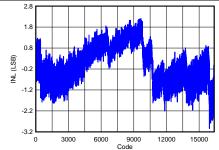


16-input mode, 14-bit resolution, f_{SAMP} = 65 MSPS



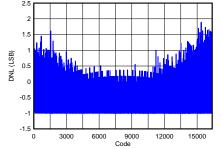
32-input mode, 14-bit resolution, f_{SAMP} = 32.5 MSPS, -1-dBFS tone applied on one channel and spur on neighboring channel measured as crosstalk

図 26. Signal-to-Noise Ratio vs Differential Input Clock Duty Cycle



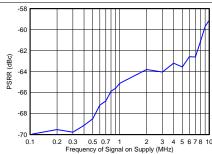
32-input mode, 14-bit resolution, f_{SAMP} = 32.5 MSPS

図 27. Crosstalk vs f_{IN}



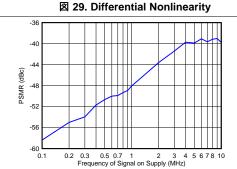
32-input mode, 14-bit resolution, f_{SAMP} = 32.5 MSPS

図 28. Integral Nonlinearity



32-input mode, 14-bit resolution, f_{SAMP} = 32.5 MSPS, 100-mV_{PP} tone on supply

図 30. Power-Supply Rejection Ratio vs Frequency of Signal on Supply

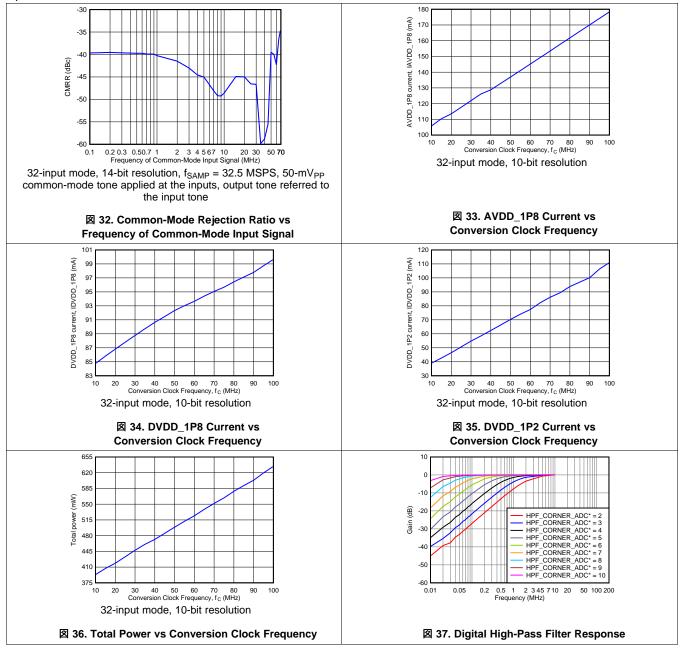


32-input mode; 14-bit resolution; f_{SAMP} = 32.5 MSPS; 100-mV_{PP} tone on supply; 5-MHz, -1-dBFS tone on input; PSMR is intermodulation tone referred to input tone amplitude

図 31. Power-Supply Modulation Ratio vs Frequency of Signal on Supply



At 25°C, AVDD_IP8 = DVDD_1P8 = 1.8 V, and DVDD_1P2 = 1.2 V, unless otherwise noted. All LVDS outputs are active with $100-\Omega$ differential terminations and a 4-pF load capacitor from each LVDS output pin to ground. A -1-dBFS input signal at 5 MHz is applied to the input channel under test. SNR is computed by ignoring the power contained in the first nine harmonic bins, the $f_S/2$ and $f_S/4$ frequency bins as well as the bins corresponding to the intermodulation frequencies between the input and the clock. A LVPECL clock is used as the clock source.

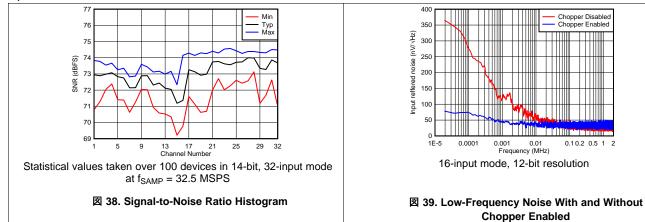


Chopper Disabled Chopper Enabled



Typical Characteristics (continued)

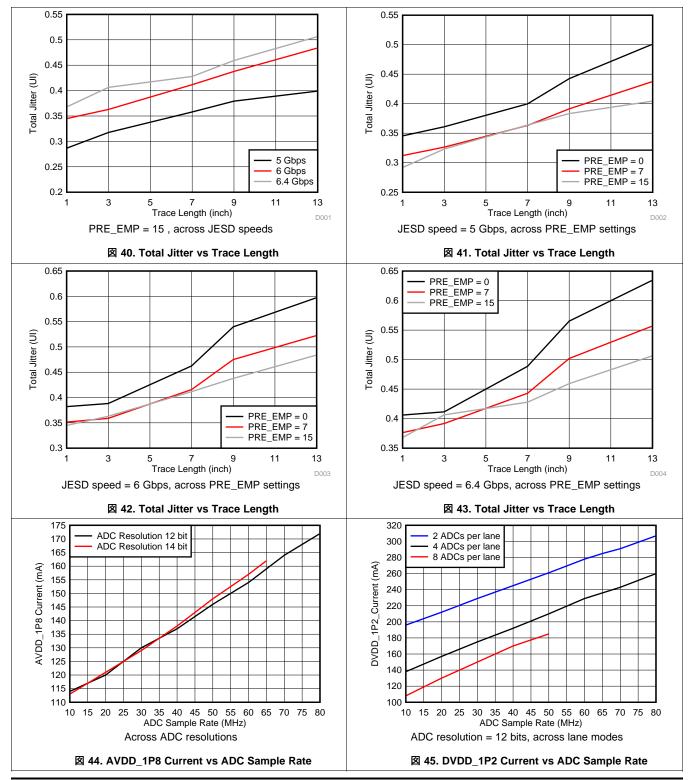
At 25°C, AVDD_IP8 = DVDD_1P8 = 1.8 V, and DVDD_1P2 = 1.2 V, unless otherwise noted. All LVDS outputs are active with $100-\Omega$ differential terminations and a 4-pF load capacitor from each LVDS output pin to ground. A -1-dBFS input signal at 5 MHz is applied to the input channel under test. SNR is computed by ignoring the power contained in the first nine harmonic bins, the $f_s/2$ and $f_s/4$ frequency bins as well as the bins corresponding to the intermodulation frequencies between the input and the clock. A LVPECL clock is used as the clock source.





7.11 Typical Characteristics: JESD Interface

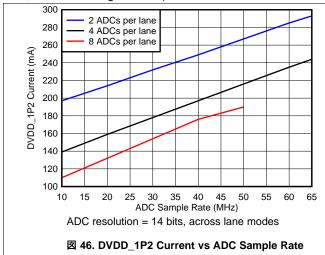
Typical values are at T_A = 25°C, AVDD_1P8 = 1.8 V, DVDD_1P2 = 1.2 V, DVDD_1P8 = 1.8 V, differential ADC clock, R_{LOAD} = 50 Ω from each CML pin to DVDD_1P2, 12-bit ADC resolution, sample rate, and f_{CLKIN} = 80 MSPS, unless otherwise noted. Minimum and maximum values are across the full temperature range of T_{MIN} = -40°C to T_{MAX} = 85°C. The JESD204B interface operates in default mode after setting the JESD_EN bit to 1 (12-bit ADC resolution, 12-bit serialization, 4 ADCs per lane, and scrambling disabled).

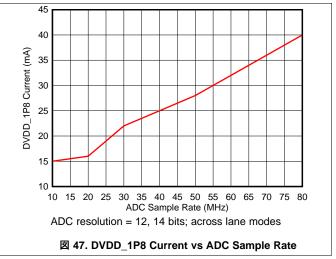




Typical Characteristics: JESD Interface (continued)

Typical values are at T_A = 25°C, AVDD_1P8 = 1.8 V, DVDD_1P2 = 1.2 V, DVDD_1P8 = 1.8 V, differential ADC clock, R_{LOAD} = 50 Ω from each CML pin to DVDD_1P2, 12-bit ADC resolution, sample rate, and f_{CLKIN} = 80 MSPS, unless otherwise noted. Minimum and maximum values are across the full temperature range of T_{MIN} = -40°C to T_{MAX} = 85°C. The JESD204B interface operates in default mode after setting the JESD_EN bit to 1 (12-bit ADC resolution, 12-bit serialization, 4 ADCs per lane, and scrambling disabled).

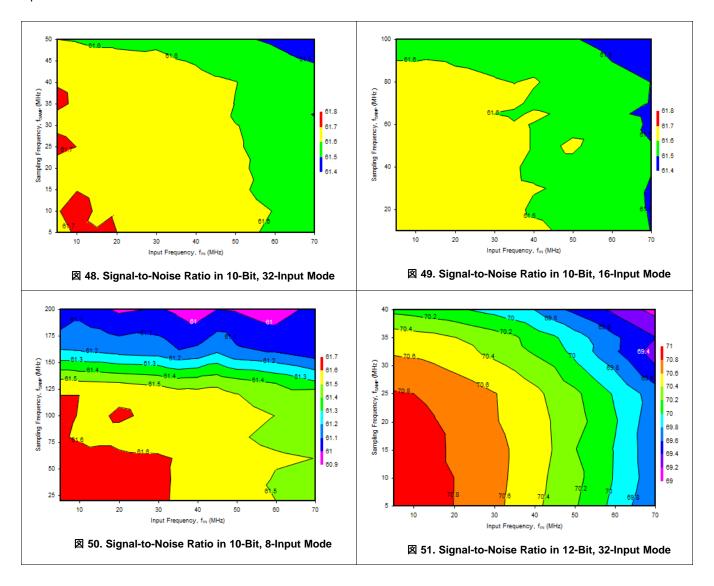






7.12 Typical Characteristics: Contour Plots

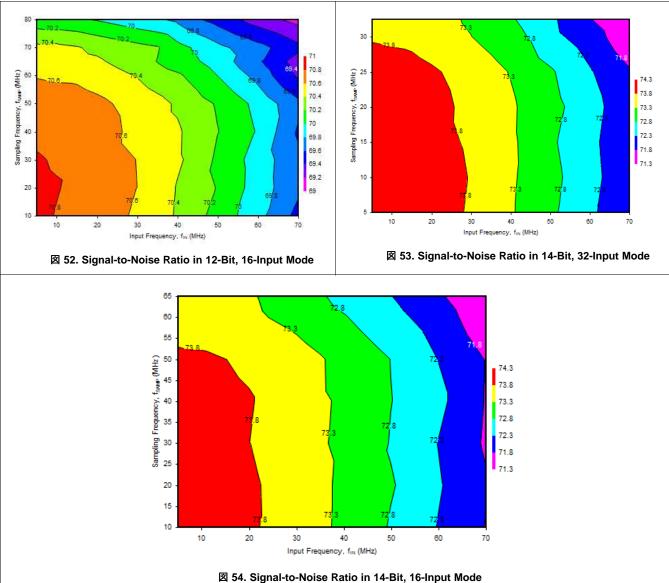
At 25°C, AVDD_IP8 = DVDD_1P8 = 1.8 V, and DVDD_1P2 = 1.2 V, unless otherwise noted. All LVDS outputs are active with $100-\Omega$ differential terminations and a 4-pF load capacitor from each LVDS output pin to ground. A -1-dBFS input signal at 5 MHz is applied to the input channel under test. SNR is computed by ignoring the power contained in the first nine harmonic bins, the $f_S/2$ and $f_S/4$ frequency bins as well as the bins corresponding to the intermodulation frequencies between the input and the clock. An LVPECL clock is used as the clock source.





Typical Characteristics: Contour Plots (continued)

At 25°C, AVDD_IP8 = DVDD_1P8 = 1.8 V, and DVDD_1P2 = 1.2 V, unless otherwise noted. All LVDS outputs are active with $100-\Omega$ differential terminations and a 4-pF load capacitor from each LVDS output pin to ground. A -1-dBFS input signal at 5 MHz is applied to the input channel under test. SNR is computed by ignoring the power contained in the first nine harmonic bins, the f_S / 2 and f_S / 4 frequency bins as well as the bins corresponding to the intermodulation frequencies between the input and the clock. An LVPECL clock is used as the clock source.



8 Detailed Description

8.1 Overview

A block diagram of the device is shown in \boxtimes 55. \boxtimes 56 illustrates the signal flow for the device while operating with the LVDS output interface. The device consists of 16 ADCs configurable to convert 8-, 16-, or 32-inputs. All ADCs run off the external clocks (provided on the CLKP, CLKM pins). The references needed for the ADCs are internally generated. The reference voltage that can be used to set the common mode voltage of the analog input comes out on the VCM pin. The output data from the 16 ADCs are serialized and output on the LVDS interface. The device also has an optional JESD204B interface. The device is controlled using an SPI interface.

8.2 Functional Block Diagrams

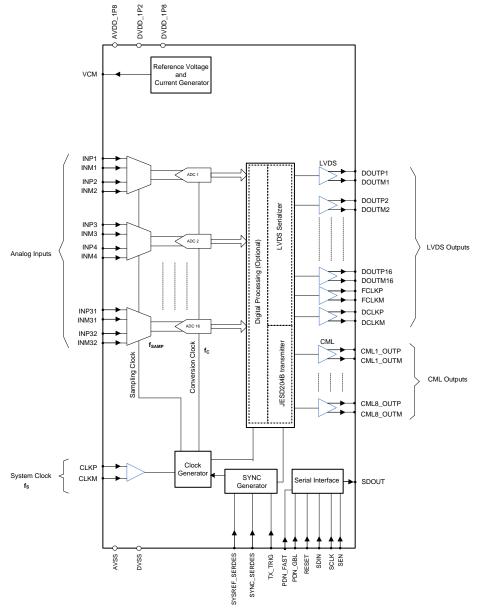


図 55. Block Diagram



Functional Block Diagrams (continued)

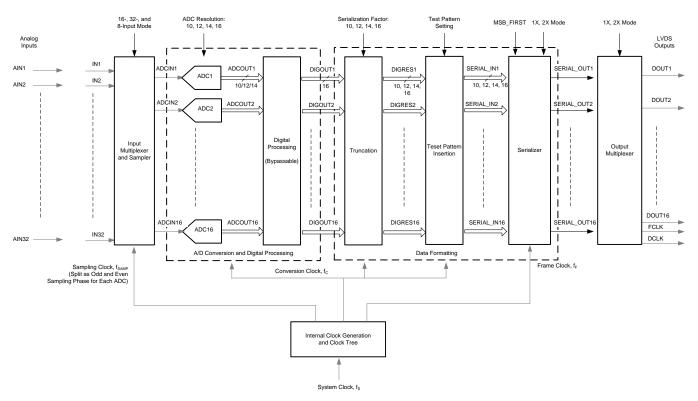


図 56. Signal Flow Diagram

8.3 Feature Description

The device has 16 synchronously operating ADCs (ADC1 to ADC16) and can be configured to accept and convert 8, 16, or 32 active differential external analog inputs (AIN1 to AIN32). The converted digital outputs can be made to come out on either 16 pairs of low-voltage differential signaling (LVDS) outputs or compressed into eight pairs. The device operates from a single clock input. This input is referred to as the system clock and its frequency is denoted by f_S. The recommended mode of driving the clock is with a differential low-voltage positive-referenced emitter coupled logic (LVPECL) clock. The system clock can be also driven by a differential sine-wave or LVDS, or can be driven with a single-ended low voltage complementary metal oxide semiconductor (LVCMOS) clock. The various aspects of the signal chain are discussed in the following sections.



Feature Description (continued)

8.3.1 Connection of the External Inputs to the Input Pins

The effective conversion rate per input changes depending on the input mode. The methodology of connecting the external inputs (AINx) to the input pins (INx) is shown in 表 1 for the 16-, 32- and 8-channel input modes. In 表 1, AIN1 refers to the differential input signal (AINP1, AINM1) and IN1 refers to the input pair (INP1, INM1). The voltage that gets sampled and converted by the device is (AINP1-AINM1).

表 1. Scheme of Driving the Input Pins (16-, 32-, 8-Channel Input Modes)

	CONNECTION	TO THE EXTERNAL ANALOG IN	NPUT SIGNAL
INPUT PAIR	16-CHANNEL INPUT MODE ⁽¹⁾⁽²⁾	32-CHANNEL INPUT MODE	8-CHANNEL INPUT MODE ⁽¹⁾
IN1	AIN1	AIN1	AIN1
IN2	_	AIN2	_
IN3	AIN2	AIN3	AIN1
IN4	_	AIN4	_
IN5	AIN3	AIN5	AIN2
IN6	_	AIN6	_
IN7	AIN4	AIN7	AIN2
IN8	_	AIN8	_
IN9	AIN5	AIN9	AIN3
IN10	_	AIN10	_
IN11	AIN6	AIN11	AIN3
IN12	_	AIN12	_
IN13	AIN7	AIN13	AIN4
IN14	_	AIN14	_
IN15	AIN8	AIN15	AIN4
IN16	_	AIN16	_
IN17	AIN9	AIN17	AIN5
IN18	_	AIN18	_
IN19	AIN10	AIN19	AIN5
IN20	_	AIN20	_
IN21	AIN11	AIN21	AIN6
IN22	_	AIN22	_
IN23	AIN12	AIN23	AIN6
IN24	_	AIN24	_
IN25	AIN13	AIN25	AIN7
IN26	_	AIN26	_
IN27	AIN14	AIN27	AIN7
IN28	_	AIN28	_
IN29	AIN15	AIN29	AIN8
IN30	_	AIN30	_
IN31	AIN16	AIN31	AIN8
IN32	_	AIN32	_

⁽¹⁾ -- = do not connect.

8.3.2 Input Multiplexer and Sampler

The input multiplexer determines the mapping of the input pins (IN1 to IN32) to the inputs that are sampled and converted by the ADCs (ADC1 to ADC16). Each ADC has two sets of sampling circuits (termed odd and even) and alternately converts the inputs presented to them.

⁽²⁾ To switch ADCx to convert the even numbered inputs, use register control IN_16CH_ADCx.



The sampling windows for the odd and even sampling circuits of each ADC are derived from the system clock. A pair of ADCs are used in \boxtimes 57, \boxtimes 58, and \boxtimes 59 to illustrate how the odd and even sampling phases are derived for each ADC in each input mode. AIN1 (t_1) refers to the AIN1 input sampled at the t_1 instant. ADC10 refers to the odd sample converted by ADC1 and ADC1e refers to the even sample converted by ADC1. The input sampling and conversion schemes for the 32-, 16-, and 8-input modes are illustrated in \boxtimes 57, \boxtimes 58, and \boxtimes 59, respectively.

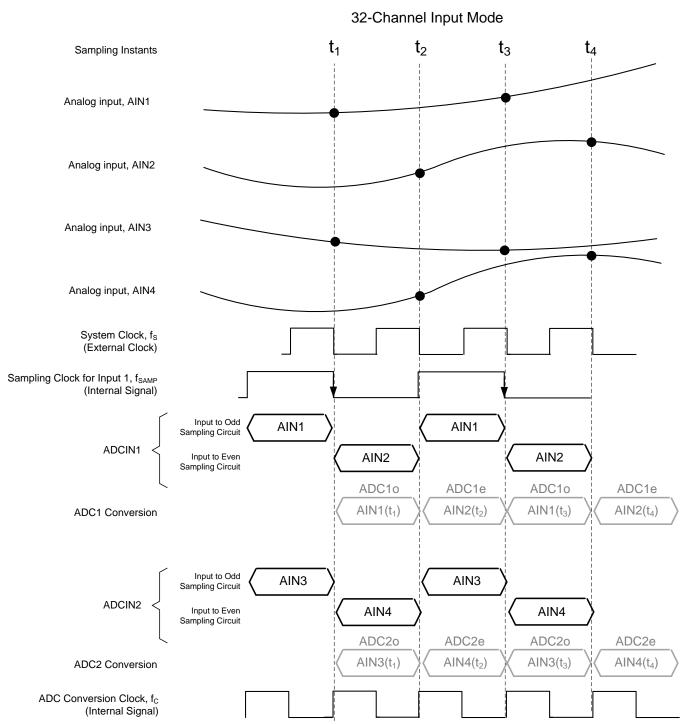


図 57. Input Sampling and Conversion Scheme (32-Input Mode)



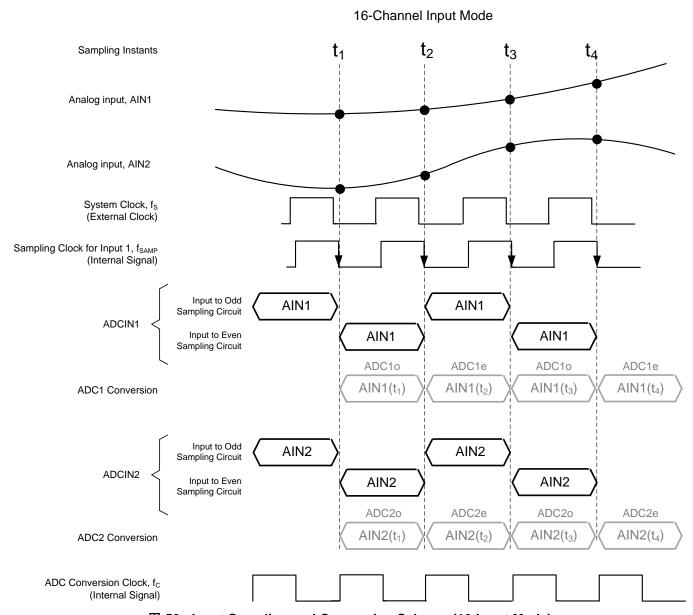


図 58. Input Sampling and Conversion Scheme (16-Input Mode)



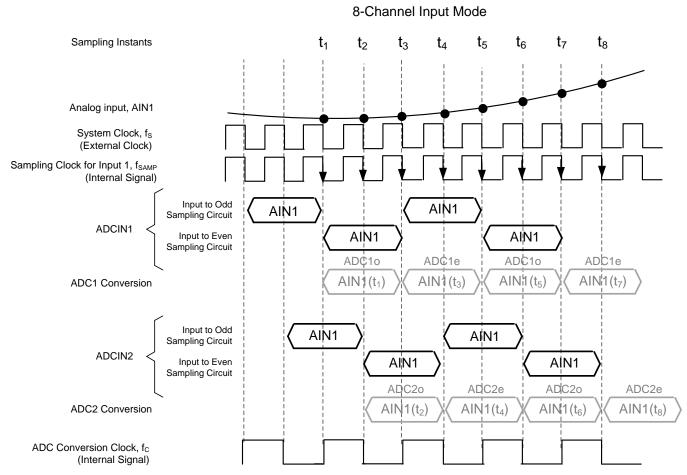


図 59. Input Sampling and Conversion Scheme (8-Input Mode)

Mapping the inputs of the odd and even sampling circuits of subsequent-numbered ADCs to subsequent-numbered sets of input pairs repeats in a similar manner.

The sampling rate (f_{SAMP}) can be defined as the rate at which the device converts each analog input presented to it. The relationship between the sampling rate and the system clock frequency is listed in $\frac{1}{5}$ 2 for the three input modes.

ANALOG INPUT MODE (Number of Input Channels)	SAMPLING RATE (f _{SAMP})
16	f _S
32	0.5 × f _S
8	f _S

表 2. Sampling Rate and Input Clock Frequency

In 16-input mode, each ADC converts one input at a sampling rate equal to the system clock. In 32-input mode, one ADC alternately converts two sets of inputs, each at a sampling rate that is half the system clock. In the 8-input mode, two ADCs convert the same input in interleaved manner.

In 16-input mode, a ping-pong operation exists between two sampling circuits of one ADC that are sampling the same input. The mismatch between the two sampling circuit bandwidths can result in an interleaving spur at $(f_S/2 \pm f_{IN})$, where f_S is the frequency of the system clock and f_{IN} is the frequency of the input signal.

In 8-input mode, additional interleaving across two adjacent ADCs is present in addition to the ping-pong operation between the two sampling circuits of the same ADC. This increased mismatch can result in significant interleaving spurs at $(f_S / 2 \pm f_{IN})$ and $(f_S / 4 \pm f_{IN})$. The offset mismatch between the four sets of sampling circuits can result in a spur at $f_S / 4$.



For the 32-input mode, the sampling instants of the even-numbered input signals are offset from the sampling instants of the odd-numbered input signals by one system clock period. The magnitude of the interleaving spurs increases when the input frequency is increased because the sampling bandwidth mismatch across the different sampling circuits results in larger phase error mismatches when the input frequency is increased.

8.3.3 Analog-to-Digital Converter (ADC)

The device has 16 synchronous ADCs that provide a digital representation of the input in twos complement format. Each ADC converts at a rate of f_C using a conversion clock that is internally generated from the system clock. Every cycle of a conversion clock corresponds to a new ADC conversion.

The mapping of the ADC conversions to the analog input is described in 表 3. See 図 57, 図 58, and 図 59 for the naming conventions.

表 3. Mapping of the ADC Conversions to the Analog Inputs and Sampling Instants

ADC SAMPLE		INPUT CONVERTED BY T	HE ADC			
ADO SAMPLE	16-INPUT MODE	32-INPUT MODE	8-INPUT MODE			
ADC1o	AIN1 (t ₁)	AIN1 (t ₁)	AIN1 (t ₁)			
ADC2o	AIN2 (t ₁)	AIN3 (t ₁)	AIN1 (t ₂)			
ADC1e	AIN1 (t ₂)	AIN2 (t ₂)	AIN1 (t ₃)			
ADC2e	AIN2 (t ₂)	AIN4 (t ₂)	AIN1 (t ₄)			

The ADC resolution (the number of bits in the signals marked as ADCOUT1 to ADCOUT16) can be programmed as 10, 12, or 14 bits using the ADC_RES bits. The maximum conversion clock of the ADC depends on the ADC resolution setting, as shown in $\frac{1}{5}$ 4.

表 4. Maximum Conversion Rate of the ADC for Different ADC Resolutions

ADC RESOLUTION (Bits)	MAXIMUM CONVERSION CLOCK (f _{C(max)} , MSPS)
10	100
12	80
14	65

The relationship between the system clock and sampling clock rates to the ADC conversion clock is shown in 表 5. Note that the maximum conversion rate of the ADC is fixed for the three resolution modes. In 表 5, sampling rate refers to the effective rate of sampling each active analog input.

表 5. System Clock and Sampling Clock Relationship to the ADC Conversion Clock

ANALOG INPUT MODE (Number of Input Channels)	SYSTEM CLOCK RATE (f _S)	SAMPLING RATE (f _{SAMP}) ⁽¹⁾	ADC RESOLUTIONS SUPPORTED
16	f _C	f _C	10, 12, 14
32	f _C	0.5 × f _C	10, 12, 14
8	2 × f _C	2 × f _C	10

(1) Sampling rate is also the effective conversion rate of each input channel.



8.3.4 Device Synchronization Using TX_TRIG

The device has multiple PLLs and clock dividers that are used to generate the programmable ADC resolutions and LVDS synchronization factors as well as to synchronize LVDS test patterns.

The TX_TRIG input is used to synchronize clock dividers inside the device. The synchronization achieved using TX_TRIG also enables multiple parallel devices to operate synchronously.

For the 32-input mode, the same ADC alternates between converting two inputs. The TX_TRIG signal provides the mechanism to determine the sampling instants of the odd and even input signals with respect to the system clock, as shown in \boxtimes 60.

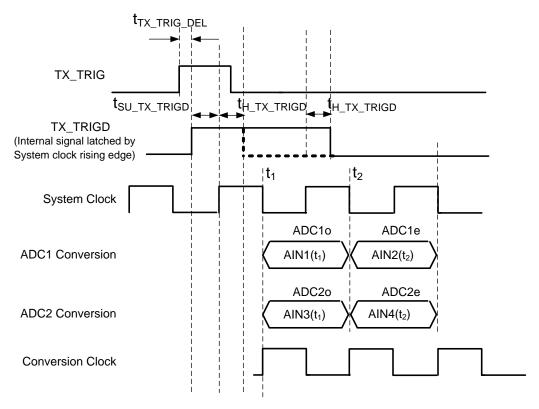


図 60. Odd- and Even-Channel Sampling Instant Definition Mechanism in 32-Input Mode with the TX_TRIG Signal



For the 8-input mode, the conversion clock is obtained by dividing the system clock by 2. The phase of the division is again determined by the TX_TRIG signal, as shown in \boxtimes 61.

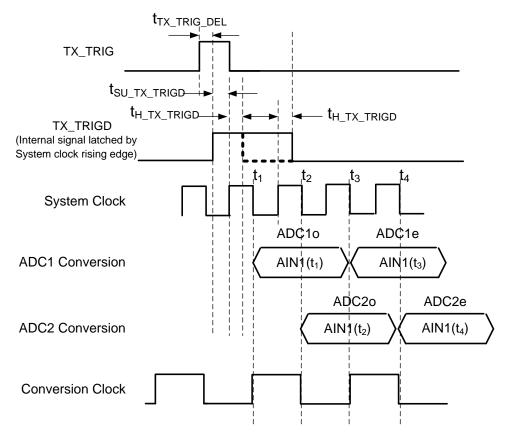


図 61. Conversion Clock Deriving Mechanism from Division of the Sampling Clock in 8-Input Mode

Applying a pulse on TX_TRIG is a mandatory part of the power-up and initialization sequence; see the *Power Sequencing and Initialization* section.

In case a TX_TRIG is not applied, the device can possibly behave in an unexpected manner. The identified cases are shown in 表 6.

表 6. Device Behavior Cases: TX_TRIG is Not Applied

SCENARIO	ISSUE	INPUT MODE WHERE ISSUE OCCURS (8-, 16-, 32-Channel Input Modes)
Multiple devices operating in parallel	Frame clock across devices is not synchronized	8- and 32-channel input modes
	LVDS patterns across devices are not synchronized	8-, 16-, and 32-channel input modes
Serialization factor different from ADC resolution	Framing of data words within a frame clock is not defined	8- and 32-channel input modes

The TX_TRIG pulse resets the phase of the test pattern generator, the odd and even sampling phase selection, and the phase of the frame clock. As a result of this phase reset operation, the ADC data can be corrupted for four to six clocks immediately after applying TX_TRIG. The phase reset from TX_TRIG can be disabled using MASK_TX_TRIG.



8.3.5 Digital Processing

The ADC outputs go to a digital processing block that can be used to enhance ADC performance. Some of the operations done in the digital processing block can enhance the effective signal to noise ratio at its output. For this reason, the number of bits at the DIGOUT1 to DIGOUT16 signals are considered to be 16. However, some of the LSBs of this 16-bit word may be zero. For example, when the digital processing block is bypassed, the number of non-zero bits in DIGOUT is the same as the ADC resolution—the extra LSBs of the 16-bit word are zero.

The digital processing block results in additional latency that can be avoided by using the low latency mode (programmed using the LOW_LATENCY_EN bit) that bypasses the entire digital processing block without introducing extra latency. The various features available in the digital processing block are shown in \boxtimes 62 and are explained in the subsequent sections.

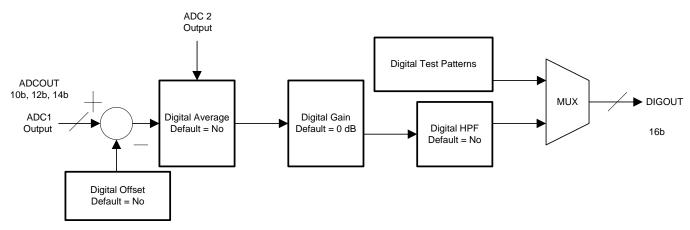


図 62. ADC Digital Block Diagram

8.3.5.1 Digital Offset

Digital functionality provides for channel offset correction. Setting the DIG_OFFSET_EN bit to 1 enables the subtraction of the offset value from the ADC output. There are two offset correction modes, as shown in \boxtimes 63.

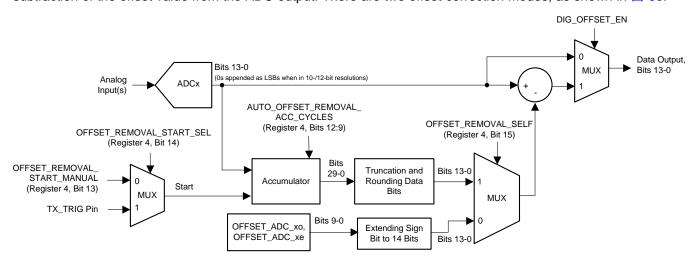


図 63. Digital Offset Correction Block Diagram



8.3.5.1.1 Manual Offset Correction

If the channel offset is known or estimated, it can be written into a 10-bit register and can be subtracted from the ADC output. There are 32 sets of manual offset controls. To enable per-channel offset correction in the 32-input mode, the offset values for the odd and even data streams of each of the 16 ADCs can be independently controlled. The registers OFFSET_ADCxo and OFFSET_ADCxe correspond to the offsets subtracted from the odd and even data streams of ADCx. Write the offset values in twos complement format.

8.3.5.1.2 Auto Offset Correction Mode (Offset Correction using a Built-In Offset Calculation Function)

The auto offset calculation module can be used to calculate the channel offset that is then subtracted from the ADC output. To enable the auto offset correction mode, set the OFFSET_REMOVAL_SELF bit and DIG OFFSET EN bit to 1.

In auto offset correction mode the dc component of the ADC output (assumed to be the channel offset) is estimated using a digital accumulator. The ADC output sample set used by the accumulator is determined by a start time or first sample and number of samples to be used. A high pulse on the TX_TRIG pin or setting the OFFSET_REMOVAL_START_MANUAL register can be used to determine the first sample to the accumulator. To set the number of samples, the AUTO_OFFSET_REMOVAL_ACC_CYCLES register must be programmed according to 表 7.

If a pulse on the TX_TRIG pin is used to set the first sample, additional flexibility in setting the first sample is provided. A programmable delay between the TX_TRIG pulse and the first sample can be set by writing to the OFFSET_CORR_DELAY_FROM_TX_TRIG register.

The determined offset value can be read out for each channel. Set the channel number in the AUTO_OFFSET_REMOVAL_VAL_RD_CH_SEL register and read the offset value for the corresponding channel in the AUTO_OFFSET_REMOVAL_VAL_RD register. Note that the offset estimation is done separately for the odd and even data streams of each of the 16 ADCs and results in 32 sets of offset estimates that can be read out.

表 7. Auto Offset Removal Accumulator Cycles

AUTO_OFFSET_REMOVAL_ACC_CYCLES (Bits 3-0)	NUMBER OF SAMPLES USED FOR OFFSET VALUE EVALUATION
0	2047
1	127
2	255
3	511
4	1023
5	2045
6	4095
7	8191
8	16383
9	32767
10 to 15	65535



8.3.5.1.3 Digital Averaging

The data from two adjacent ADCs (ADC1 and ADC2, ADC3 and ADC4, and so forth) can be averaged by enabling the AVG_EN bit. A scenario where this feature can be useful is where the same analog input is fed to two channels and their outputs are averaged to achieve approximately a 3-dB improvement in SNR. The mapping of DIGOUT to the ADC data is shown in 表 8.

表 8. Mapping of the DIGOUT Words to the ADC Outputs when Using Digital Averaging

DIGOUT	RELATIONSHIP TO ADC DATA	LVDS PAIR THE DA	ATA COME OUT ON
DIGOUT	RELATIONSHIP TO ADC DATA	1X DATA RATE MODE	2X DATA RATE MODE
DIGOUT1	Average of ADC1 and ADC2	DOUT1	DOUT4
DIGOUT2	Average of ADC3 and ADC4	DOUT2	DOUT1
DIGOUT3	Average of ADC5 and ADC6	DOUT3	DOLITO
DIGOUT4	Average of ADC7 and ADC8	DOUT4	DOUT2
DIGOUT5	Ignore	_	_
DIGOUT6	Ignore	_	_
DIGOUT7	Ignore	_	_
DIGOUT8	Ignore	_	_
DIGOUT9	Average of ADC9 and ADC10	DOUT9	DOLITO
DIGOUT10	Average of ADC11 and ADC12	DOUT10	DOUT9
DIGOUT11	Average of ADC13 and ADC14	DOUT11	DOLITAG
DIGOUT12	Average of ADC15 and ADC16	DOUT12	DOUT10
DIGOUT13	Ignore	_	_
DIGOUT14	Ignore	_	_
DIGOUT15	Ignore	_	_
DIGOUT16	Ignore	_	_

8.3.5.1.4 Digital Gain

The digital gain block can be enabled using the DIG_GAIN_EN bit. When enabled, a digital gain programmable from 0 dB to 6 dB in steps of 0.2 dB can be applied. To enable individual digital gain control for each input in 32-input mode, a separate digital gain control is provided for the odd and even sample of each ADC. Therefore, there are 32 gain controls. When using 16-input mode, set the odd and even gain controls of the same ADC to the same value. When using 8-input mode, four sets of gain controls are to be set to the same value (the odd and even gains of adjacent ADCs; for instance, ADC1 and ADC2).

8.3.5.1.5 Digital HPF

A digital high-pass filter (HPF) can be enabled in the path of each ADC word. The enable control is shared between sets of four consecutive-numbered ADCs (ADC1-ADC4, ADC5-ADC8, ADC9-ADC12, and ADC13-ADC16). For example, DIG_HPF_EN_ADC1-4 enables the HPF in the paths of ADCOUT1, ADCOUT2, ADCOUT3, and ADCOUT4. The digital high-pass transfer function is determined by 式 1:

$$Y(n) = \frac{2^{k}}{2^{k} + 1} [x(n) - x(n-1) + y(n-1)]$$
(1)



When DIG_HPF_EN_ADC1-4 is set, the value of K in 式 1 is set by the HPF_CORNER_ADC1-4 bits. The value of K can be programmed from 2 to 10. 表 9 shows the cutoff frequency as a function of K.

表 9. Digital HPF, –1-dB Corner Frequency versus K and f_s

CORNER FREQUENCY (k)	CORNER FREQUENCY (kHz)			
(HPF_CORNER_ADCx Register)	f _S = 40 MSPS	f _S = 50 MSPS	f _S = 65 MSPS	
2	2780	3480	4520	
3	1490	1860	2420	
4	738	230	1200	
5	369	461	600	
6	185	230	300	
7	111	138	180	
8	49	61	80	
9	25	30	40	
10	12.	15	20	

By default the HPF output is truncated to 14 bits. To enable the rounding operation to map the HPF output to the ADC resolution, set the HPF_ROUND_EN_CH1-8 and HPF_ROUND_EN_CH9-16 bits to 1.

8.3.6 Data Formatting

The data formatting block does two functions: truncation and test pattern insertion. The serialization block following the data formatting block performs a parallel-to-serial conversion of the input word. The serialization factor is programmable to 10, 12, 14, or 16. The truncation block truncates the DIGOUT signal to the number of bits specified by the serialization factor. The number of bits in DIGRES1 to DIGRES16 is therefore determined by the serialization factor. Again, some of the bits in DIGRES may always be zero, depending on the combination of ADC resolution, what digital features are enabled or disabled, and the serialization factor that is programmed. To aid the FPGA in capturing and deserializing the serial output, the device includes provisions to replace the ADC data with test patterns. The SERIAL_IN1 to SERIAL_IN16 signals are the same as the DIGRES1 to DIGRES16 signals during normal operation. When a test pattern is programmed, the DIGRES signals are replaced with the appropriate test pattern. The manner in which a given test pattern actually comes out of the LVDS lines can be altered based on the serializer operating mode because the serializer itself has multiple modes (LSB-, MSB-first modes and 1X, 2X data rate modes).

8.3.7 Serializer and LVDS Interface

By default, each serializer takes in one SERIAL_IN word and performs a parallel-to-serial conversion. This mode is referred to as the 1X data rate mode. In the 1X data rate mode, all 16 LVDS pairs are active and each pair corresponds to the data coming out of one ADC. In the 2X data rate mode (set using the LVDS_RATE_2X bit), the data from a pair of ADCs (two SERIAL_IN words) is packed into the same serial stream. In 2X mode, half the LVDS pairs are idle and can be powered down. The 2X data rate mode causes the LVDS interface to run at twice the rate but results in power saving. See the *Timing Requirements: Signal Chain* table for speed restrictions when using the 1X and 2X data rate modes.

The LVDS interface is a clock-data-frame (CDF) format, and has a frame clock and a high-speed bit clock in addition to the serial data lines.



The frequency of the bit clock with respect to the conversion clock frequency depends on the serialization factor (set using the SER_DATA_RATE bits), as shown in 表 10. Note that the serialized data are meant to be captured on both the rising and falling edges of the bit clock. Thus, the serialized data rate is twice the bit clock frequency.

表 10. Bit Clock Rate Relationship to the Conversion Clock and System Clock Rates

SERIALIZATION	DATA RATE MODE	BIT CLOCK RATE	BIT CL	OCK RATE (f _B in Term	s of f _S)
FACTOR	DATA KATE MODE	(f _B in Terms of f _C)	16-INPUT MODE	32-INPUT MODE	8-INPUT MODE
10	1X	$5 \times f_C$	5 × f _S	5 × f _S	2.5 × f _S
10	2X	10 × f _C	10 × f _S	10 × f _S	5 × f _S
12	1X	6 × f _C	6 × f _S	6 × f _S	$3 \times f_S$
	2X	12 × f _C	12 × f _S	12 x f _S	6 × f _S
1.4	1X	$7 \times f_C$	7 × f _S	7 × f _S	$3.5 \times f_S$
14	2X	14 × f _C	14 × f _S	14 × f _S	7 × f _S
4.0	1X	8 × f _C	8 × f _S	8 × f _S	4 × f _S
16	2X	16 × f _C	16 × f _S	16 × f _S	8 × f _S

The relationship of the frame clock frequency to the conversion clock frequency for the three input modes is as shown in 表 11. The relationship of the frame clock frequency to the system clock (and conversion clock) frequencies is the same between the 1X and 2X data rate modes.

表 11. Relation of Frame Clock Rate to the Conversion Clock and System Clock Rates

ANALOG INPUT MODE (Number of Channels)	FRAME CLOCK RATE (f _F in Terms of f _C)	FRAME CLOCK RATE (f _F in Terms of f _S)	DATA RATE MODES SUPPORTED
16	f_C	f _S	1X, 2X
32	0.5 × f _C	0.5 × f _S	1X
8	f _C	0.5 × f _S	1X, 2X

The serialization schemes for the various modes are illustrated in \boxtimes 64 to \boxtimes 68. Note that although the signals marked *ADCx Conversion* in \boxtimes 64 to \boxtimes 68 represent a multi-bit digital word, the SERIAL_OUTx signals are actually serialized representations of the correspondingly colored signals. For example, the blue-colored section in the SERIAL_OUT1 signal in \boxtimes 64 contains the serial stream of data that originated from the word corresponding to ADC1o.



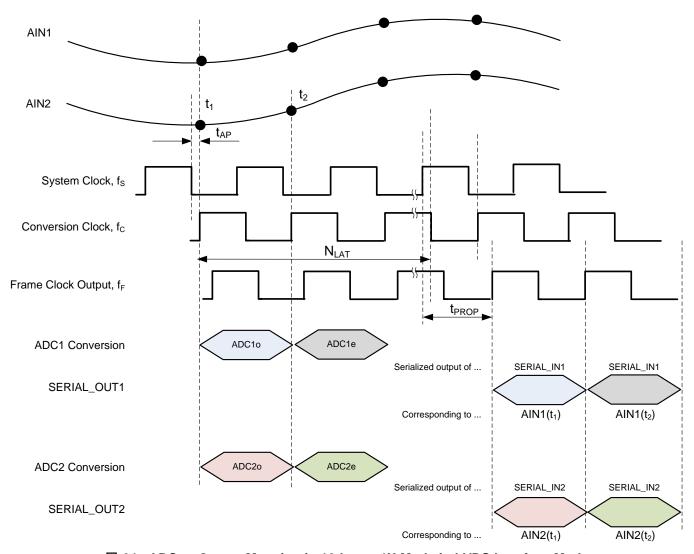


図 64. ADC to Output Mapping in 16-Input, 1X Mode in LVDS Interface Mode



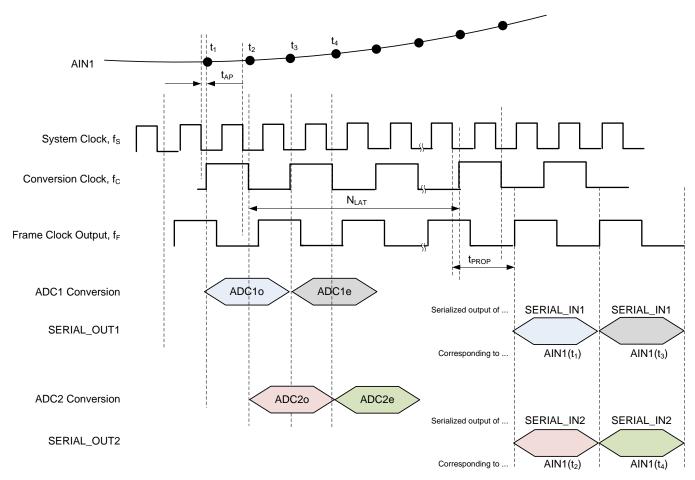


図 65. ADC to Output Mapping in 8-Input, 1X Mode in LVDS Interface Mode



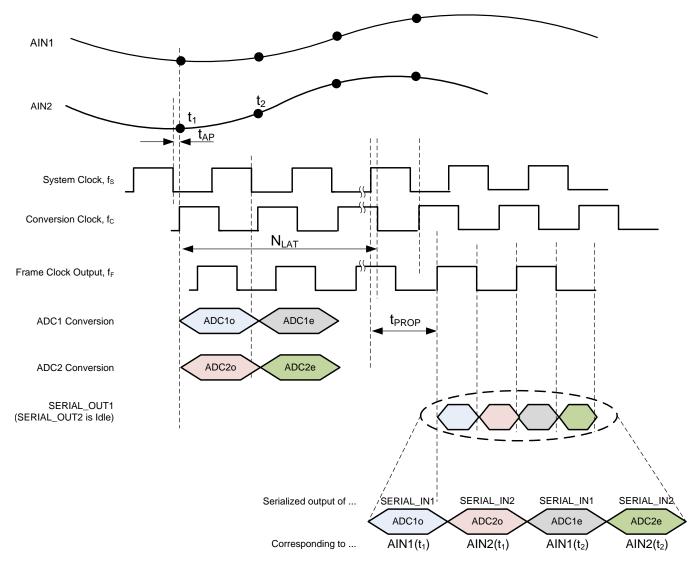


図 66. ADC to Output Mapping in 16-Input, 2X Mode in LVDS Interface Mode



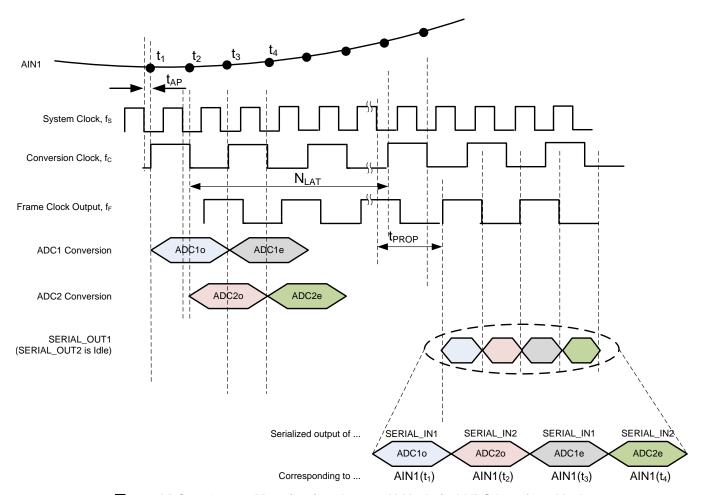


図 67. ADC to Output Mapping in 8-Input, 2X Mode in LVDS Interface Mode



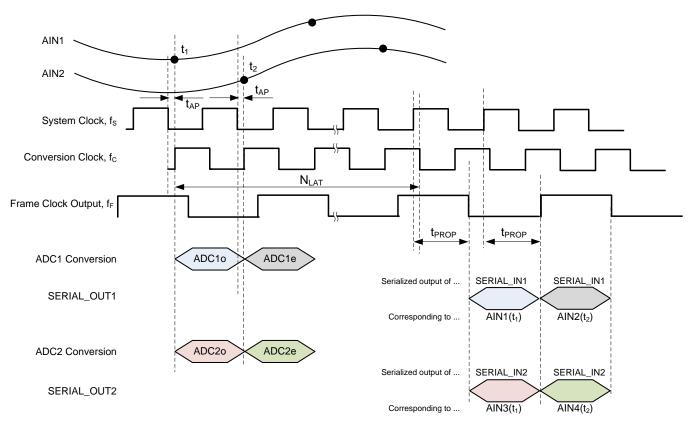


図 68. ADC to Output Mapping in 32-Input, 1X Mode in LVDS Interface Mode

The mapping of the subsequent-numbered ADC signals to subsequent-numbered SERIAL_OUT signals follows the same pattern as indicated previously.

The serialized stream in SERIAL_OUT is a serialized representation of SERIAL_IN, which is the input word coming into the serializer. By default, serialization is done LSB-first. By setting the MSB_FIRST bit, serialization can be set to MSB-first.

The alignment of the frame clock, bit clock, and the serialized output data is illustrated in 🗵 1 for 16-input mode where the serialization factor is set to 12 bit, serialization is LSB-first, and the data rate is set to 1X mode.

Another case is shown in \boxtimes 69 for 16-input mode. Here, the serialization factor is set to 14 bit, serialization is MSB-first, and the data rate is set to 2X mode.

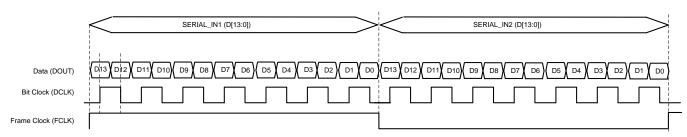


図 69. LVDS Output Signals Timing Diagram in 16-Input Mode with 14-Bit Serialization, MSB-First, 2X Data Rate Mode



The serialized signals come out on the DOUT pins as indicated in 表 12. The buffers marked *Idle* can be powered down using the appropriate register bits to save power.

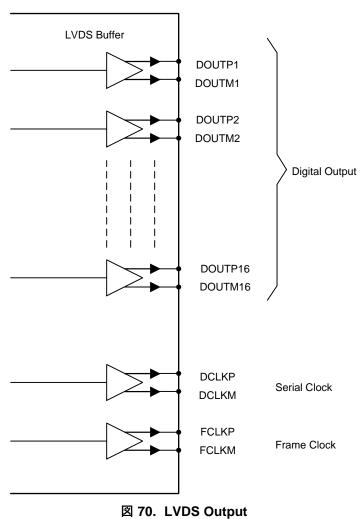
表 12. Mapping of the Serialized Outputs to the DOUT Pins

LVDS OUTPUT PIN (DOUT)	OUTPUT SIGNAL			
LVD3 OUTFUT FIN (DOUT)	1X DATA RATE MODE	2X DATA RATE MODE		
DOUT1	SERIAL_OUT1	SERIAL_OUT1		
DOUT2	SERIAL_OUT2	SERIAL_OUT3		
DOUT3	SERIAL_OUT3	SERIAL_OUT5		
DOUT4	SERIAL_OUT4	SERIAL_OUT7		
DOUT5	SERIAL_OUT5	Idle		
DOUT6	SERIAL_OUT6	Idle		
DOUT7	SERIAL_OUT7	Idle		
DOUT8	SERIAL_OUT8	Idle		
DOUT9	SERIAL_OUT9	SERIAL_OUT9		
DOUT10	SERIAL_OUT10	SERIAL_OUT11		
DOUT11	SERIAL_OUT11	SERIAL_OUT13		
DOUT12	SERIAL_OUT12	SERIAL_OUT15		
DOUT13	SERIAL_OUT13	Idle		
DOUT14	SERIAL_OUT14	Idle		
DOUT15	SERIAL_OUT15	Idle		
DOUT16	SERIAL_OUT16	ldle		



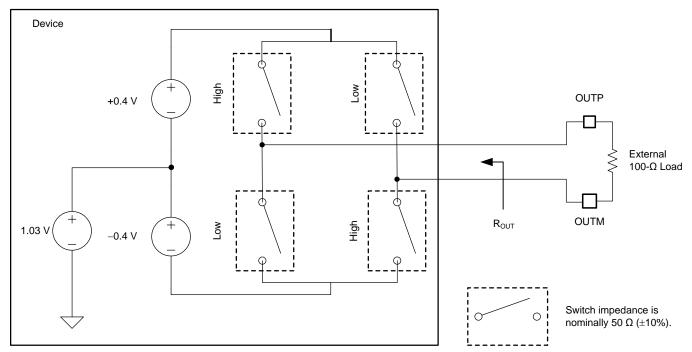
8.3.8 LVDS Buffers

A graphical representation of the 18 LVDS output buffers is shown in 2 70.





The equivalent circuit of each LVDS output buffer is shown in \boxtimes 71. The buffer is designed for a differential output impedance of 100 Ω (R_{OUT}). The differential outputs can be terminated at the receiver end by a 100- Ω termination. The buffer output impedance functions like a source-side series termination. By absorbing reflections from the receiver end, the buffer output impedance helps improve signal integrity.



NOTE: When either the high or low switches are closed, differential R_{OUT} = 100 $\Omega.$

図 71. LVDS Output Circuit

8.3.9 JESD204B Interface

8.3.9.1 Overview

When operating in 16-input and 32-input modes, the device supports a multi-lane output interface based on the JEDEC standard: JESD204B (serial interface for data converters). This interface runs up to 5 Gbps and provides a compact way of routing the data from multiple ADCs in the device to the FPGA. Subclasses 0, 1, and 2 of the JESD204B interface are supported. The block diagram in \boxtimes 72 illustrates the connections of the JESD interface to the rest of the device. After the test pattern insertion block, the parallel data streams SERIAL_IN1 to SERIAL_IN16 can be routed to either the LVDS interface or to the JESD interface (or both). The ADC data can be sent out using the EN_JESD and DIS_LVDS controls. The LVDS_INx and CML_INx words are the same as the SERIAL_INx words.

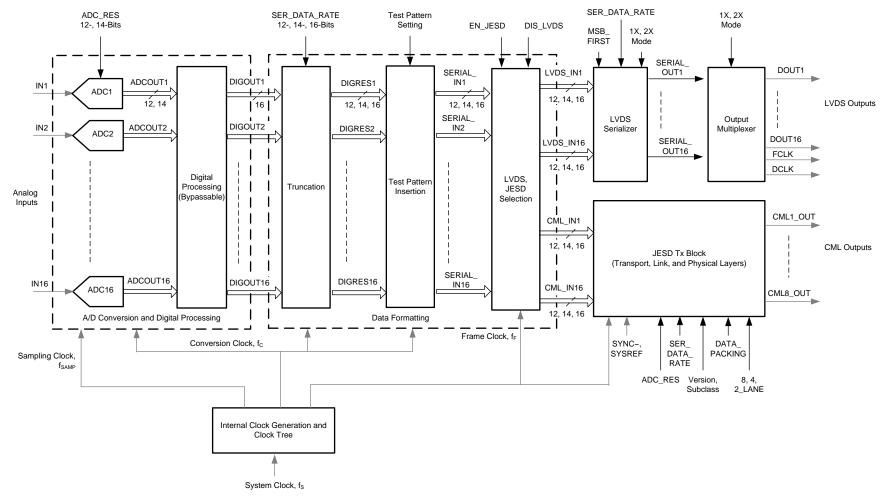


図 72. JESD Interface Connection to the Digital Processing Output



The JESD interface can be enabled by setting the EN_JESD bit to 1. When in JESD mode, the LVDS interface can be disabled by setting the DIS_LVDS bit to 1. Both the LVDS and JESD interfaces can be simultaneously kept active by setting the DIS_LVDS bit to 0 and the EN_JESD bit to 1.

表 13 shows the clock rates corresponding to the various clocks mentioned in the JESD204B document. This mapping is independent of whether the device operates in 8-, 16-, or 32-input mode.

表 13.	Mapping	of JESD204B	Clock Notation to	o the Clock Rates
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CLOCK NOTATION IN JESD204B DOCUMENT	CORRESPONDING CLOCK RATE
Device clock	f _S
Frame clock	f _C
Conversion clock	f _C
Sample clock	f _C

All mandatory features of the JESD204B interface are supported by the device, and are:

- Breaking up of data from the ADCs into octets.
- Optional scrambling of octets to avoid spectral tones.
- · Conversion of (scrambled) octets to 10-bit words using 8b, 10b encoding.
- Parallel-to-serial conversion of octets.
- A code group synchronization (CGS) phase to enable the receiver to synchronize to the frame boundaries.
- An initial lane alignment (ILA) sequence phase to help the receiver align the data from all lanes and also for the receiver to read and verify the link configuration parameters.
- Character replacement at frame and multi-frame boundaries during normal data transmission to enable the receiver to monitor frame alignment.
- Mechanism to achieve deterministic latency across the link using the SYSREF signal in subclass 1 and the SYNC~ signal in subclass 2.

The *Link Configuration* section details only the device-specific implementation aspects of the JESD204B interface. For additional details related to the standard, see the JEDEC standard 204B (July 2011).

8.3.9.2 Link Configuration

The JESD204B link in the device can be configured to operate in different modes using the register controls in 表 14.

表 14. Register Controls Determining Link Configuration Parameters

REGISTER CONTROL	DESCRIPTION	ALLOWED SETTINGS
NUM_ADC_PER_LANE	Number of ADC words packed into one lane	2, 4, 8
ADC_RES	Number of bits resolution in the ADC word input to the JESD transmitter block	10, 12, 14, 16
SER_DATA_RATE	Serialization factor control	10, 12, 14, 16

In addition to the register controls mentioned in 表 14, the SING_CONV_PER_OCT register bit controls the packaging efficiency of the ADC data into octets.

The link configuration parameters are determined by 表 15.



表 15. Link Configuration Parameters

LINK CONFIGURATION PARAMETER			LINK CONF	IGURATION FIELD		
LINK CONFIGURATION PARAMETER	DESCRIPTION	ALLOWED VALUES (Decimal)	DEFAULT VALUE (In Decimal, Unless Otherwise Specified) ⁽¹⁾	METHOD OF SETTING	CORRESPONDING FIELD IN ILAS	RELATION OF FIELD TO PARAMETER
ADJCNT	Not relevant	0	0	Forced to 0; not used	ADJCNT[3:0]	Binary value
ADJDIR	Not relevant	0	0	Forced to 0; not used	ADJDIR[0]	Binary value
BID	Bank ID	015	0	BANK_ID register control	BID[3:0]	Binary value
CF	Number of control words per frame	0	0	Forced to 0	CF[4:0]	Binary value
CS	Number of control bits per sample	0	0	Forced to 0	CS[1:0]	Binary value
DID	Device ID	0255	0	DEVICE_ID register control	DID[7:0]	Binary value
F	Number of octets per frame	See 表 18	6	Determined by 表 18	F[7:0]	Binary value minus 1
HD	High density format	0	0	Forced to 0; not used	HD[0]	Binary value
JESDV	JESD204 version	0 = JESD204A 1 = JESD204B	1	ENABLE_JESD_VER_CONTROL, JESD_VERSION register control; see 表 16	JESDV[2:0]	Binary value
К	Number of frames per multiframe	See 表 16	3	Determined by 表 29; can be changed using FORCE_K and K_VALUE_TO_FORCE register controls	K[4:0]	Binary value minus 1
L	Number of lanes	2, 4, 8	4	Determined by 表 18	L[4:0]	Binary value minus 1
LID	Lane ID	1 to 8	As given in 表 5	Default (value given in 表 17) can be changed using EN_LANE_ID# and LANE_ID# register controls for each lane number	LID[4:0]	Binary value
М	Number of ADCs	16	16	Forced to 16	M[7:0]	Binary value minus 1
N	ADC resolution	10, 12, 14, 16	12	Determined by ADC_RES register control	N[4:0]	Binary value minus 1
N'	Total number of bits per sample	See 表 18	12	Determined by 表 18	N'[4:0]	Binary value minus 1
PHADJ	Not relevant	0	0	Forced to 0; not used	PHADJ[0]	Binary value
S	Number of samples per ADC per frame	1	1	Forced to 1	S[4:0]	Binary value minus 1
SCR	Scrambler enable or disable	0,1	0	SCR_EN register control	SCR[0]	Binary value
SUBCLASSV	Device subclass version	0 = Subclass 0 1 = Subclass 1 2 = Subclass 2	1	ENABLE_JESD_VER_CONTROL, JESD_SUBCLASS register control; see 表 16	SUBCLASSV[2:0]	Binary value
RES1	Reserved field 1	0	0	Forced to 0	RES1[7:0]	Binary value
RES2	Reserved field 2	0	0	Forced to 0	RES2[7:0]	Binary value
CHKSUM	Checksum	-	Lane 1 – 32h Lane 3 – 34h Lane 5 – 36h Lane 7 – 38h	Default value as calculated by device can be changed using EN_CHECKSUM_LANE# and CHECK_SUM# for each lane number	FCHK[7:0]	Binary value

⁽¹⁾ Corresponding to ADC_RES set to 12 bits, SER_DATA_RATE set to 12 bits, NUM_ADC_PER_LANE set to four ADCs per lane, SING_CONV_PER_OCT mode disabled, and ENABLE_JESD_VER_CONTROL set to 0 (to operate in JESD204B-subclass1).



8.3.9.3 JESD Version and Subclass

The interface can be configured to operate either as a JESD204A version or as a JESD204B version. Furthermore, when operating as a JESD204B version, the subclass can be configured as subclass 0, 1, or 2. The register controls for programming the version and subclass are shown in 表 16.

表 16. JESD `	Version	and Subclass	s Control
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				FIELD VALUE	
ENABLE_JESD_ VER_CONTROL	JESD_VERSION	JESD_ SUBCLASS	JESD VERSION	JESD VERSION	SUBCLASS VERSION
0	X ⁽¹⁾	X	JESD204B-subclass1	001	001
1	000	000	JESD204A	000	000
1	001	000	JESD204B-subclass 0	001	000
1	001	001	JESD204B-subclass 1	001	001
1	001	010	JESD204B-subclass 2	001	010

⁽¹⁾ X = don't care.

8.3.9.4 Transport Layer

In the JESD204B transport layer, the incoming stream of ADC samples are mapped to one or more parallel lanes and grouped into a frame of F octets for transmission on each lane. Additional tail bits can be appended to the ADC samples.

8.3.9.4.1 User Data Format

The interface can be configured to operate in 2, 4, or 8 lane modes (L = 2, 4, or 8). Depending on the number of lanes used, the data from the 16 ADCs comes out in the different lanes as shown in $\frac{1}{2}$ 17.

表 17. Lane Mapping to CML Pins⁽¹⁾

DEFAULT LANE ID	MAPPING TO THE PINS	2 ADCS PER LANE (8-Lane Mode) ⁽²⁾	4 ADCS PER LANE (4-Lane Mode) ⁽²⁾	8 ADCS PER LANE (2-Lane Mode) ⁽²⁾
1	CML1_OUTP-CML1_OUTM	ADC1, ADC2	ADC1ADC4	ADC1ADC8
2	CML2_OUTP-CML2_OUTM	ADC3, ADC4	_	_
3	CML3_OUTP-CML3_OUTM	ADC5, ADC6	ADC5ADC8	_
4	CML4_OUTP-CML4_OUTM	ADC7, ADC8	_	_
5	CML5_OUTP-CML5_OUTM	ADC9, ADC10	ADC9ADC12	ADC9ADC16
6	CML6_OUTP-CML6_OUTM	ADC11, ADC12	_	
7	CML7_OUTP-CML7_OUTM	ADC13, ADC14	ADC13ADC16	_
8	CML8_OUTP-CML8_OUTM	ADC15, ADC16	_	_

⁽¹⁾ More accurately, ADC1...ADC16 corresponds to CML_IN1...CML_IN16 as illustrated in Z 72.

The unused lanes are automatically powered down.

The device supports several combinations of ADC resolutions and number of lanes. There are no control bits or control words (CF = 0). The device has two modes of data packing: normal packing mode and single converter per octet mode. The packing mode can be chosen using the SING_CONV_PER_OCT register control. The number of ADCs per lane can be programmed to 8, 4, or 2 using the NUM_ADC_PER_LANE register control. The number of ADCs per lane automatically determines the value of L (the number of lanes). The values of N' and F for the different modes are described in 表 18.

⁽²⁾ Determined by the NUM_ADC_PER_LANE register control.



表 18. Different JESD204B Interface Modes of Operation

NUMBER OF	SER DATA	ADC RES,	- (2)	N ⁽³⁾ (Resolution of	NORMAL PAC	NORMAL PACKING MODE(1)		SINGLE CONVERTER PER OCTET MODE ⁽¹⁾	
ADCS PER LANE, N _{AL} ⁽¹⁾	RATE, N _{SER} ⁽¹⁾⁽²⁾ (Bits)	N _{RES} ⁽¹⁾ (Bits)	L ⁽³⁾ (Lanes)	ADC Word Input to the JESD204B Transmitter)	N' ⁽³⁾ (Total Number of Bits)	F ⁽³⁾ (Octets per Frame)	N' ⁽³⁾ (Total Number of Bits)	F ⁽³⁾ (Octets per Frame)	
8	10, 12, 14, 16	10, 12, 14, 16	2	ADC_RES	SER_DATA_ RATE ⁽⁴⁾	SER_DATA_ RATE	16	16 ⁽⁵⁾	
4	10, 12, 14, 16	10, 12, 14, 16	4	ADC_RES	SER_DATA_ RATE ⁽⁴⁾	SER_DATA_ RATE/2	16	8 ⁽⁵⁾	
	10	10		ADC_RES	12	3 ⁽⁶⁾	16	4 ⁽⁵⁾	
0	12	10, 12	0	ADC_RES	12	3	16	4 ⁽⁵⁾	
2	14	10, 12, 14	8	ADC_RES	16	4 ⁽⁶⁾	16	4 ⁽⁵⁾	
	16	10, 12, 14, 16		ADC_RES	16	4	16	4 ⁽⁵⁾	

- (1) Value or mode is set by programming the appropriate registers.
- (2) SER_DATA_RATE must be greater than or equal to ADC_RES.
- (3) Automatically calculated and set by the device.
- (4) When SER_DATA_RATE > ADC_RES, then each ADC word is additionally padded with the (SER_DATA_RATE ADC_RES) number of zeros on the LSB side to create the JESD ADC word. Each JESD ADC word is broken up into nibbles. Incomplete nibbles (if any) are stuffed with the starting bits of the subsequent JESD ADC word for maximum data packing.
- (5) Each ADC sample is broken into two octets; the incomplete octet is completed using zeros as tail bits.
- (6) Each ADC sample is broken into nibbles; incomplete nibbles are completed using zeros as tail bits.

The data packing modes are described in 表 19 to 表 24 for different modes of operation. Lane 1 is used for illustration purposes in these tables.

表 19. Data Packing in Normal Packing Mode for N_{AL} = 8 and N_{RES} = $N_{SER}^{(1)}$

	I							
OCTET	$N_{RES} = 10,$	N _{SER} = 10	N _{RES} = 12,	N _{SER} = 12	N _{RES} = 14,	N _{SER} = 14	$N_{RES} = 16,$	N _{SER} = 16
OCIEI	NIBBLE 1	NIBBLE 2	NIBBLE 1	NIBBLE 2	NIBBLE 1	NIBBLE 2	NIBBLE 1	NIBBLE 2
1	ADC1[9:6]	ADC1[5:2]	ADC1[11:8]	ADC1[7:4]	ADC1[13:10]	ADC1[9:6]	ADC1[15:12]	ADC1[11:8]
2	ADC1[1:0], ADC2[9:8]	ADC2[7:4]	ADC1[3:0]	ADC2[11:8]	ADC1[5:2]	ADC1[1:0], ADC2[13:12]	ADC1[7:4]	ADC1[3:0]
3	ADC2[3:0]	ADC3[9:6]	ADC2[7:4]	ADC2[3:0]	ADC2[11:8]	ADC2[7:4]	ADC2[15:12]	ADC2[11:8]
4	ADC3[5:2]	ADC3[1:0], ADC4[9:8]	ADC3[11:8]	ADC3[7:4]	ADC2[3:0]	ADC3[13:10]	ADC2[7:4]	ADC2[3:0]
5	ADC4[7:4]	ADC4[3:0]	ADC3[3:0]	ADC4[11:8]	ADC3[9:6]	ADC3[5:2]	ADC3[15:12]	ADC3[11:8]
6	ADC5[9:6]	ADC5[5:2]	ADC4[7:4]	ADC4[3:0]	ADC3[1:0], ADC4[13:12]	ADC4[11:8]	ADC3[7:4]	ADC3[3:0]
7	ADC5[1:0], ADC6[9:8]	ADC6[7:4]	ADC5[11:8]	ADC5[7:4]	ADC4[7:4]	ADC4[3:0]	ADC4[15:12]	ADC4[11:8]
8	ADC6[3:0]	ADC7[9:6]	ADC5[3:0]	ADC6[11:8]	ADC5[13:10]	ADC5[9:6]	ADC4[7:4]	ADC4[3:0]
9	ADC7[5:2]	ADC7[1:0], ADC8[9:8]	ADC6[7:4]	ADC6[3:0]	ADC5[5:2]	ADC5[1:0], ADC6[13:12]	ADC5[15:12]	ADC5[11:8]
10	ADC7[7:4]	ADC8[3:0]	ADC7[11:8]	ADC7[7:4]	ADC6[11:8]	ADC6[7:4]	ADC5[7:4]	ADC5[3:0]
11	_	_	ADC7[3:0]	ADC8[11:8]	ADC6[3:0]	ADC7[13:10]	ADC6[15:12]	ADC6[11:8]
12	_	_	ADC8[7:4]	ADC8[3:0]	ADC7[9:6]	ADC7[5:2]	ADC6[7:4]	ADC6[3:0]
13	_			_	ADC7[1:0], ADC8[13:12]	ADC8[11:8]	ADC7[15:12]	ADC7[11:8]
14		_	_	_	ADC8[7:4]	ADC8[3:0]	ADC7[7:4]	ADC7[3:0]
15	_	_	_	_	_	_	ADC8[15:12]	ADC8[11:8]
16	_	_	_	_	_	_	ADC8[7:4]	ADC8[3:0]

(1) A similar data packing scheme is used for other lanes with the mapping of ADCs per lane as indicated in 表 17.



表 20. Data Packing in Normal Packing Mode for N_{AL} = 8 and N_{SER} > N_{RES} ⁽¹⁾

OCTET	N _{RES} = 10,	N _{SER} = 12	N _{RES} = 12,	N _{SER} = 14	N _{RES} = 14,	N _{SER} = 16
OCTET	NIBBLE 1	NIBBLE 2	NIBBLE 1	NIBBLE 2	NIBBLE 1	NIBBLE 2
1	ADC1[9:6]	ADC1[5:2]	ADC1[11:8]	ADC1[7:4]	ADC1[13:10]	ADC1[9:6]
2	ADC1[1:0], 00	ADC2[9:6]	ADC1[3:0]	00,ADC2[11:10]	ADC1[5:2]	ADC1[1:0], 00
3	ADC2[5:2]	ADC2[1:0], 00	ADC2[9:6]	ADC2[5:2]	ADC2[13:10]	ADC2[9:6]
4	ADC3[9:6]	ADC3[5:2]	ADC2[1:0],00	ADC3[11:8]	ADC2[5:2]	ADC2[1:0], 00
5	ADC3[1:0], 00	ADC4[9:6]	ADC3[7:4]	ADC3[3:0]	ADC3[13:10]	ADC3[9:6]
6	ADC4[5:2]	ADC4[1:0], 00	00,ADC4[11:10]	ADC4[9:6]	ADC3[5:2]	ADC3[1:0], 00
7	ADC5[9:6]	ADC5[5:2]	ADC4[5:2]	ADC4[1:0],00	ADC4[13:10]	ADC4[9:6]
8	ADC5[1:0], 00	ADC6[9:6]	ADC5[11:8]	ADC5[7:4]	ADC4[5:2]	ADC4[1:0], 00
9	ADC6[5:2]	ADC6[1:0], 00	ADC5[3:0]	00,ADC6[11:10]	ADC5[13:10]	ADC5[9:6]
10	ADC7[9:6]	ADC7[5:2]	ADC6[9:6]	ADC6[5:2]	ADC5[5:2]	ADC5[1:0], 00
11	ADC7[1:0], 00	ADC8[9:6]	ADC6[1:0],00	ADC7[11:8]	ADC6[13:10]	ADC6[9:6]
12	ADC8[5:2]	ADC8[1:0], 00	ADC7[7:4]	ADC7[3:0]	ADC6[5:2]	ADC6[1:0], 00
13	_	_	00,ADC8[11:10]	ADC8[9:6]	ADC7[13:10]	ADC7[9:6]
14			ADC8[5:2]	ADC8[1:0],00	ADC7[5:2]	ADC7[1:0], 00
15			_		ADC8[13:10]	ADC8[9:6]
16	_		_	_	ADC8[5:2]	ADC8[1:0], 00

⁽¹⁾ A similar data packing scheme is used for other lanes with the mapping of ADCs per lane as indicated in 表 17.

表 21. Data Packing in Normal Packing Mode for $N_{AL} = 4$ and $N_{RES} = N_{SER}^{(1)}$

OCTET	N _{RES} = 10, NS		N _{RES} = 12,	N _{RES} = 12, N _{SER} = 12		N _{SER} = 14	N _{RES} = 16, N _{SER} = 16	
OCIEI	NIBBLE 1	NIBBLE 2	NIBBLE 1	NIBBLE 2	NIBBLE 1	NIBBLE 2	NIBBLE 1	NIBBLE 2
1	ADC1[9:6]	ADC1[5:2]	ADC1[11:8]	ADC1[7:4]	ADC1[13:10]	ADC1[9:6]	ADC1[15:12]	ADC1[11:8]
2	ADC1[1:0], ADC2[9:8]	ADC2[7:4]	ADC1[3:0]	ADC2[11:8]	ADC1[5:2]	ADC1[1:0], ADC2[13:12]	ADC1[7:4]	ADC1[3:0]
3	ADC2[3:0]	ADC3[9:6]	ADC2[7:4]	ADC2[3:0]	ADC2[11:8]	ADC2[7:4]	ADC2[15:12]	ADC2[11:8]
4	ADC3[5:2]	ADC3[1:0], AD4[9:8]	ADC3[11:8]	ADC3[7:4]	ADC2[3:0]	ADC3[13:10]	ADC2[7:4]	ADC2[3:0]
5	ADC4[7:4]	ADC4[3:0]	ADC3[3:0]	ADC4[11:8]	ADC3[9:6]	ADC3[5:2]	ADC3[15:12]	ADC3[11:8]
6	_	_	ADC4[7:4]	ADC4[3:0]	ADC3[1:0], ADC4[13:12]	ADC4[11:8]	ADC3[7:4]	ADC3[3:0]
7	_	_	_	_	ADC4[7:4]	ADC4[3:0]	ADC4[15:12]	ADC4[11:8]
8	_	_	_	_	_	_	ADC4[7:4]	ADC4[3:0]

⁽¹⁾ A similar data packing scheme is used for other lanes with the mapping of ADCs per lane as indicated in 表 17.

表 22. Data Packing in Normal Packing Mode for N_{AL} = 4 and $N_{SER} > N_{RES}^{(1)}$

OCTET	N _{RES} = 10, NSER = 12		N _{RES} = 12,	N _{SER} = 14	N _{RES} = 14, N _{SER} = 16		
OCIEI	NIBBLE 1	NIBBLE 2	NIBBLE 1	NIBBLE 2	NIBBLE 1	NIBBLE 2	
1	ADC1[9:6]	ADC1[5:2]	ADC1[11:8]	ADC1[7:4]	ADC1[13:10]	ADC1[9:6]	
2	ADC1[1:0], 00	ADC2[9:6]	ADC1[3:0]	00,ADC2[11:10]	ADC1[5:2]	ADC1[1:0], 00	
3	ADC2[5:2]	ADC2[1:0], 00	ADC2[9:6]	ADC2[5:2]	ADC2[13:10]	ADC2[9:6]	
4	ADC3[9:6]	ADC3[5:2]	ADC2[1:0],00	ADC3[11:8]	ADC2[5:2]	ADC2[1:0], 00	
5	ADC3[1:0], 00	ADC4[9:6]	ADC3[7:4]	ADC3[3:0]	ADC3[13:10]	ADC3[9:6]	
6	ADC4[5:2]	ADC4[1:0], 00	00,ADC4[11:10]	ADC4[9:6]	ADC3[5:2]	ADC3[1:0], 00	
7	_	_	ADC4[5:2]	ADC4[1:0],00	ADC4[13:10]	ADC4[9:6]	
8	_	_	_	_	ADC4[5:2]	ADC4[1:0], 00	

⁽¹⁾ A similar data packing scheme is used for other lanes with the mapping of ADCs per lane as indicated in 表 17.



表 23. Data Packing in Normal Packing Mode for $N_{AL} = 2^{(1)}$

OCTET	N _{RES} = 10, NSER = 10 or 12		N _{RES} = 12,	N _{RES} = 12, N _{SER} = 12		N _{RES} = 14, N _{SER} = 14 or 16		N _{RES} = 16, N _{SER} = 16	
OCIEI	NIBBLE 1	NIBBLE 2	NIBBLE 1	NIBBLE 2	NIBBLE 1	NIBBLE 2	NIBBLE 1	NIBBLE 2	
1	ADC1[9:6]	ADC1[5:2]	ADC1[11:8]	ADC1[7:4]	ADC1[13:10]	ADC1[9:6]	ADC1[15:12]	ADC1[11:8]	
2	ADC1[1:0], 00	ADC2[9:6]	ADC1[3:0]	ADC2[11:8]	ADC1[5:2]	ADC1[1:0], 00	ADC1[7:4]	ADC1[3:0]	
3	ADC2[5:2]	ADC3[1:0], 00	ADC2[7:4]	ADC2[3:0]	ADC2[13:10]	ADC2[9:6]	ADC2[15:12]	ADC2[11:8]	
4	_	_	_	_	ADC2[5:2]	ADC2[1:0], 00	ADC2[7:4]	ADC2[3:0]	

⁽¹⁾ A similar data packing scheme is used for other lanes with the mapping of ADCs per lane as indicated in 表 17.

表 24. Data Packing in Single Converter per Octet Packing Mode for $N_{AL} = 8$ (Independent of N_{SER})⁽¹⁾⁽²⁾

OCTET	N _{RES}	= 10	N _{RES}	= 12	N _{RES}	= 14	N _{RES} = 16,	N _{SER} = 16
OCTET	NIBBLE 1	NIBBLE 2	NIBBLE 1	NIBBLE 2	NIBBLE 1	NIBBLE 2	NIBBLE 1	NIBBLE 2
1	ADC1[9:6]	ADC1[5:2]	ADC1[11:8]	ADC1[7:4]	ADC1[13:10]	ADC1[9:6]	ADC1[15:12]	ADC1[11:8]
2	ADC1[1:0], 00	0000	ADC1[3:0]	0000	ADC1[5:2]	ADC1[1:0], 00	ADC1[7:4]	ADC1[3:0]
3	ADC2[9:6]	ADC2[5:2]	ADC2[11:8]	ADC2[7:4]	ADC2[13:10]	ADC2[9:6]	ADC2[15:12]	ADC2[11:8]
4	ADC2[1:0], 00	0000	ADC2[3:0]	0000	ADC2[5:2]	ADC2[1:0], 00	ADC2[7:4]	ADC2[3:0]
5	ADC3[9:6]	ADC3[5:2]	ADC3[11:8]	ADC3[7:4]	ADC3[13:10]	ADC3[9:6]	ADC3[15:12]	ADC3[11:8]
6	ADC3[1:0], 00	0000	ADC3[3:0]	0000	ADC3[5:2]	ADC3[1:0], 00	ADC3[7:4]	ADC3[3:0]
7	ADC4[9:6]	ADC4[5:2]	ADC4[11:8]	ADC4[7:4]	ADC4[13:10]	ADC4[9:6]	ADC4[15:12]	ADC4[11:8]
8	ADC4[1:0], 00	0000	ADC4[3:0]	0000	ADC4[5:2]	ADC4[1:0], 00	ADC4[7:4]	ADC4[3:0]
9	ADC5[9:6]	ADC5[5:2]	ADC5[11:8]	ADC5[7:4]	ADC5[13:10]	ADC5[9:6]	ADC5[15:12]	ADC5[11:8]
10	ADC5[1:0], 00	0000	ADC5[3:0]	0000	ADC5[5:2]	ADC5[1:0], 00	ADC5[7:4]	ADC5[3:0]
11	ADC6[9:6]	ADC6[5:2]	ADC6[11:8]	ADC6[7:4]	ADC6[13:10]	ADC6[9:6]	ADC6[15:12]	ADC6[11:8]
12	ADC6[1:0], 00	0000	ADC6[3:0]	0000	ADC6[5:2]	ADC6[1:0], 00	ADC6[7:4]	ADC6[3:0]
13	ADC7[9:6]	ADC7[5:2]	ADC7[11:8]	ADC7[7:4]	ADC7[13:10]	ADC7[9:6]	ADC7[15:12]	ADC7[11:8]
14	ADC7[1:0], 00	0000	ADC7[3:0]	0000	ADC7[5:2]	ADC7[1:0], 00	ADC7[7:4]	ADC7[3:0]
15	ADC8[9:6]	ADC8[5:2]	ADC8[11:8]	ADC8[7:4]	ADC8[13:10]	ADC8[9:6]	ADC8[15:12]	ADC8[11:8]
16	ADC8[1:0], 00	0000	ADC8[3:0]	0000	ADC8[5:2]	ADC8[1:0], 00	ADC8[7:4]	ADC8[3:0]

⁽¹⁾ For $N_{AL} = 4$, use the first eight octets. For $N_{AL} = 2$, use the first four octets.

Tail bits (in modes where applicable) are set to 0. There is no option for a pseudo-random generator for generating the tail bits. When a converter is powered down, the corresponding sample is replaced by a dummy sample that corresponds to all zeros. There is no option for a pseudo-random generator for generating the dummy samples. The value S (number of samples per ADC per frame minus 1) is always 0 and HD mode is not supported.

8.3.9.4.2 Transport Layer Test Patterns

All test patterns described in the *LVDS Test Pattern Mode* section can be set, even with the JESD204B interface. These test patterns serve as transport layer test modes for the JESD interface. These test patterns can replace the normal ADC data going into the JESD204B link layer.

8.3.9.5 Scrambler

An optional scrambler is implemented in the device using the polynomial as defined in the JESD204B standard. The scrambler can be enabled using the SCR_EN register control. The scrambler is bypassed during the code group synchronization and transmission of the initial lane alignment sequence. There is no alternate scrambler to keep processing the user data during these states.

⁽²⁾ A similar data packing scheme is used for other lanes with the mapping of ADCs per lane as indicated in 表 17.



8.3.9.6 Data Link Layer

The data link layer of the JESD204B block handles various functions (such as the 8b, 10b encoding of the input octets, code group synchronization (CGS), transmission of an initial lane alignment (ILA) sequence, frame alignment character replacement, and transmission of link layer test patterns). As specified by the standard, the device uses 8b, 10b coding to encode the data before being transmitted. The frame contents are processed from MSB to LSB.

8.3.9.6.1 Code Group Synchronization (CGS)

In the CGS state, the device transmits a set of /K28.5/ characters that are used by the receiver to recover the clock and data from the serial stream using a clock and data recovery (CDR) circuit, and also to align to the symbol boundaries. The device enters the CGS state when it receives an active (low going) SYNC pulse that is at least four device clocks wide. In addition, when the device is in the CGS state as defined by the JESD204B standard, the device can also be made to transmit a stream of /K28.5/ symbols by programming the TX_SYNC_REQ register control.

8.3.9.6.2 Initial Lane Alignment (ILA)

By default, the CGS phase is followed by the transmission of an ILA sequence. The ILA transmission can be disabled using the LINK_CONFIG_DIS register control. Transitioning from a CGS state to an ILA sequence state occurs on the local multiframe clock (LMFC) boundary. By default, the transition occurs at the first LMFC boundary after SYNC~ is deasserted. However, the transition point can be delayed to the second, third, or fourth LMFC edge by programming the RELEASE_ILA register control to 1, 2, or 3, respectively. This mode can be used to provide sufficient time to the receiver to achieve synchronization.

8.3.9.6.3 Lane and Frame Alignment Monitoring

The lane and frame alignment monitoring and character replacement are as per the JESD204B standard. The insertion of frame and lane alignment characters can be enabled by setting the LANE_ALIGN and FRAME_ALIGN register controls. These controls, in conjunction with the SCR_EN control, determine the mechanism of the lane and frame alignment character replacement, as shown in 表 25.

SCR_EN	FRAME_ALIGN	LANE_ALIGN	EFFECT ON LINK DATA
0	0	0	ADC data are sent without any character replacement.
0	0	1	If the last octet of the multiframe is the same as the last octet of the previous multiframe, then the last octet is replaced with /K28.3/.
0	1	0	If the last octet of the frame is the same as the last octet of the previous frame, then the last octet is replaced with /K28.7/. If an alignment character has already been sent in the previous frame, then no characters are replaced.
0	1	1	Frame and lane alignment character replacements are enabled.
1	0	0	ADC data are scrambled and sent without any character replacement.
1	0	1	If the last scrambled octet of the multiframe is D28.3, then that octet is replaced with /K28.3/.
1	1	0	If the last scrambled octet of the frame is D28.7, then that octet is replaced with /K28.7/.
1	1	1	Frame and lane alignment character replacements are enabled with scrambling.

表 25. Character Replacement for Lane and Frame Alignment

8.3.9.6.4 Link Layer Test Modes

The JESD link can be tested by transmitting predetermined 8b, 10b characters in all frames and on all lanes. Test modes can be enabled with the LINK_LAYER_TESTMODES register control. These test patterns are never scrambled. A pseudo-random pattern of 120 bits corresponds to the random pattern (RPAT). An additional PRBS pattern can be output by setting the transport layer test mode to a constant pattern and enabling the scrambler. A scrambled jitter pattern (JSPAT) is not supported.

8.3.9.7 Deterministic Latency

Deterministic latency is achieved in the subclass 1 and subclass 2 of the JESD204B standard through a local multiframe clock (LMFC) that is synchronized between the transmitter and receiver. The phase of the LMFC is dictated by the sampled SYSREF input in subclass 1 and by the SYNC~ rising edge in subclass 2.

8.3.9.7.1 Synchronization Using SYNC~ and SYSREF

In order to achieve deterministic latency across the entire link, the device supports system-level link synchronization using the SYNC~ (in subclass 2) and SYSREF (in subclass 1) signals, as mentioned in the JESD204B standards document. The mapping of these signals to the pin voltages is shown in 表 26.

表 26. Mapping of the JESD204B Signals to Device Pins

SIGNAL NOTATION IN JESD204B DOCUMENT	RELATION TO DEVICE PINS
Device clock	ADC_CLKP – ADC_CLKM
SYNC~	SYNCP_SERDES - SYNCM_SERDES
SYSREF ⁽¹⁾	SYSREFP_SERDES - SYSREFM_SERDES

⁽¹⁾ Must be inactive (low) except when operating in JESD204B subclass 1.

JESD subclasses 1 and 2 use an internal clock called the local multiframe clock (LMFC) to achieve deterministic latency in the link. The phase of the LMFC clock is set based on the device clock rising edge that the SYSREF (in subclass 1) or SYNC~(in subclass 2) signals are sampled on. The device clock is the highest speed input clock for the device and there is no provision for a higher speed adjustment clock to achieve phase adjustments finer than what is achievable using the device clock. By default, the LMFC count is reset to 0 during a SYNC~ or SYSREF event. This reset count can be forced to a different value by using the FORCE_LMFC_COUNT and LMFC_COUNTER_INIT_VALUE register controls. The LMFC does not exist in JESD subclass 0.

SYSREF can be a periodic, one-shot, or gapped periodic active-high signal that is sampled on the rising edge of the device clock. There is no option to sample the SYSREF signal on the falling edge of the device clock. If SYSREF is a periodic or gapped periodic signal, then its periodicity must be a multiple of the LMFC period in order to avoid unwanted sudden shifts in the phase of the LMFC. Note that a continuous periodic SYSREF can cause spurious degradation in the ADC performance because of energy coupling into the device at a rate that is a sub-harmonic of the device clock rate.

In addition to resetting the phase of the LMFC, SYSREF (or SYNC~) also resets some of the other internal clock dividers not related to the JESD block and affects the reset of the phase of the test pattern generator (see the LVDS Test Pattern Mode section). SYSREF (or SYNC~) also affects the reset of the frame clock phases and the odd or even sampling selection in 32-channel mode.

The default mode is to reset all internal dividers as well as the phase of the LMFC during every SYSREF (or SYNC~) event based on the JESD subclass.

The reset operations based on SYNC~ and SYSREF for the different subclasses occurs as shown in 表 27.

表 27. Reset Operations from SYNC~ or SYSREF in the Various JESD204B Subclasses

	EVENT CONTROLLING THE	What gets reset				
SUBCLASS	RESET	JESD BLOCK (Phase of the LMFC Clock)	REST OF DEVICE			
JESD204B-subclass 0	SYNC~ rising edge	Not applicable	Yes			
JESD204B-subclass 1	SYSREF ⁽¹⁾	Yes	Yes			
JESD204B-subclass 2	SYNC~ rising edge	Yes	Yes			
JESD204A	SYNC~ rising edge	Not applicable	Yes			

⁽¹⁾ To avoid unexpected reset behavior, SYSREF must be active only when operating in JESD204B subclass 1.



表 28 lists the register controls to selectively mask the reset operations of the various blocks.

表 28. Masking of the Various Reset Operations Resulting from SYNC~ or SYSREF

	MASKS RESET OPERATION IN				
REGISTER BIT	JESD BLOCK (Phase of the LMFC Clock)	CLOCK DIVIDERS	OTHER SYNCHRONIZATION ⁽¹⁾		
JESD_RESET1	No	Yes	Yes		
JESD_RESET2	Yes	Yes	No		

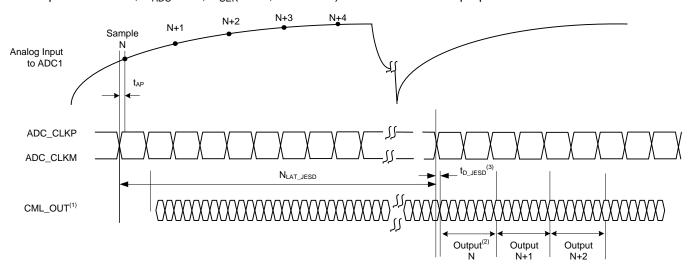
⁽¹⁾ Demodulators and test pattern generation.

The JESD_RESET1 and JESD_RESET2 bits mask the reset operations as indicated in 表 28 for all subsequent SYNC~ and SYSREF events after the bits are set. The JESD_RESET3 register bit is functionally similar to JESD_RESET2 (in terms of masking the reset function to the blocks). However, when JESD_RESET3 is set, this bit allows the first SYNC~ or SYSREF event to reset all clock dividers, takes affect, and masks the reset of the LMFC clock divider only after the first SYNC~ or SYSREF event occurs. The JESD_RESET1, JESD_RESET2, and JESD_RESET3 bits can be used appropriately to avoid unwanted reset operations resulting from SYNC~ and SYSREF events.

When SYSREF resets the rest of the device, the ADC data can be corrupted for four to six clocks. If SYSREF is periodic, then periodic corruption of ADC data can result. Thus, when using a periodic or a gapped periodic SYSREF, one JESD_RESET (JESD_RESET1, JESD_RESET2, or JESD_RESET3) must be set to 1.

8.3.9.7.2 Latency

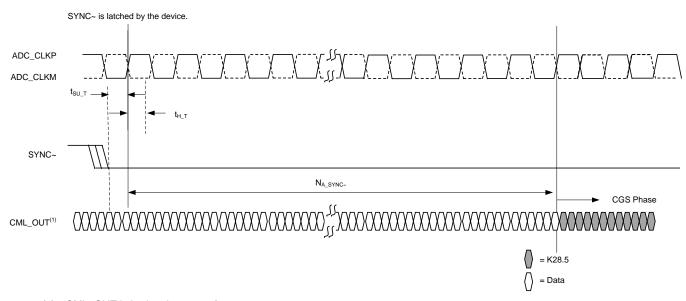
 \boxtimes 73 to \boxtimes 76 illustrate the relevant latencies for the JESD interface with the default mode of operation (four ADCs per lane mode, N_{ADC} = 12, N_{SER} = 12, and K = 3) used for illustration purposes.



- (1) CML_OUT is shown broken in terms of octets.
- (2) The ADC word corresponding to ADC1 is contained in the first two octets of output N.
- (3) t_{D JESD} is a small additional variable delay which is a fraction of the device clock period.

図 73. ADC Latency in JESD Mode





(1) CML_OUT is broken in terms of octets.

図 74. Latency from SYNC~ Assertion to Start of CGS Phase

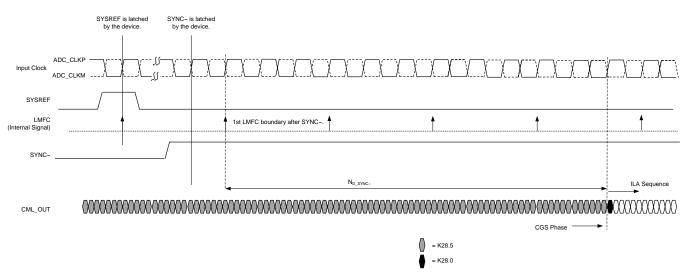


図 75. Latency from SYNC~ Deassertion to Start of ILA Phase in Subclass 1



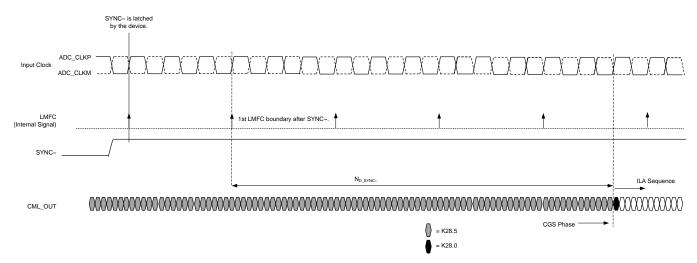


図 76. Latency from SYNC~ Deassertion to Start of ILA Phase in Subclass 2

8.3.9.7.3 Multiframe Size

The size of the multiframe (as well as the periodicity of the LMFC clock) is denoted as K. Multiframe size is calculated as shown in ± 2 :

Ceil (17 / Number of Octets per Frame) ≤ Multiframe Size (In Terms of Number of Frames)

(2)

表 29 lists the multiframe size for different modes of operation.

表 29. Multiframe Size in Different Modes⁽¹⁾

ADC RESOLUTION	2 ADCS PER LANE ⁽²⁾			4 ADCS PER LANE ⁽²⁾			8 ADCS PER LANE ⁽²⁾		
	FRAME SIZE	MULTIFRAME SIZE		FRAME SIZE	MULTIFRAME SIZE		FRAME SIZE	MULTIFRAME SIZE	
(Bits)	(Octets)	FRAMES	OCTETS	(Octets)	FRAMES	OCTETS	(Octets)	FRAMES	OCTETS
12	3	6	18	6	3	18	12	2	24
14	4	5	20	7	3	21	14	2	28
16	4	5	20	8	3	24	16	2	32

⁽¹⁾ The decimal equivalent of K[4:0] in the link configuration parameter is equal to the multiframe size (in frames) minus 1.

8.3.9.8 JESD Physical Layer

The JESD transmitter uses a PLL that runs off an internal low-dropout (LDO) regulator that provides noise rejection on the external 1.2-V supply. At higher speeds (beyond 4 Gbps), the LDO voltage drops because of increased switching currents. To improve the jitter at higher speeds, restore the LDO voltage with the INC_JESD_VDD register control.

⁽²⁾ Determined by the register control NUM_ADC_PER_LANE.



8.3.9.8.1 CML Buffer

The device JESD204B transmitter uses differential CML output drivers with a typical current drive of 16 mA. The output driver includes an internal $50-\Omega$ termination to the DVDD_1P2 supply. Additionally, external $50-\Omega$ termination resistors connected to DVDD_1P2 must be placed close to the receiver pins. DC compliance to the standard is not ensured and ac coupling can be used to avoid the common-mode mismatch between the transmitter and receiver, as shown in $\boxed{2}$ 77.

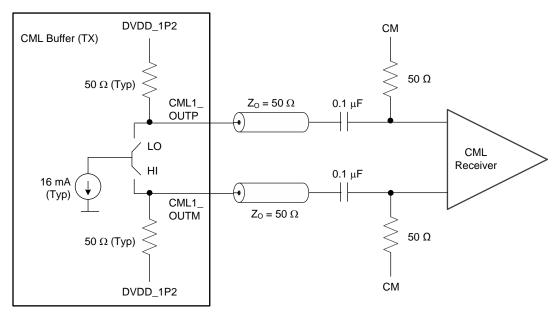


図 77. CML Output Connections

The CML buffer also has a pre-emphasis control for improving the timing margins. Pre-emphasis is achieved by increasing the CML buffer current if the current transmitter bit is different from the previous one. The current of the CML buffer for a transitioning bit can be increased from the CML buffer current setting to one of 16 settings in steps of 0.25 mA using the PRE_EMP register control. Pre-emphasis is recommended to be used at higher speeds in order to improve the timing margins.



8.3.9.8.2 Jitter Considerations

☑ 78 shows the data eye measurement of the device JESD204B transmitter against the JESD204B transmitter eye mask at 3.125 Gbps.

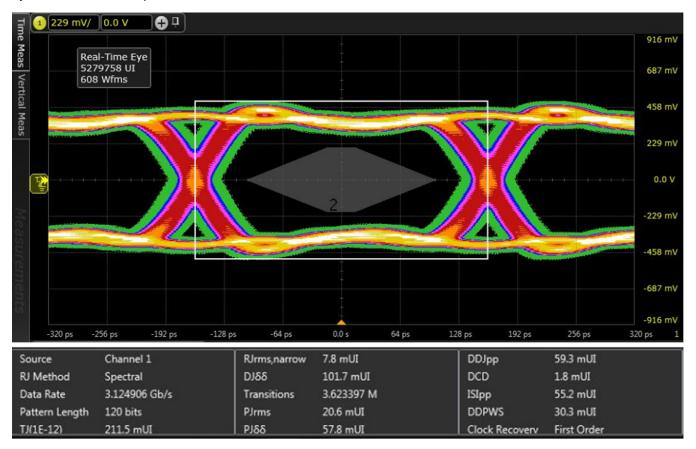


図 78. Eye Diagram at the CML Output at a Data Rate of 3.125 Gbps



🗵 79 shows the data eye measurement of the device JESD204B transmitter against the JESD204B transmitter eye mask at 5 Gbps. This measurement is taken with PRE EMP set to 7.

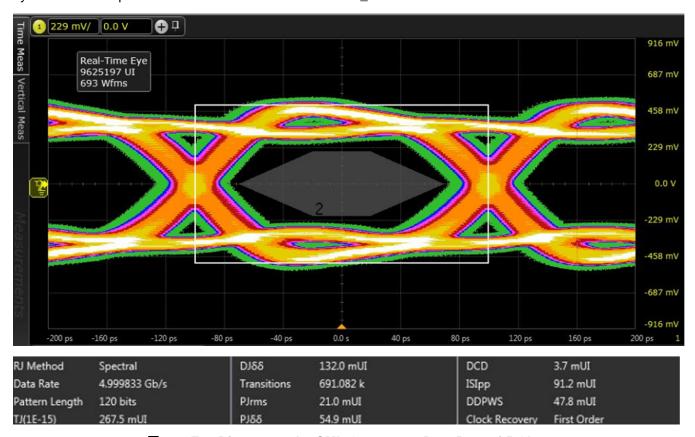


図 79. Eye Diagram at the CML Output at a Data Rate of 5 Gbps

The total jitter as a fraction of the UI changes with interface speed, pre-emphasis setting, and the length of the trace from the transmitter pins to the external termination resistor. The total jitter at the transmitter pins can exceed the transmitter eye mask specification for speeds beyond 5 Gbps. However, the interface can be made to work (and meet the eye mask specification at the receiver inputs) at speeds higher than 5 Gbps for short trace lengths. 2 40 illustrates the total jitter as a function of the trace length (between the transmitter pins and the termination resistor) for 5-Gbps, 6-Gbps, and 6.4-Gbps speeds. 41 to 43 illustrate the total jitter as a function of the trace length for different pre-emphasis settings at 5 Gbps, 6 Gbps, and 6.4 Gbps, respectively.



8.3.10 Interfacing SYNC~ and SYSREF Between the FPGA and ADCs

The SYNC~ and SYSREF signals must be connected to the FPGA and the multiple ADCs in the system. When driving SYNC~ and SYSREF using differential signals, additional interface circuits may be required to decouple the common-mode levels between the FPGA and the ADC. ☒ 80 shows an overview of such a scheme for driving the SYNC~ signal from the FPGA to multiple ADCs.

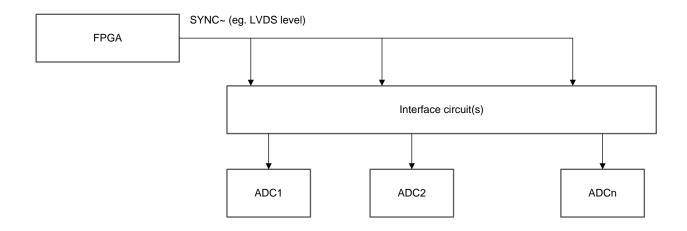


図 80. Connection of SYNC~ From the FPGA to the ADCs

The ADC has internal 5-k Ω resistors from the SYNCP and SYNCM pins to an internal reference voltage of 0.7 V. When driven by a differential driver, an interface circuit may be required to match the common-mode voltages between the driver and the ADC. An example circuit is shown in \boxtimes 81 to level-shift from a 1.2-V common-mode voltage at the driver output to the 0.7 V at the ADC input. The 100 Ω at the driver output depicts the differential termination and could be realized inside the FPGA.

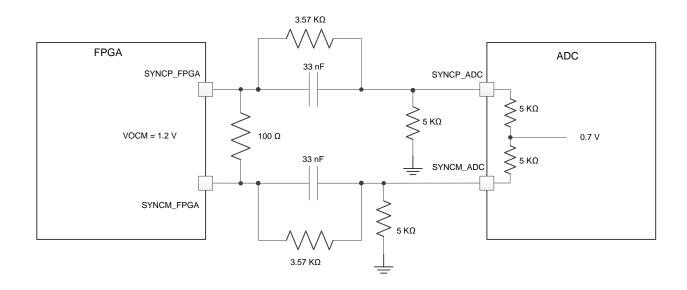


図 81. Circuit to Level-Shift the Common-Mode Voltage From 1.2 V at the Driver Output to 0.7 V at the ADC Input



For a different driver output common-mode than the one shown in 281, the interface circuit must be modified.

A similar circuit as shown in \boxtimes 81 can also be used to interface the SYSREF signals to the ADC. As shown in \boxtimes 82, the SYSREF signal can also be driven using an ac-coupling scheme. The external components are chosen for a case where the SYSREF source drives only one ADC. The values of these components must be changed if the signal is interfaced to multiple ADCs (contact the factory for details).

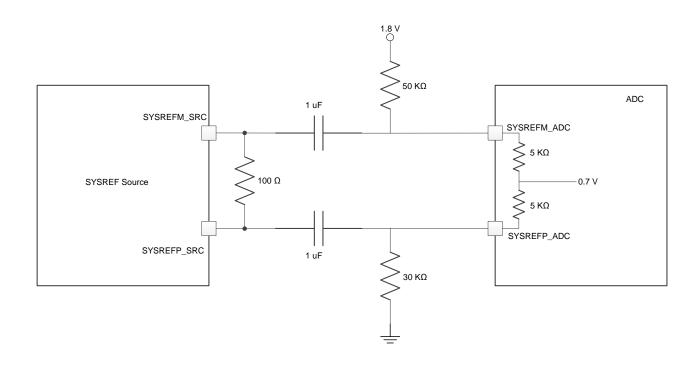


図 82. AC-Coupling Scheme for SYSREF (do not use for SYNC~)

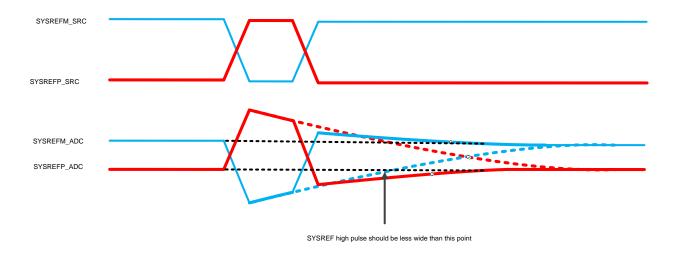


図 83. Transient of SYSREF With AC-Coupling



The 50-k Ω and 30-k Ω external resistors along with the two 5-k Ω resistors internal to the ADC form a voltage divider circuit to generate a negative differential offset at the ADC SYSREF input when SYSREF is low. A high-going pulse on the SYSREF_SRC signal passes through the ac-coupling capacitor. The ac-coupling capacitor and the resistors form a high-pass filter and cause the SYSREF_ADC signal to droop towards their quiescent values over time (denoted by the dotted lines in \boxtimes 83). However, if the high width of SYSREF is much lower than the time constant of the filter, the circuit is able to pass the pulse properly.

The SYNC~ and SYSREF signals also can be driven using single-ended LVCMOS levels, which can be done by driving the P side with the LVCMOS level and connecting the M side to ground as shown in \boxtimes 84. When driven in this manner, the internal 5-k Ω resistor (connecting the P and M pins to the 0.7-V node) is disconnected from the pins.

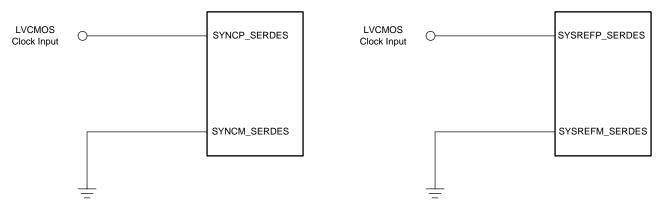


図 84. Single-Ended Driving Circuit for SYNC~ and SYSREF



8.3.11 Clock Input

The input clock to the device (referred to as the system clock) goes to an input buffer that automatically configures itself either to accept a single-ended clock or a differential clock. The equivalent load on the clock pins in the case of a differential clock input is shown in \boxtimes 85. For the case of a single-ended clock input, the 5-k Ω resistor is disconnected from the input.

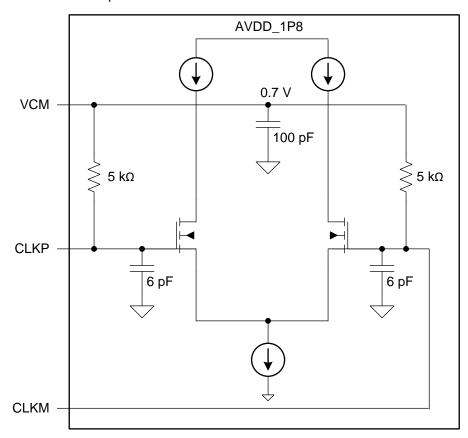


図 85. Internal Clock Buffer for Differential Clock Mode



If the preferred clocking scheme for the device is single-ended, connect the CLKM pin to ground (in other words, short CLKM directly to AVSS, as shown in 🗵 86). In this case, the auto-detect feature shuts down the internal differential clock buffer and the device automatically goes into a single-ended clock input. Connect the single-ended clock source directly (without decoupling) to the CLKP pin. When using a single-ended clock input, TI recommends using low-jitter, square signals (LVCMOS levels, 1.8-V amplitude) to drive the ADC (refer to technical brief, Clocking High-Speed Data Converters, SLYT075 for further details).

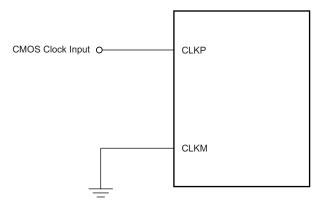


図 86. Single-Ended Clock Driving Circuit

For differential clocks (such as differential sine-wave, LVPECL, LVDS, and so forth), enable the clock amplifier with the connection scheme shown in 287. This same scheme applies when the clock is single-ended but the clock amplitude is either small or its edges are not sharp. In this case, connect the input clock signal with a capacitor to CLKP (as in 287) and connect CLKM to ground through a capacitor (that is, ac-coupled to AVSS).

If a transformer is used with the secondary coil floating (for instance, to convert from single-ended to differential), the outputs of the transformer can be connected directly to the clock inputs without requiring the 10-nF series capacitors.

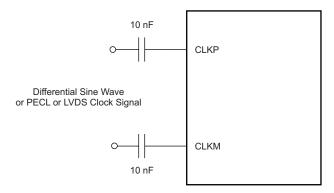


図 87. Differential Clock Driving Circuit

To ensure that the aperture delay and jitter are the same for all channels, the device uses a clock tree network to generate individual sampling clocks for each channel. For all channels, the clock is closley matched from the source point to the sampling circuit of each of the eight internal devices.

The jitter cleaners CDCM7005, CDCE72010, or LMK048X series are suitable to generate the system clock and enable high performance. ☒ 88 shows a clock distribution network.

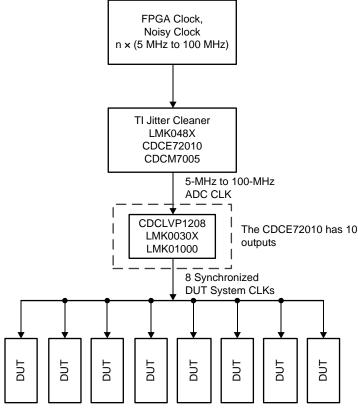
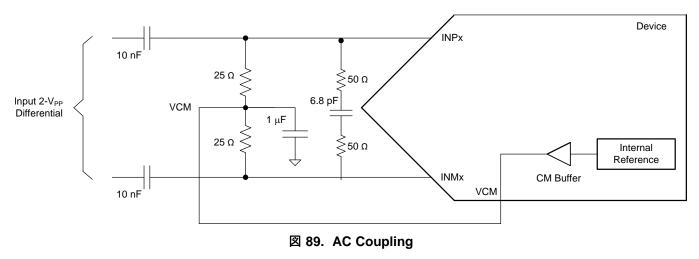


図 88. System Clock Distribution Network

8.3.12 Analog Input and Driving Circuit

8.3.12.1 Signal Input

The analog input to the device can be either ac- or dc-coupled. In ac-coupling, the input common-mode required for device functionality can be forced with the common-mode voltage, generated internally by the device (that comes at the VCM pin) through a resistor, as shown in \boxtimes 89. The resistor and capacitor values used for coupling determines the high-pass filter corner of the input circuit; thus, these values are chosen with the frequency of interest in mind.





When dc-coupling the analog input, the output common-mode voltage of the driver can be set using the VCM output pin as a reference, as shown in \boxtimes 90.

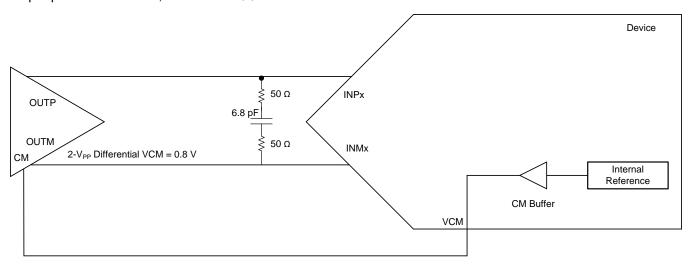


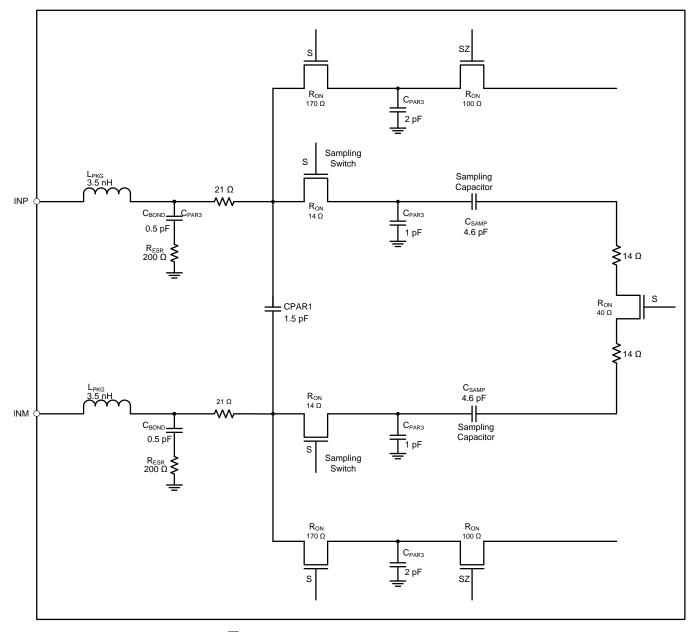
図 90. DC Coupling

Each input interfaces to two sets of identical sampling circuits. The electrical model of the load that each of the sampling networks present is illustrated in 291. For the sake of simplification, the MOS switches can be considered as ideal switches.

As illustrated in \boxtimes 57, \boxtimes 58, and \boxtimes 59, the scheme of connecting each input sampling circuit to the input pins differs across the three input modes. The time-dependent loading of the input pins therefore is different across the three input modes, and can be determined by referring to \boxtimes 57, \boxtimes 58, \boxtimes 59, and \boxtimes 91.



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☑ 91. Analog Input Sampling Network



8.4 Device Functional Modes

8.4.1 Input Modes

The device supports three input modes: a 16-input, a 32-input, and an 8-input mode using the SEL_CH[2:0] register controls. See 表 49 for a listing of register bits that select the 8-, 16-, and 32-input modes. Using the same set of 16 ADCs, the three modes can be used to convert 16, 32, or 8 input channels, respectively. The performance of the ADC itself depends on the conversion clock frequency, which has a different relationship to the system clock and sampling rates in each of the three modes. Although the ADCs are common to all three modes, the manner in which the ADCs are used determines unique performance characteristics in each mode. For example, the 8-input mode can have significant interleaving spurs. Additionally, in the 8-input mode, the conversion phases of two adjacent ADCs are offset by one system clock period. The switching operation in one ADC can affect the performance of the adjacent ADC especially at higher input frequencies. For this reason, only 10-bit ADC resolution is supported in the 8-input mode. The restrictions when operating in the different input modes are listed in 表 30.

表 30. Modes Supported in 8-, 16-, and 32-Input Modes

ANALOG INPUT MODE	ADC RESOLUTIONS SUPPORTED (Bits)	LVDS DATA RATE MODES SUPPORTED
16	10, 12, 14	1X, 2X
32	10, 12, 14	1X
8	10	1X, 2X

8.4.2 ADC Resolution Modes

The ADC resolution can be programmed between 10, 12,and 14 with the ADC_RES register control. The maximum conversion rate of each ADC is determined by the programmed ADC resolution. The restrictions when operating with the different ADC resolutions are listed in 表 31.

表 31. Modes Supported in the 10-, 12-, and 14-Bit ADC Resolution Modes

ADC RESOLUTION (Bits)	ANALOG INPUT MODES SUPPORTED	MAXIMUM CONVERSION CLOCK (f _C , MHz)
10	16, 8, 32	100
12	16, 32	80
14	16, 32	65

8.4.3 LVDS and JESD Interface Modes

By default, the LVDS interface is enabled. To disable the LVDS interface, set DIS LVDS to 1.

To enable the JESD204B interface, set EN_JESD to 1. The JESD204B interface is supported only in 16-input and 32-input modes.

8.4.4 LVDS Serialization and Output Data Rate Modes

The serialization factor of the LVDS interface can be set to 10, 12, 14, or 16 using the SER_DATA_RATE register. Additionally, the density of output data payload can be set to 1X or 2X mode by using the LVDS_RATE_2X register bits. The maximum data rate (in bits per sec) of the LVDS interface is limited. Depending on the input mode, serialization factor, and output data rate mode, the LVDS interface speed restriction may impose additional constraints on the maximum sampling rate achievable.

8.4.5 Power Modes

The ADS52J90 can be configured via SPI or pin settings to a global power-down mode and via pin settings to a fast power-down (standby mode). During these two modes (global and standby power-down), different internal functions stay powered up, resulting in different power consumption and wake-up times.

In standby mode, all LVDS data lanes are powered down. The bit clock and frame clock lanes remain enabled to save time to sync again on the receiver side. However, in global power-down mode all lanes are powered down and thus this mode requires more time to wake-up because the bit clock and frame clock lanes must sync again with the receiver device.



The device consists of the following key blocks:

- · Band-gap circuit,
- · Serial interface.
- Reference voltage and current generator,
- ADC analog block that performs a sampling and conversion,
- ADC digital block that includes all the digital post processing blocks (such as the offset, gain, digital HPF, and so forth),
- · LVDS data serializer and buffer that converts the ADC parallel data to a serial stream,
- · LVDS frame and clock serializer and buffer, and
- PLL (phase-locked loop) that generates a high-frequency clock for both the ADC and serializer.

Of all these blocks, only the band-gap and serial interface block are not powered down using the power-down pins or bits. 表 32 lists which blocks in the ADC are powered down using different pins and bits.

表 32. Power-Down Modes Description for the ADC

NAME	TYPE (Pin or Register)	ADC ANALOG	ADC DIGITAL	LVDS DATA SERIALIZER, BUFFER	LVDS FRAME AND CLOCK SERIALIZER, BUFFER	REFERENCE + ADC CLOCK BUFFER	PLL	CHANNEL
PDN_GBL	Pin	Yes ⁽¹⁾	Yes	Yes	Yes	Yes	Yes	AII ⁽²⁾
GLOBAL_PDN	Register	Yes	Yes	Yes	Yes	Yes	Yes	All
PDN_FAST	Pin	Yes	Yes	Yes	No	No	No	All
DIS_LVDS	Register	No	No	Yes	Yes	No	No	All
PDN_ANA_ADCx	Register	Yes	No	No	No	No	No	Individual
PDN_DIG_ADCx	Register	No	Yes	No	No	No	No	Individual
PDN_LVDSx	Register	No	No	Yes	No	No	No	Individual

⁽¹⁾ Yes = powered down. No = active.

⁽²⁾ All = all channels are powered down. Individual = only a single channel is powered down, depending upon the corresponding bit.



8.4.6 LVDS Test Pattern Mode

The ADC data coming out of the LVDS outputs can be replaced by different kinds of test patterns. Note that the test patterns replace the data streaming out of the ADCs (more specifically, the DIGRES1 signal). Therefore, in 16-, 8-, and 32-channel input modes, the pattern that occurs on a per-channel basis can be different for some test patterns. The different test patterns are described in 表 33.

表 33. Description of LVDS Test Patterns

	PROGRAMMI	PROGRAMMING THE MODE						
TEST PATTERN MODE	THE SAME PATTERN MUST BE COMMON TO ALL DATA LINES	THE PATTERN IS SELECTIVELY REQUIRED ON ONE OR MORE DATA LINE	TEST PATTERNS REPLACE ⁽¹⁾					
All 0s	Set the mode using PAT_MODES[2:0]	Set PAT_SELECT_IND = 1. To output the pattern on the DOUTx line, select PAT_LVDSx[2:0]	Zeros in all bits (00000000000000) of DIGRESx					
All 1s	Set the mode using PAT_MODES[2:0]	Set PAT_SELECT_IND = 1. To output the pattern on the DOUTx line, select PAT_LVDSx[2:0]	Ones in all bits (11111111111111) of DIGRESx					
Deskew	Set the mode using PAT_MODES[2:0]	Set PAT_SELECT_IND = 1. To output the pattern on the DOUTx line, select PAT_LVDSx[2:0]	DIGRESx word is replaced by alternate 0s and 1s (01010101010101)					
Sync	Set the mode using PAT_MODES[2:0]	Set PAT_SELECT_IND = 1. To output the pattern on the DOUTx line, select PAT_LVDSx[2:0]	DIGRESx word is replaced by half 1s and half 0s (11111110000000)					
Custom	Set the mode using PAT_MODES[2:0]. Set the desired custom pattern using the CUSTOM_PATTERN register control.	Set PAT_SELECT_IND = 1. To output the pattern on the DOUTx line, select PAT_LVDSx[2:0]	The word written in the CUSTOM_PATTERN control (taken from the MSB side) replaces DIGRESx. (For instance, CUSTOM_PATTERN = 11001011010111100 and DIGRESx = 110010110101111 when the serialization factor is 14.)					
Ramp	Set the mode using PAT_MODES[2:0]	Set PAT_SELECT_IND = 1. To output the pattern on the DOUTx line, select PAT_LVDSx[2:0]	The ADCOUTx word (not the DIGRESx word) is replaced by a word that increments by 1 LSB every conversion clock starting at negative full-scale, increments until positive full-scale, and wraps back to negative full-scale.					
Toggle	Set the mode using PAT_MODES[2:0]	Set PAT_SELECT_IND = 1. To output the pattern on the DOUTx line, select PAT_LVDSx[2:0]	The DIGRESx word alternates between two words that are all 1s and all 0s. At each setting of the toggle pattern, the start word can either be all 0s or all 1s. (Alternate between 111111111111111 and 00000000000000000000000000000000000					
PRBS	Set SEL_PRBS_PAT_GBL = 1. Select either custom or ramp pattern with PAT_MODES[2:0]. Enable PRBS mode using PRBS_EN. Select the desired PRBS mode using PRBS_MODE. Reset the PRBS generator with PRBS_SYNC.	Set PAT_SELECT_IND = 1. Select either custom or ramp pattern with PAT_LVDSx[2:0]. Enable PRBS mode on DOUTx with the PAT_PRBS_LVDSx control. Select the desired PRBS mode using PRBS_MODE. Reset the PRBS generator with PRBS_SYNC.	A 16-bit pattern is generated by a 23-bit (or 9-bit) PRBS pattern generator (taken from the MSB side) and replaces the DIGRESx word.					

⁽¹⁾ Shown for a serialization factor of 14.

All patterns listed in 表 33 (except the PRBS pattern) can also be forced on the frame clock output line by using PAT_MODES_FCLK[2:0]. To force a PRBS pattern on the frame clock, use the SEL_PRBS_PAT_FCLK, PRBS_EN, and PAT_MODES_FCLK register controls.



The ramp, toggle, and pseudo-random sequence (PRBS) test patterns can be reset or synchronized by providing a synchronization pulse on the TX_TRIG pin or by setting and resetting a specific register bit.

These test patterns also function as transport layer test patterns for the JESD204B interface.

8.5 Programming

8.5.1 Serial Peripheral Interface (SPI) Operation

This section discusses the read and write operations of the SPI interface.

8.5.1.1 Serial Register Write Description

Several different modes can be programmed with the serial peripheral interface (SPI). This interface is formed by the SEN (serial interface enable), SCLK (serial interface clock), SDIN (serial interface data), and RESET pins. The SCLK, SDIN, and RESET pins have a $20\text{-k}\Omega$ pulldown resistor to ground. SEN has a $20\text{-k}\Omega$ pullup resistor to supply. Serially shifting bits into the device is enabled when SEN is low. SDIN serial data are latched at every SCLK rising edge when SEN is active (low). SDIN serial data are loaded into the register at every 24th SCLK rising edge when SEN is low. If the word length exceeds a multiple of 24 bits, the excess bits are ignored. Data can be loaded in multiples of 24-bit words within a single active SEN pulse (an internal counter counts the number of 24 clock groups after the SEN falling edge). Data is divided into two main portions: the register address (8 bits) and data (16 bits). 29 shows the timing diagram for serial interface write operation.

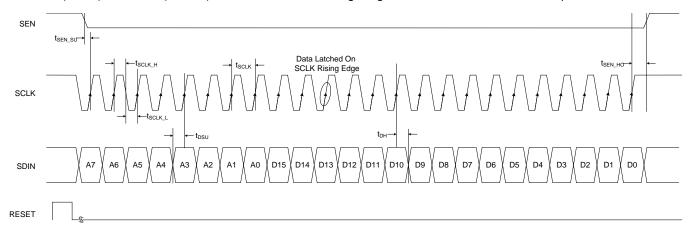


図 92. Serial Interface Timing



Programming (continued)

8.5.1.2 Register Readout

The device includes an option where the contents of the internal registers can be read back. This readback can be useful as a diagnostic test to verify the serial interface communication between the external controller and AFE. First, the REG_READ_EN bit must be set to 1. Then, initiate a serial interface cycle specifying the address of the register (A[7:0]) whose content must be read. The data bits are *don't care*. The device outputs the contents (D[15:0]) of the selected register on the SDOUT pin. For lower-speed SCLKs, SDOUT can be latched on the SCLK rising edge. For higher-speed SCLKs, latching SDOUT at the next SCLK falling edge is preferable. The read operation timing diagram is shown in 293. In readout mode, the REG_READ_EN bit can be accessed with SDIN, SCLK, and SEN. To enable serial register writes, set the REG_READ_EN bit back to 0.

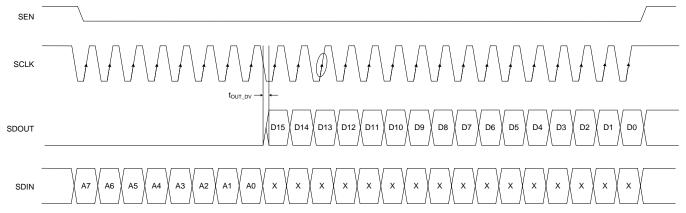


図 93. Serial Interface Register, Read Operation

The device SDOUT buffer is 3-stated and is only enabled when the REG_READ_EN bit is enabled. SDOUT pins from multiple devices can therefore be tied together without any pullup resistors. The SN74AUP1T04 level shifter can be used to convert 1.8-V logic to 2.5-V or 3.3-V logic, if necessary.

9 Application and Implementation

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Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

The ADS52J90 supports multiple levels of channel integration (8, 16, and 32) with high sampling rates achievable for each channel. The ADS52J90 also has options to synchronize the clocking and LVDS interface of multiple devices. These features, combined with the excellent ADC performance and low power, make the ADS52J90 an excellent choice for applications involving high channel counts. Such applications include ultrasound imaging systems, sonar imaging equipment, and radar.



9.2 Typical Application

An illustration of a system with a channel count of 64 is shown in 294. In 294, the output interface is selected as the LVDS interface. Four ADS52J90 devices, each operating in 16-input mode, are connected to a single FPGA that aggregates the data from all ADCs for further data processing and storage.

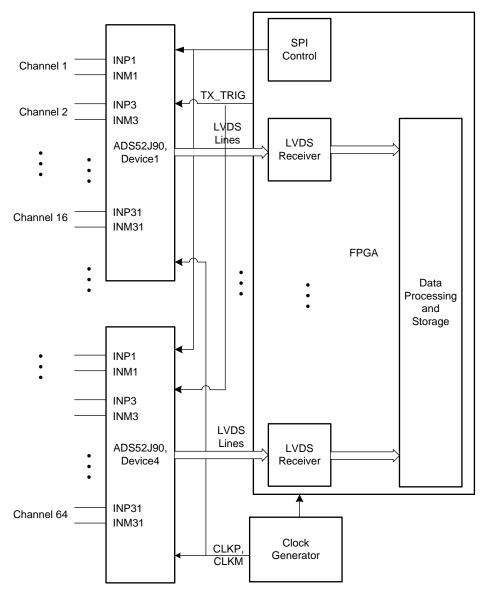


図 94. Application Schematic: 64-Channel Medical Ultrasound Receiver Using the ADS52J90



Typical Application (continued)

9.2.1 Design Requirements

Typical requirements of a medical ultrasound receiver system are listed in 表 34.

表 34. Requirements of a Typical Medical Ultrasound Receiver

DESIGN PARAMETER	EXAMPLE VALUES
Signal center frequency	5 MHz-15 MHz
Signal bandwidth	2 MHz
Maximum input signal amplitude	100 mV _{PP}
Transducer noise level	1 nV/√Hz
Total harmonic distortion	40 dBc

The ultrasound system typically has an LNA and a time-dependent gain block at the front-end before the ADC. In an ultrasound receiver, the signal level keeps reducing as a function of time and the role of the front-end blocks is to gain up the signal level without adding too much additional noise. The gain of the front-end can be adjusted so that the input signal to the ADC always remains within its full-scale range.

A sampling rate of approximately 40 MHz to 50 MHz is usually sufficient for such an application. Thus the ADS52J90 can be operated in 16-input mode. Furthermore, the resolution can be set to 14 bits to maximize the SNR of the device. A higher sampling rate ADC results in a lower noise density in the signal band of interest. For example, an ADC with a 2-V_{PP} input operating at 50 MSPS with an SNR of 73 dBFS has a noise level of approximately 35 nV/ $\sqrt{\text{Hz}}$ referred to the input of the ADC. If the front-end has a gain of 40 dB, the ADC noise referred to the input of the front-end is then 0.35 nV/ $\sqrt{\text{Hz}}$, which in this case is lower than the transducer noise level.

9.2.2 Detailed Design Procedure

The design considerations when designing with the 16-, 32-, and 8-input modes are described in the following sections.



9.2.2.1 Designing with the 16-Input Mode

Mapping of the analog inputs to the LVDS outputs is shown in 表 35 for a case corresponding to a 16-input mode and a 1X data rate.

表 35. Mapping of Analog Inputs to LVDS Outputs (16-Input Mode, 1X Data Rate)

ANALOG INPUT SIGNAL	CONNECTION TO ANALOG INPUT PINS	SAMPLING INSTANT	ADC WORD	SERIAL_OUT (Over Two Frames)	LVDS OUTPUTS ON DOUT PINS
A INI4	INIA	t ₁	ADCOUT10	Frame 1: ADCOUT1o	DOUT4
AIN1	IN1	t ₂	ADCOUT1e	Frame 2: ADCOUT1e	DOUT1
AIN2	IN3	t ₁	ADCOUT20	Frame 1: ADCOUT2o	DOUT2
AINZ	INS	t ₂	ADCOUT2e	Frame 2: ADCOUT2e	DO012
AIN3	IN5	t ₁	ADCOUT30	Frame 1: ADCOUT3o	DOUT3
Alivo	INS	t ₂	ADCOUT3e	Frame 2: ADCOUT3e	00013
AIN4	IN7	t ₁	ADCOUT40	Frame 1: ADCOUT4o	DOUT4
AIIN4	IIN7	t ₂	ADCOUT4e	Frame 2: ADCOUT4e	DO014
AIN5	IN9	t ₁	ADCOUT50	Frame 1: ADCOUT50	DOUT5
CILIN	ins	t ₂	ADCOUT5e	Frame 2: ADCOUT5e	DO015
AIN6	IN11	t ₁	ADCOUT60	Frame 1: ADCOUT6o	DOUT6
Alivo	IINTT	t ₂	ADCOUT6e	Frame 2: ADCOUT6e	DO016
AIN7	IN13	t ₁	ADCOUT70	Frame 1: ADCOUT70 Frame 2: ADCOUT7e	DOUT7
AINI	IIVIO	t ₂	ADCOUT7e		DOOT
AIN8	INI4E	t ₁	ADCOUT80	Frame 1: ADCOUT8o Frame 2: ADCOUT8e	DOUTS
Alino	IN15	t ₂	ADCOUT8e		DOUT8
AIN9	IN17	t ₁	ADCOUT90	Frame 1: ADCOUT9o	DOUT9
Allva	IIN I 7	t ₂	ADCOUT9e	Frame 2: ADCOUT9e	D0019
AIN10	IN19	t ₁	ADCOUT10o	Frame 1: ADCOUT10o	DOUT10
AllVIO	11413	t ₂	ADCOUT10e	Frame 2: ADCOUT10e	D00110
AIN11	IN21	t ₁	ADCOUT110	Frame 1: ADCOUT110	DOUT11
AllVII	111/2 1	t ₂	ADCOUT11e	Frame 2: ADCOUT11e	DOOTTI
AIN12	IN23	t ₁	ADCOUT120	Frame 1: ADCOUT120	DOUT12
AINIZ	11425	t ₂	ADCOUT12e	Frame 2: ADCOUT12e	DO0112
AIN13	IN25	t ₁	ADCOUT130	Frame 1: ADCOUT130	DOUT13
Alivio	IIVZS	t ₂	ADCOUT13e	Frame 2: ADCOUT13e	D00113
AIN14	IN27	t ₁	ADCOUT140	Frame 1: ADCOUT14o	DOUT14
Allilit	IINZ I	t ₂	ADCOUT14e	Frame 2: ADCOUT14e	500114
AIN15	IN29	t ₁	ADCOUT150	Frame 1: ADCOUT150	DOUT15
MINIO	11423	t ₂	ADCOUT15e	Frame 2: ADCOUT15e	500110
AIN16	IN31	t ₁	ADCOUT160	Frame 1: ADCOUT160	DOUT16
AINTO	IIVOI	t ₂	ADCOUT16e	Frame 2: ADCOUT16e	DOOTTO



Mapping of the analog inputs to the LVDS outputs is shown in 表 36 for a case corresponding to a 16-input mode and a 2X data rate.

表 36. Mapping of Analog Inputs to LVDS Outputs (16-Input Mode, 2X Data Rate)

ANALOG INPUT SIGNAL	CONNECTION TO ANALOG INPUT PINS	SAMPLING INSTANT	ADC WORD	SERIAL_OUT (Over Two Frames)	LVDS OUTPUTS ON DOUT PINS
AIN1	IN1	t ₁	ADCOUT10	Frame 1: ADCOUT1o,	
AINT	IINI	t ₂	ADCOUT1e	ADCOUT20	DOUT1
AIN2	IN3	t ₁	ADCOUT20	Frame 2: ADCOUT1e, ADCOUT2e	DOOTT
AINZ	IINO	t ₂	ADCOUT2e	ADCOUTZe	
AIN3	IN5	t ₁	ADCOUT30	Frame 1: ADCOUT3o,	
Ains	INS	t ₂	ADCOUT3e	ADCOUT40	DOUT2
AIN4	IN7	t ₁	ADCOUT40	Frame 2: ADCOUT3e, ADCOUT4e	D0012
AIN4	IIN7	t ₂	ADCOUT4e	ADCOUT46	
AIN5	IN9	t ₁	ADCOUT50	Frame 1: ADCOUT50,	
CINA	1119	t ₂	ADCOUT5e	ADCOUT60	DOUT3
AIN6	IN11	t ₁	ADCOUT60	Frame 2: ADCOUT5e, ADCOUT6e	00013
AINO	IINTT	t ₂	ADCOUT6e	ADCOUT66	
AIN7	IN13	t ₁	ADCOUT70	Frame 1: ADCOUT7o,	DOUT4
AIN	IIVIS	t ₂	ADCOUT7e	ADCOUT80 Frame 2: ADCOUT7e, ADCOUT8e	
AIN8	IN15	t ₁	ADCOUT80		
Alivo	CINII	t ₂	ADCOUT8e	ADCOUTSE	
AIN9	IN17	t ₁	ADCOUT90	Frame 1: ADCOUT9o,	DOUT9
Ains	IIN 17	t ₂	ADCOUT9e	ADCOUT100	
AIN10	IN19	t ₁	ADCOUT10o	Frame 2: ADCOUT9e, ADCOUT10e	
AINTO	11119	t ₂	ADCOUT10e	ADCOUTTOE	
AIN11	IN21	t ₁	ADCOUT110	Frame 1: ADCOUT11o,	
AINTI	IINZ I	t ₂	ADCOUT11e	ADCOUT110,	DOUT10
AIN12	IN23	t ₁	ADCOUT120	Frame 2: ADCOUT11e, ADCOUT12e	DO0110
AINTZ	IIVZS	t ₂	ADCOUT12e	ADCOUTTZe	
AIN13	IN25	t ₁	ADCOUT130	Frame 1: ADCOUT13o,	
AINTS	IIVZS	t ₂	ADCOUT13e	ADCOUT14	DOUT11
AIN14	IN27	t ₁	ADCOUT14o	Frame 2: ADCOUT13e,	DOOTTI
AIN 14	IINZ/	t ₂	ADCOUT14e	ADCOUT14e	
AIN15	IN29	t ₁	ADCOUT150	Frame 1: ADCOLIT150	
AINIO	IINZIJ	t ₂	ADCOUT15e	Frame 1: ADCOUT150, ADCOUT160	DOUT12
AIN16	IN31	t ₁	ADCOUT160	Frame 2: ADCOUT15e, ADCOUT16e	DO0112
AINTO	IIII	t ₂	ADCOUT16e	ADCOULINE	

表 35 and 表 36 illustrate that the ADCs convert the odd numbered input when operating in the 16-input mode. Each ADC can be set to convert the following even numbered input using the register control IN_CH_ADCx. The performance of the ADC may slightly degrade when IN_CH_ADCx is set to 1.



In 16-input mode, there is a one-to-one mapping between the inputs and the ADCs. The register map relative to the ADCs can therefore be mapped to the 16 channels, as shown in 表 37.

表 37. Reinterpretation of the Register Map in 16-Input Mode

REGISTER MAP NOTATION	MAPPING TO CHANNELS IN 16-INPUT MODE	EXAMPLE
GAIN_ADCxo, GAIN_ADCxe	GAIN_CHANNELx	GAIN_CHANNEL1 = GAIN_ADC1o (same for GAIN_ADC1e) (Set odd and even gains of the same ADC to the same setting)
OFFSET_ADCxo, OFFSET_ADCxe	OFFSET_CHANNELx	OFFSET_CHANNEL1 = OFFSET_ADC1o (same for OFFSET_ADC1e (Set odd and even offsets of the same ADC to the same setting)
PDN_DIG_ADCx	PDN_DIG_CHANNELx	PDN_DIG_CHANNEL1 = PDN_DIG_ADC1
PDN_ANA_ADCx	PDN_ANA_CHANNELx	PDN_ANA_CHANNEL1 = PDN_ANA_ADC1
DIG_HPF_EN_ADCx	Mapped to 4 channels	DIG_HPF_EN_CHANNEL1-4 = DIG_HPF_EN_ADC1-4 Common setting for 4 ADCs maps to common setting for 4 channels
HPF_CORNER_ADCx	Mapped to 4 channels	HPF_CORNER_CHANNEL1-4 = HPF_CORNER_ADC1-4 Common setting for 4 ADCs maps to common setting for 4 channels

9.2.2.2 Designing with the 32-Input Mode

Mapping of the analog inputs to the LVDS outputs is shown in 表 38 for a case corresponding to a 32-input mode and a 1X data rate.

表 38. Mapping of Analog Inputs to LVDS Outputs (32-Input Mode, 1X Data Rate)

	•	• .	•	•	•
ANALOG INPUT SIGNAL	CONNECTION TO ANALOG INPUT PINS	SAMPLING INSTANT	ADC WORD	SERIAL_OUT (Over One Frame)	LVDS OUTPUTS ON DOUT PINS
AIN1	IN1	t ₁	ADCOUT10	ADCOUT10,	DOUT1
AIN2	IN2	t ₂	ADCOUT1e	ADCOUT1e	DOUTT
AIN3	IN3	t ₁	ADCOUT20	ADCOUT20,	DOUT2
AIN4	IN4	t ₂	ADCOUT2e	ADCOUT2e	DO012
AIN5	IN5	t ₁	ADCOUT30	ADCOUT30,	DOUT3
AIN6	IN6	t ₂	ADCOUT3e	ADCOUT3e	DO013
AIN7	IN7	t ₁	ADCOUT40	ADCOUT4o,	DOUT4
AIN8	IN8	t ₂	ADCOUT4e	ADCOUT4e	DO014
AIN9	IN9	t ₁	ADCOUT50	ADCOUT50,	DOUTE
AIN10	IN10	t ₂	ADCOUT5e	ADCOUT5e	DOUT5
AIN11	IN11	t ₁	ADCOUT60	ADCOUT60,	DOUT6
AIN12	IN12	t ₂	ADCOUT6e	ADCOUT6e	DO016
AIN13	IN13	t ₁	ADCOUT70	ADCOUT7o,	DOUT7
AIN14	IN14	t ₂	ADCOUT7e	ADCOUT7e	DO017
AIN15	IN15	t ₁	ADCOUT80	ADCOUT80,	DOUT8
AIN16	IN16	t ₂	ADCOUT8e	ADCOUT8e	DO016
AIN17	IN17	t ₁	ADCOUT90	ADCOUT9o,	DOUT9
AIN18	IN18	t ₂	ADCOUT9e	ADCOUT9e	00019
AIN19	IN19	t ₁	ADCOUT10o	ADCOUT10o,	DOUT10
AIN20	IN20	t ₂	ADCOUT10e	ADCOUT10e	DOUTIO
AIN21	IN21	t ₁	ADCOUT110	ADCOUT110,	DOLIT44
AIN22	IN22	t ₂	ADCOUT11e	ADCOUT11e	DOUT11
AIN23	IN23	t ₁	ADCOUT120	ADCOUT120,	DOUT12
AIN24	IN24	t ₂	ADCOUT12e	ADCOUT12e	טטטווצ
AIN25	IN25	t ₁	ADCOUT130	ADCOUT130,	DOUT13
AIN26	IN26	t ₂	ADCOUT13e	ADCOUT13e	סטווט



表 38. Mapping of Analog Inputs to LVDS Outputs (32-Input Mode, 1X Data Rate) (continued)

ANALOG INPUT SIGNAL	CONNECTION TO ANALOG INPUT PINS	SAMPLING INSTANT	ADC WORD	SERIAL_OUT (Over One Frame)	LVDS OUTPUTS ON DOUT PINS
AIN27	IN27	t ₁	ADCOUT140	ADCOUT14o,	DOUT14
AIN28	IN28	t ₂	ADCOUT14e	ADCOUT14e	DO0114
AIN29	IN29	t ₁	ADCOUT150	ADCOUT15o,	DOUT15
AIN30	IN30	t ₂	ADCOUT15e	ADCOUT15e	DO0115
AIN31	IN31	t ₁	ADCOUT160	ADCOUT16o,	DOLIT46
AIN32	IN32	t ₂	ADCOUT16e	ADCOUT16e	DOUT16

Note that 2X data rate mode is not supported in 32-input mode. In 32-input mode, only one ADC is used to convert two inputs.

The odd numbered inputs correspond to the odd sample from the ADC, and the even numbered inputs correspond to the even sample from the ADC. The register map relative to the ADCs can therefore be mapped to the 32 channels, as shown in 表 39.

表 39. Reinterpretation of Register Map in 32-Input Mode

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REGISTER MAP NOTATION	MAPPING TO CHANNELS IN 16-INPUT MODE	EXAMPLE					
GAIN_ADCxo	GAIN_CHANNEL (odd)	GAIN_CHANNEL1 = GAIN_ADC10					
GAIN_ADCxe	GAIN_CHANNEL (even)	GAIN_CHANNEL2 = GAIN_ADC1e					
OFFSET_ADCXo	OFFSET_CHANNEL (odd)	OFFSET_CHANNEL1 = OFFSET_ADC10					
OFFSET_ADCxe	OFFSET_CHANNEL (even)	OFFSET_CHANNEL2 = OFFSET_ADC1e					
PDN_DIG_ADCx	PDN_DIG_CHANNEL (odd and even)	PDN_DIG_CHANNEL1 = PDN_DIG_CHANNEL2 = PDN_DIG_ADC1					
PDN_ANA_ADCx	PDN_ANA_CHANNEL (odd and even)	PDN_ANA_CHANNEL1 = PDN_ANA_CHANNEL2 = PDN_ANA_ADC1					
DIG_HPF_EN_ADCx	Mapped to 8 channels	DIG_HPF_EN_CHANNEL1-8 = DIG_HPF_EN_ADC1-4 Common setting for 4 ADCs mapped to common setting for 8 channels					
HPF_CORNER_ADCx	Mapped to 8 channels	HPF_CORNER_CHANNEL1-8 = HPF_CORNER_ADC1-4 Common setting for 4 ADCs mapped to common setting for 8 channels					



9.2.2.3 Designing with the 8-Input Mode

Mapping of the analog inputs to the LVDS outputs is shown in 表 40 for a case corresponding to an 8-input mode and a 1X data rate.

表 40. Mapping of Analog Inputs to LVDS Outputs (8-Input Mode, 1X Data Rate)

ANALOG INPUT SIGNAL	CONNECTION TO ANALOG INPUT PINS	SAMPLING INSTANT	ADC WORD	SERIAL_OUT (Over Two Frames)	LVDS OUTPUTS ON DOUT PINS
		t ₁	ADCOUT10	Frame 1: ADCOUT10	DOLIT4
A I N I 4	IN1, IN3	t ₂	ADCOUT20	Frame 2: ADCOUT1e	DOUT1
AIN1	(shorted externally)	t ₃	ADCOUT1e	Frame 1: ADCOUT20	DOLITO
		t ₄	ADCOUT2e	Frame 2: ADCOUT2e	DOUT2
		t ₁	ADCOUT30	Frame 1: ADCOUT3o	DOLITO
AINO	IN5, IN7	t ₂	ADCOUT40	Frame 2: ADCOUT3e	DOUT3
AIN2	(shorted externally)	t ₃	ADCOUT3e	Frame 1: ADCOUT4o	DOLIT4
		t ₄	ADCOUT4e	Frame 2: ADCOUT4e	DOUT4
	AIN3 IN9, IN11 (shorted externally)	t ₁	ADCOUT50	Frame 1: ADCOUT50	DOLITE
AINIO		t ₂	ADCOUT60	Frame 2: ADCOUT5e	DOUT5
AIN3		t ₃	ADCOUT5e	Frame 1: ADCOUT60	DOLLTO
		t ₄	ADCOUT6e	Frame 2: ADCOUT6e	DOUT6
		t ₁	ADCOUT70	Frame 1: ADCOUT7o Frame 2: ADCOUT7e	DOUT7
AIN4	IN13, IN15	t ₂	ADCOUT80		
AIIN4	(shorted externally)	t ₃	ADCOUT7e	Frame 1: ADCOUT80 Frame 2: ADCOUT8e	DOUT8
		t ₄	ADCOUT8e		
		t ₁	ADCOUT90	Frame 1: ADCOUT90 Frame 2: ADCOUT9e	DOUT9
AIN5	IN17, IN19	t ₂	ADCOUT100		DO019
CILIA	(shorted externally)	t ₃	ADCOUT9e	Frame 1: ADCOUT10o	DOUT10
		t ₄	ADCOUT10e	Frame 2: ADCOUT10e	DOOTTO
		t ₁	ADCOUT110	Frame 1: ADCOUT110	DOLITA:
AIN6	IN21, IN23	t ₂	ADCOUT120	Frame 2: ADCOUT11e	DOUT11
Alivo	(shorted externally)	t ₃	ADCOUT11e	Frame 1: ADCOUT12o	DOUT12
		t ₄	ADCOUT12e	Frame 2: ADCOUT12e	D00112
		t ₁	ADCOUT130	Frame 1: ADCOUT13o	DOUT42
AIN7	IN25, IN27	t ₂	ADCOUT14o	Frame 2: ADCOUT13e	DOUT13
Alini	(shorted externally)	t ₃	ADCOUT13e	Frame 1: ADCOUT14o	DOUT14
		t ₄	ADCOUT14e	Frame 2: ADCOUT14e	DO0114
		t ₁	ADCOUT150	Frame 1: ADCOUT150	DOUT15
AIN8	IN29, IN31	t ₂	ADCOUT160	Frame 2: ADCOUT15e	DO0113
Alivo	(shorted externally)	t ₃	ADCOUT15e	Frame 1: ADCOUT160	DOLUT16
		t ₄	ADCOUT16e	Frame 2: ADCOUT16e	DOUT16



Mapping of the analog inputs to the LVDS outputs is shown in 表 41 for a case corresponding to an 8-input mode and a 2X data rate.

表 41. Mapping of Analog Inputs to LVDS Outputs (8-Input Mode, 2X Data Rate)

ANALOG INPUT SIGNAL	CONNECTION TO ANALOG INPUT PINS	SAMPLING INSTANT	ADC WORD	SERIAL_OUT (Over Two Frames)	LVDS OUTPUTS ON DOUT PINS
		t ₁	ADCOUT10	Frame 1: ADCOUT1o,	
AIN1	IN1, IN3	t ₂	ADCOUT20	ADCOUT20	DOUT1
AINT	(shorted externally)	t ₃	ADCOUT1e	Frame 2: ADCOUT1e,	DOUTT
		t ₄	ADCOUT2e	ADCOUT2e	
		t ₁	ADCOUT30	Frame 1: ADCOUT3o,	
AIN2	IN5, IN7	t ₂	ADCOUT40	ADCOUT40	DOUT2
Alinz	(shorted externally)	t ₃	ADCOUT3e	Frame 2: ADCOUT3e,	00012
		t ₄	ADCOUT4e	ADCOUT4e	
		t ₁	ADCOUT50	Frame 1: ADCOUT5o,	
AIN3	IN9, IN11	t ₂	ADCOUT60	ADCOUT60	DOUT3
Alino	(shorted externally)	t ₃	ADCOUT5e	Frame 2: ADCOUT5e,	00013
		t ₄	ADCOUT6e	ADCOUT6e	
		t ₁	ADCOUT70	Frame 1: ADCOUT7o,	
AIN4	IN13, IN15	t ₂	ADCOUT80	ADCOUT80	DOUT4
Aliv4	(shorted externally)	t ₃	ADCOUT7e	Frame 2: ADCOUT7e,	DO014
		t ₄	ADCOUT8e	ADCOUT8e	
		t ₁	ADCOUT90	Frame 1: ADCOUT9o,	
AIN5	IN17, IN19	t ₂	ADCOUT10o	ADCOUT10o	DOUT9
Ains	(shorted externally)	t ₃	ADCOUT9e	Frame 2: ADCOUT9e,	00019
		t ₄	ADCOUT10e	ADCOUT10e	
		t ₁	ADCOUT110	Frame 1: ADCOUT11o,	
AIN6	IN21, IN23	t ₂	ADCOUT120	ADCOUT120	DOUT10
AINO	(shorted externally)	t ₃	ADCOUT11e	Frame 2: ADCOUT11e,	D00110
		t ₄	ADCOUT12e	ADCOUT12e	
		t ₁	ADCOUT130	Frame 1: ADCOUT13o,	
AIN7	IN25, IN27	t ₂	ADCOUT14o	ADCOUT14	DOUT11
Ally	(shorted externally)	t ₃	ADCOUT13e	Frame 2: ADCOUT13e,	DOOTTI
		t ₄	ADCOUT14e	ADCOUT14e	
		t ₁	ADCOUT150	Frame 1: ADCOUT15o,	
AIN8	IN29, IN31	t ₂	ADCOUT160	ADCOUT160	DOUT12
AIINO	(shorted externally)	t ₃	ADCOUT15e	Frame 2: ADCOUT15e,	DO0112
		t ₄	ADCOUT16e	ADCOUT16e	



In 8-input mode, two neighboring ADCs are used to convert a single input. The register map relative to the ADCs can be mapped to the eight channels, as shown in 表 42.

表 42. Reinterpretation of Register Map in 8-input Mode

REGISTER MAP NOTATION	MAPPING TO CHANNELS IN 16-INPUT MODE	EXAMPLE
GAIN_ADCxo, GAIN_ADCxe of two adjacent channels	GAIN_CHANNELx	GAIN_CHANNEL1 = GAIN_ADC1o (same for GAIN_ADC1e, GAIN_ADC2o, and GAIN_ADC2e) Set odd and even gains of two adjacent ADCs to the same setting.
OFFSET_ADCxo, OFFSET_ADCxe	OFFSET_CHANNELx	OFFSET_CHANNEL1 = OFFSET_ADC1o (same for OFFSET_ADC1e, OFFSET_ADC2o, and OFFSET_ADC2e) Set odd and even offsets of two adjacent ADCs to the same setting.
PDN_DIG_ADCx of two adjacent channels	PDN_DIG_CHANNELx	PDN_DIG_CHANNEL1 = PDN_DIG_ADC1 (same for PDN_DIG_ADC2) Set the power-down for two adjacent ADCs to the same setting.
PDN_ANA_ADCx of two adjacent channels	PDN_ANA_CHANNELx	PDN_ANA_CHANNEL1 = PDN_ANA_ADC1 (same for PDN_ANA_ADC2) Set the power-down for two adjacent ADCs to the same setting.
DIG_HPF_EN_ADCx	Mapped to 2 channels	DIG_HPF_EN_CHANNEL1-2 = DIG_HPF_EN_ADC1-4 Common setting for 4 ADCs mapped to the common setting for 2 channels.
HPF_CORNER_ADCx	Mapped to 2 channels	HPF_CORNER_CHANNEL1-2 = HPF_CORNER_ADC1-4 Common setting for 4 ADCs mapped to the common setting for 2 channels.

9.2.3 Application Curves

This section outlines the trends described in the *Typical Characteristics* section from an application perspective.

- ☑ 2 illustrates the FFT with a 5-MHz input signal for 32-input mode with the ADC resolution set to 10 bits. The system clock provided is 100 MSPS and the input is sampled at an effective rate of 50 MSPS, which is the maximum sampling rate for this mode of operation.
- ☑ 3 illustrates the FFT with a 5-MHz input signal for 16-input mode with the ADC resolution set to 10 bits. The system clock provided is 100 MSPS and the input is sampled at an effective rate of 100 MSPS, which is the maximum sampling rate for this mode of operation.
- \boxtimes 4 illustrates the FFT with a 5-MHz input signal for 8-input mode with the ADC resolution set to 10 bits. The system clock provided is 200 MSPS and the input is sampled at an effective rate of 200 MSPS, which is the maximum sampling rate for this mode of operation. The increase in sampling rate is achieved through two ADCs converting the same input in an interleaved manner. The interleaving spurs are visible in the FFT. The predominant spur is at the frequencies of (f_S / 2 \pm f_{IN}), which appear at 95 MHz. Additional spurs are at the frequencies of (f_S / 4 \pm f_{IN}), which appear at 45 MHz and 55 MHz. The magnitude of the spurs is expected to rise when the input frequency is increased. Also, the spur level is sensitive to the matching of the manner in which the two sets of input pins are driven. A spur at $f_S/4$ is also seen. This arises from the offset mismatch between the four sets of sampling circuits used to sample the same input.
- ☑ 5 illustrates the FFT with a 5-MHz input signal for 32-input mode with the ADC resolution set to 12 bits. The system clock provided is 80 MSPS and the input is sampled at an effective rate of 40 MSPS, which is the maximum sampling rate for this mode of operation.
- 🗵 6 illustrates the FFT with a 5-MHz input signal for 16-input mode with the ADC resolution set to 12 bits. The system clock provided is 80 MSPS and the input is sampled at an effective rate of 80 MSPS, which is the maximum sampling rate for this mode of operation.
- ☑ 7 illustrates the FFT with a 5-MHz input signal for 32-input mode with the ADC resolution set to 14 bits. The system clock provided is 65 MSPS and the input is sampled at an effective rate of 32.5 MSPS, which is the maximum sampling rate for this mode of operation.
- \boxtimes 8 illustrates the FFT with a 5-MHz input signal for 16-input mode with the ADC resolution set to 14 bits. The system clock provided is 65 MSPS and the input is sampled at an effective rate of 65 MSPS, which is the maximum sampling rate for this mode of operation. In addition to the harmonics, the spur at the frequency (f_S / 2 \pm f_{IN}) also occurs at 27.5 MHz. This spur is caused by the interleaved sampling of the input signal by two physically different sampling circuits of the same ADC.



- 🗵 9 illustrates the signal-to-noise ratio (SNR) versus the frequency of the input signal for 32-input mode with the ADC resolution set to 10 bits. SNR is expressed in the dBFS scale where the RMS noise at the ADC output is referred to the full-scale differential voltage of 2 V. The system clock provided is 100 MSPS and the input is sampled at an effective rate of 50 MSPS. SNR is computed by integrating the noise in all FFT bins after excluding the first nine harmonics. SNR is dominated by the quantization noise of the 10-bit conversion.
- ☑ 10 illustrates SNR versus the frequency of the input signal for 16-input mode with the ADC resolution set to 10 bits. The system clock provided is 100 MSPS and the input is sampled at an effective rate of 100 MSPS. SNR is computed by integrating the noise in all FFT bins after excluding the first nine harmonics and any interleaving spurs. SNR is dominated by the quantization noise of the 10-bit conversion.
- \boxtimes 11 illustrates SNR versus the frequency of the input signal for 8-input mode with the ADC resolution set to 10 bits. The system clock provided is 200 MSPS and the input is sampled at an effective rate of 200 MSPS. SNR is computed by integrating the noise in all FFT bins after excluding the first nine harmonics and any interleaving spurs at $(f_S / 2 \pm f_{IN})$ and $(f_S / 4 \pm f_{IN})$ as well as additional spurs at $f_S / 2$ and $f_S / 4$. SNR is dominated by the quantization noise of the 10-bit conversion.
- ☑ 12 illustrates SNR versus the frequency of the input signal for 32-input mode with the ADC resolution set to 12 bits. The system clock provided is 80 MSPS and the input is sampled at an effective rate of 40 MSPS.
- ☑ 13 illustrates SNR versus the frequency of the input signal for 16-input mode with the ADC resolution set to 12 bits. The system clock provided is 80 MSPS and the input is sampled at an effective rate of 80 MSPS.
- ☑ 14 illustrates SNR versus the frequency of the input signal for 32-input mode with the ADC resolution set to 14 bits. The system clock provided is 65 MSPS and the input is sampled at an effective rate of 32.5 MSPS. SNR at high input frequencies degrades because of clock jitter.
- ☑ 15 illustrates SNR versus the frequency of the input signal for 16-input mode with the ADC resolution set to 14 bits. The system clock provided is 65 MSPS and the input is sampled at an effective rate of 65 MSPS.
- ☑ 16 illustrates the amplitude of the third-order harmonic distortion (HD3) of the input signal versus the frequency of the input signal. The unit of dBc indicates that the HD3 amplitude is referred to the amplitude of the input signal, which is set to −1 dBFS. ☑ 16 is taken for 32-input mode with the ADC resolution set to 10 bits. The system clock provided is 100 MSPS and the input is sampled at an effective rate of 50 MSPS. The device follows a similar trend across the other input modes and resolutions.
- ☑ 17 illustrates the amplitude of the second-order harmonic distortion (HD2) of the input signal versus the frequency of the input signal. The unit of dBc indicates that the HD2 amplitude is referred to the amplitude of the input signal, which is set to −1 dBFS. ☑ 17 is taken for 32-input mode with the ADC resolution set to 10 bits. The system clock provided is 100 MSPS and the input is sampled at an effective rate of 50 MSPS. The device follows a similar trend across the other input modes and resolutions.
- ☑ 18 illustrates the total harmonic distortion (THD) versus the frequency of the input signal. The THD parameter includes the RMS amplitude of the first nine harmonics of the fundamental signal. The unit of dBc indicates that THD is referred to the amplitude of the input signal, which is set to −1 dBFS. ☑ 18 is taken for 32-input mode with the ADC resolution set to 10 bits. The system clock provided is 100 MSPS and the input is sampled at an effective rate of 50 MSPS. The device follows a similar trend across the other input modes and resolutions.
- ☑ 19 illustrates the interleaving spur at $(f_S / 2 \pm f_{IN})$ versus the frequency of the input signal. ☑ 19 is taken for 8-input mode with the ADC resolution set to 10 bits. The system clock is set to 200 MSPS and the input is sampled at an effective rate of 200 MSPS. The interleaving spur at $(f_S / 2 \pm f_{IN})$ is referred to the fundamental amplitude, which is at a level of −1 dBFS. The $(f_S / 2 \pm f_{IN})$ spur comes about because of the interleaved conversion of the same input by two ADCs. As illustrated in ☑ 19, the interleaving spur gets much worse at higher input frequencies. This degradation results from the fact that when the input frequency is increased, any mismatch in the sampling bandwidths and sampling instants of the two interleaved ADCs leads to a larger phase error between the interleaved conversions.
- \boxtimes 20 illustrates the interleaving spur at (f_S / 2 ± f_{IN}) versus the frequency of the input signal. \boxtimes 20 is taken for 16-input mode with the ADC resolution set to 10 bits. The system clock is set to 100 MSPS and the input is sampled at an effective rate of 100 MSPS. The (f_S / 2 ± f_{IN}) spur comes about because of the interleaved sampling of the input by the two sampling circuits of one ADC. Although not as bad as the (f_S / 2 ± f_{IN}) spur for 8-input mode, the interleaving spur could still be the dominant factor governing the SFDR at high input frequencies.



- ☑ 22 illustrates SNR in dBFS as a function of the input amplitude, also expressed in dBFS. SNR excludes the first nine harmonics and the interleaving spurs. ☑ 22 is taken for the 16-input mode with the ADC resolution set to 14 bits. The system clock is set to 65 MSPS and the input is sampled at an effective rate of 65 MSPS. The points in the left extreme of the curve provide an estimate of the idle channel SNR (SNR in the absence of an input signal).
- ☑ 23 illustrates the spurious-free dynamic range (SFDR) as a function of the input amplitude. ☑ 23 is taken for 32-input mode with the ADC resolution set to 14 bits. In 32-input mode, there is no interleaved operation of any sort and SFDR is a true measure of ADC conversion performance. As mentioned previously, SFDR may be dominated by interleaving spurs (and significantly lower than 32-input mode) when operated in 16-input or 8-input modes. SFDR is plotted in both dBc and dBFS: the former referring the amplitude of the worst-spur to the fundamental amplitude and the latter to the full-scale voltage.
- ☑ 24 illustrates SNR as a function of the input common-mode voltage (average of INP and INM). ☑ 24 is taken for 16-input mode with the ADC resolution set to 14 bits. The device is meant to be operated at an input common-mode that is tightly controlled around the ideal value of 0.8 V. The driving circuit can generate its output common-mode using the 0.8-V reference voltage provided at the VCM pin.
- \boxtimes 25 illustrates SNR as a function of the input clock amplitude (expressed in differential V_{PP}) when driven with a differential sine-wave clock input. At small input amplitudes, the sine-wave clock has a low dV/dt slope at the zero crossings. This low slope can cause increased jitter in the clocking and can lead to a reduction in the SNR within the device. The effect is more pronounced when the input frequency is set to a higher value (as is evidenced by the difference in behavior between the 5-MHz and 50-MHz inputs). The recommended manner to drive the device is with an LVPECL clock.
- ☑ 26 illustrates SNR as a function of the duty cycle of a differential clock input. Ideally, the device is driven with a 50% clock; see the *Electrical Characteristics* table for the acceptable variation around 50% duty cycle.
- ☑ 27 illustrates the channel-to-channel crosstalk as a function of the analog input frequency. An analog input of a −1-dBFS amplitude is applied on one channel and the crosstalk spur (at the input frequency) is measured on all channels. The worst of the crosstalk numbers (usually on the physically closest channel) is plotted.
- ☑ 28 illustrates the integral nonlinearity (INL) versus ADC code. The device is operated in 32-input mode at 14-bit resolution with an effective sampling rate of 32.5 MSPS. ☑ 28 provides an accurate INL estimate of the ADC inside the device because there is no interleaving of any kind in the 32-input mode operation.
- ☑ 29 illustrates the differential nonlinearity (DNL) versus ADC code. The device is operated in 32-input mode at 14-bit resolution with an effective sampling rate of 32.5 MSPS. The saturation of the DNL on the lower side to −1 indicates missing codes at the 14-bit level.
- \boxtimes 30 illustrates the power-supply rejection ratio (PSRR) as a function of the tone frequency applied on the supply. A tone is applied on the supplies and the tone at the same frequency is measured at the device output. The unit of dBc refers to the relation of the amplitude of the output tone to the amplitude of the supply tone that is set to 100 mV_{PP} for this measurement.
- ☑ 31 illustrates the power-supply modulation ratio (PSMR) as a function of the tone frequency applied on the supply. A –1-dBFS input at 5 MHz is applied on the analog input. Simultaneously, a 100-mV_{PP} tone is applied on the supply. The tone caused by the intermodulation between the supply tone and the input tone is measured at the device output. PSMR refers to the intermodulation tone referred to in terms of dBc to the amplitude of the input tone.
- ☑ 32 illustrates the common-mode rejection ratio (CMRR) as a function of the tone frequency applied as a common-mode signal on the input pins. A 50-mV_{PP} common-mode signal is applied to INP and INM around the ideal common-mode voltage of 0.8 V. The amplitude of the tone at the same frequency is measured at the device output. CMRR refers to the amplitude of this output tone referred to in terms of dBc to the amplitude of the common-mode input tone.



- \boxtimes 33 illustrates the current of the AVDD_1P8 supply as a function of f_C , the conversion clock frequency. The relation of the sampling rate to the conversion clock frequency is different between the 16-, 32-, and 8- input modes and therefore the curve can be appropriately interpreted for each mode. The curve extends to a conversion clock frequency of up to 100 MSPS, which is the maximum value for the 10-bit ADC resolution. For the 12- and 14-bit ADC resolutions, sections of the same curve up to 80 MSPS and 65 MSPS (respectively) are applicable.
- ☑ 34 illustrates the current of the DVDD_1P8 supply as a function of the conversion clock frequency. All 16 LVDS buffers are on during this measurement.
- 35 illustrates the current of the DVDD 1P2 supply as a function of the conversion clock frequency.
- ☑ 36 illustrates the total power consumption as a function of the conversion clock frequency. The power per input channel can be calculated by dividing this total power by 8, 16, or 32 for the 8-, 16-, or 32-input modes.
- 37 illustrates the digital high-pass filter response for different settings of the HPF corner frequency.
- \boxtimes 38 illustrates the typical minimum and maximum SNR values taken across 100 devices operating in the 14-bit, 32-input mode at f_C = 65 MSPS (corresponding to f_{SAMP} = 32.5 MSPS). A trend can be observed across channels and originates from the physical placement and routing of common signals (such as reference voltage and power) to the channels. Depending on the way the channel data are combined, an averaging effect can result when the system-level SNR is computed.
- \boxtimes 39 illustrates a plot of the low-frequency noise from the device with and without the chopper enabled. When the chopper is enabled (using the CHOPPER_EN register control), the low-frequency noise generated inside the device is shifted to approximately f_S / 2. Chopper mode is useful when the signal frequency of interest is close to dc.
- ☑ 48 illustrates a contour plot of SNR as a function of both the input frequency and sampling frequency for 32-input mode operating with a 10-bit ADC resolution.
- 🗵 49 illustrates a contour plot of SNR as a function of both the input frequency and sampling frequency for 16-input mode operating with a 10-bit ADC resolution.
- ☑ 50 illustrates a contour plot of SNR as a function of both the input frequency and sampling frequency for 8-input mode operating with a 10-bit ADC resolution.
- ☑ 51 illustrates a contour plot of SNR as a function of both the input frequency and sampling frequency for 32-input mode operating with a 12-bit ADC resolution.
- ☑ 52 illustrates a contour plot of SNR as a function of both the input frequency and sampling frequency for 16input mode operating with a 12-bit ADC resolution.
- ☑ 53 illustrates a contour plot of SNR as a function of both the input frequency and sampling frequency for 32-input mode operating with a 14-bit ADC resolution.
- ⊠ 54 illustrates a contour plot of SNR as a function of both the input frequency and sampling frequency for 16input mode operating with a 14-bit ADC resolution.



9.3 Do's and Don'ts

Driving the inputs (analog or digital) beyond the power-supply rails. For device reliability, an input must not go more than 300 mV below the ground pins or 300 mV above the supply pins. Exceeding these limits, even on a transient basis, can cause faulty or erratic operation and can impair device reliability.

Driving the device signal input with an excessively high level signal. The device offers consistent and fast overload recovery for an overload of upto 6 dBFS. For very large overload signals (> 6 dB of the linear input signal range), TI recommends back-to-back Schottky clamping diodes at the input to limit the amplitude of the input signal.

Using a clock source with excessive jitter, an excessively long input clock signal trace, or having other signals coupled to the ADC clock signal trace. These situations cause the sampling instant vary, causing an excessive output noise and a reduction in SNR performance. For a system with multiple devices, the clock tree scheme must be used to apply an ADC clock. Excessive clock delay mismatch between devices can also lead to latency mismatch and functional failure at the system level.

LVDS routing length mismatch. The routing length of all LVDS lines routing to the FPGA must be matched to avoid any timing-related issues. For systems with multiple devices, the LVDS serialized data clock (DCLKP, DCLKM) and the frame clock (FCLKP, FCLKM) of each individual device must be used to deserialize the corresponding LDVS serialized data (DOUTP, DOUTM).

Failure to provide adequate heat removal. Use the appropriate thermal parameter listed in the *Thermal Information* table and an ambient, board, or case temperature in order to calculate device junction temperature. A suitable heat removal technique must be used to keep the device junction temperature below the maximum limit of 105°C.

10 Power Supply Recommendations

The device requires three supplies in order to operate properly. These supplies are AVDD_1P8, DVDD_1P8, and DVDD_1P2. All supplies must be driven with low-noise sources to be able to achieve the best performance from the device. When determining the drive current needed to drive each of the supplies of the device, a margin of 50-100% over the typical current might be needed to account for the current consumption across different modes of operation.

10.1 Power Sequencing and Initialization

☑ 95 shows the suggested power-up sequencing and reset timing for the device. Note that the DVDD_1P2 supply must rise before the AVDD_1P8 supply. If the AVDD_1P8 supply rises before the DVDD_1P2 supply, the AVDD_1P8 supply current is several times higher than the normal operating current until the time the DVDD_1P2 supply reaches the 1.2-V level.

The device requires register described in 表 43 to be written as part of the initialization.

表 43. Initialization Register Details

INITIALIZATION REGISTER ADDRESS	16-BIT DATA WORD TO BE WRITTEN
0Ah	3000h

The initialization sequence is described below:

- 1. Power-up the supplies as indicated,
- 2. Apply a hardware reset pulse,
- 3. Write the initialization register listed in 表 43 through the SPI interface,
- 4. Write other device settings through the SPI interface, and
- 5. After a wait time, the device is ready for high accuracy operation.



The power sequence and initialization is shown in № 95.

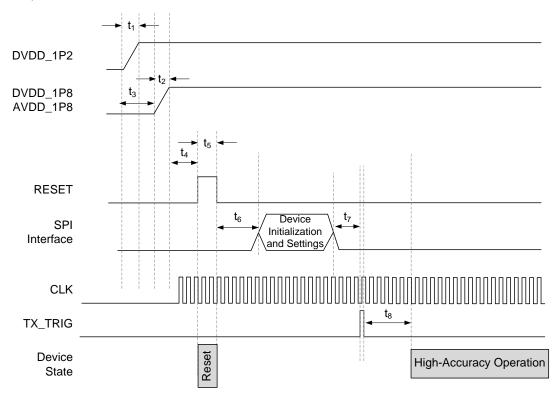


図 95. Power Sequencing and Initialization

The timing parameters corresponding to 図 95 are shown in 表 44.

表 44. Timing for Power Sequencing and Initialization

		MIN	MAX	UNIT
t ₁	Ramp-up time of DVDD_1P2	10 μ	50 m	S
t ₂	Ramp up time of AVDD_1P8 and DVDD_1P8	10 μ	50 m	S
t ₃	Time between DVDD_1P2 and AVDD_1P8 start of ramp up	t ₁		
t ₄	Time between supplies stabilizing and application of a hardware reset	10		ms
t ₅	Width of hardware reset	100		ns
t ₆	Time between hardware reset and SPI write for device initialization and programming of device settings	100		ns
t ₇	Time between programming of device settings and synchronization using TX_TRIG	100		ns
t ₈	Time between TX_TRIG pulse and device ready for high-accuracy operation	10		ADC clocks



11 Layout

11.1 Power Supply, Grounding, and Bypassing

In a mixed-signal system design, the power-supply and grounding design plays a significant role. The device distinguishes between two different grounds: AVSS (analog ground) and DVSS (digital ground). In most cases, laying out the PCB to use a single ground plane is adequate. However, in high-frequency or high-performance systems, care must be taken so that this ground plane is properly partitioned between various sections within the system to minimize interactions between analog and digital circuitry. Alternatively, the digital supply set consisting of the DVDD_1P8, DVDD_1P2, and DVSS pins can be placed on separate power and ground planes. For this configuration, tie the AVSS and DVSS grounds together at the power connector in a star layout. In addition, optical or digital isolators (such as the ISO7240) can completely separate the analog portion from the digital portion. Consequently, such isolators prevent digital noise from contaminating the analog portion. 表 45 lists the related circuit blocks for each power supply.

POWER SUPPLY
GROUND
CIRCUIT BLOCKS

AVDD_1P8
AVSS
ADC analog, reference voltage and current generator, band-gap circuit, and ADC clock buffer

DVDD_1P8
DVSS
LVDS serializer and buffer, and PLL
DVDD_1P2
DVSS
ADC digital and serial interface

表 45. Supply versus Circuit Blocks

Reference all bypassing and power supplies for the device to their corresponding ground planes. Bypass all supply pins with 0.1- μF ceramic chip capacitors (size 0603 or smaller). In order to minimize the lead and trace inductance, the capacitors must be located as close to the supply pins as possible. Where double-sided component mounting is allowed, these capacitors are best placed directly under the package. In addition, larger bipolar decoupling capacitors (2.2 μF to 10 μF , effective at lower frequencies) can also be used on the main supply pins. These components can be placed on the PCB in close proximity (< 0.5 inch or 12.7 mm) to the device itself.

Bypass the VCM pin with at least a $1-\mu F$ capacitor; higher value capacitors can be used for better low-frequency noise suppression. For best results, choose low-inductance ceramic chip capacitors (size 0402, > 1 μF) placed as close as possible to the device pin.

11.2 Layout Guidelines

High-speed, mixed-signal devices are sensitive to various types of noise coupling. One primary source of noise is the switching noise from the serializer and the output buffer and drivers. For the device, care must be taken to ensure that the interaction between the analog and digital supplies within the device is kept to a minimal amount. The extent of noise coupled and transmitted from the digital and analog sections depends on the effective inductances of each of the supply and ground connections. Smaller effective inductances of the supply and ground pins result in better noise suppression. For this reason, multiple pins are used to connect each supply and ground sets. Low inductance properties must be maintained throughout the design of the PCB layout by use of proper planes and layer thickness.

To avoid noise coupling through supply pins, TI recommends keeping sensitive input pins (such as the INM and INP pins) away from the supply planes. For example, do not route the traces or vias connected to these pins across the supply planes. That is, avoid the power planes under the INM and INP pins.

Some layout guidelines associated with the layout of the high speed interfaces are listed below:

- The length of the positive and negative traces of a differential pair must be matched to within 2 mils of each other.
- Each differential pair length must be matched within 10 mils of other differential pairs.
- When the ADC is used on the same printed circuit board (PCB) with a digital intensive component (such as an FPGA or ASIC), separate digital and analog ground planes must be used. Do not overlap these separate ground planes to minimize undesired coupling.
- Connect decoupling capacitors directly to ground and place these capacitors close to the ADC power pins and the power-supply pins to filter high-frequency current transients directly to the ground plane.
- Ground and power planes must be wide enough to keep the impedance very low. In a multilayer PCB, one layer must be dedicated to each ground and power plane.



Layout Guidelines (continued)

- All high-speed traces must be routed straight with minimum bends. Where a bend is necessary, avoid making very sharp right-angle bends in the trace.
- In order to maintain proper LVDS timing, all LVDS traces must follow a controlled impedance design. In addition, all LVDS trace lengths must be equal and symmetrical; TI recommends keeping trace length variations less than 150 mil (0.150 inch or 3.81 mm).
- When routing CML lines, the traces must be designed for a controlled impedance of 50 Ω . The routing of different lines must be matched as much as possible to minimize the inter-lane skew. However, trace length matching is less critical for the JESD interface as compared to the LVDS interface.

Additional details on the NFBGA PCB layout techniques can be found in the Texas Instruments application report, *MicroStar BGA Packaging Reference Guide* (SSYZ015), available from www.ti.com.

11.3 Layout Example

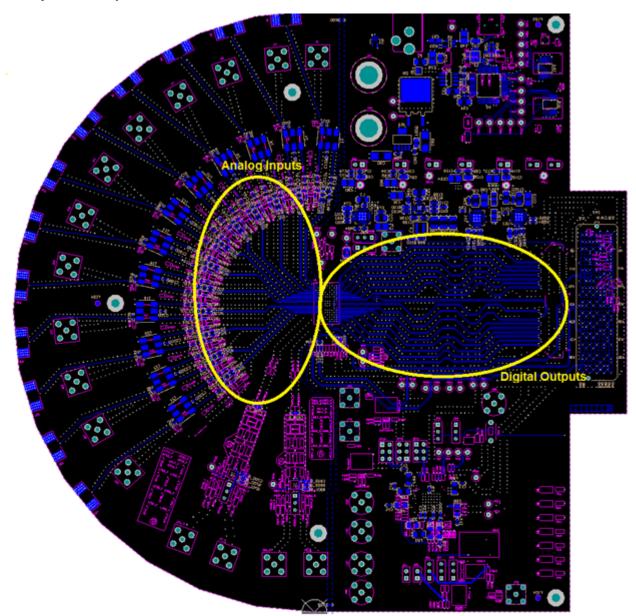


図 96. Example Layout

TEXAS INSTRUMENTS

12 Register Map

12.1 ADC Registers

The register map of the device is shown in 表 46.

表 46. ADC Register Map

REGISTER ADDRESS								REGISTE	R DATA ⁽¹⁾							
(Hex)	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	REG_ READ_EN	RESET
1	0	LVDS_ RATE_2X	0	0	0	0	0	0	SEL_CH[2]	EN_JESD	DIS_LVDS	SEL_CH[1]	0	SEL_CH[0]	0	GLOBAL_ PDN
2	P.A	AT_MODES_FC	ELK	LOW_ LATENCY_ EN	AVG_EN	SEL_ PRBS_ PAT_FCLK		PAT_MODES		SEL_ PRBS_ PAT_GBL	OFFSET_CORR_DELAY_FROM_TX_TRIC			TRIG[5:0]		
3	S	ER_DATA_RAT	ΓE	DIG_ GAIN_EN	0	OFFSET_CC FROM_TX	DRR_DELAY_ [_TRIG[7:6]	DIG_ OFFSET_ EN	0	0	JESD_ WR_SEL	0	0	0	0	0
4	OFFSET_ REMOVAL_ SELF	OFFSET_ REMOVAL_ START_ SEL	OFFSET_ REMOVAL_ START_ MANUAL	AUTO_	_OFFSET_REM	MOVAL_ACC_C	YCLES	PAT_SEL _IND	PRBS_ SYNC	PRBS_ MODE	PRBS_ EN	MSB_ FIRST	0	0	ADC	_RES
5								CUSTOM	PATTERN							
7	А	UTO_OFFSET	_REMOVAL_V	AL_RD_CH_SE	L	0	0	0	0	0	0	0	0	0	0	CHOPPER _EN
8	0	0						AUT	O_OFFSET_R	EMOVAL_VAL	_RD					
Α	0	0	INIT2	INIT1	0	0	0	0	0	0	0	0	0	0	0	0
В	0	0	0	0	EN_ DITHER	0	0	0	0	0	0	0	0	0	0	0
D			GAIN_ADC1o			0					OFFSET	Γ_ADC1o				
E			GAIN_ADC1e			0					OFFSET	Γ_ADC1e				
F			GAIN_ADC20			0					OFFSET	Γ_ADC2o				
10			GAIN_ADC2e			0					OFFSET	Γ_ADC2e				
11			GAIN_ADC3o			0					OFFSET	Γ_ADC3o				
12			GAIN_ADC3e			0					OFFSET	Γ_ADC3e				
13			GAIN_ADC40			0					OFFSET	Γ_ADC4o				
14			GAIN_ADC4e			0					OFFSET	Γ_ADC4e				
15	PAT_ PRBS_ LVDS1	PAT_ PRBS_ LVDS2	PAT_ PRBS_ LVDS3	PAT_ PRBS_ LVDS4		PAT_LVDS1			PAT_LVDS2		HPF_ ROUND_ EN_CH1-8		HPF_CORN	IER_ADC1-4		DIG_HPF_ EN_ADC1-4
17	0	0	0	0	IN_16CH_ ADC1	IN_16CH_ ADC2	IN_16CH_ ADC3	IN_16CH_ ADC4		PAT_LVDS3			PAT_LVDS4		0	0
18	PDN_ DIG_ADC4	PDN_ DIG_ADC3	PDN_ DIG_ADC2	PDN_ DIG_ADC1	PDN_ LVDS4	PDN_ LVDS3	PDN_ LVDS2	PDN_ LVDS1	PDN_ ANA_ADC4	PDN_ ANA_ADC3	PDN_ ANA_ADC2	PDN_ ANA_ADC1	INVERT_ LVDS4	INVERT_ LVDS3	INVERT_ LVDS2	INVERT_ LVDS1

⁽¹⁾ Default value of all registers is 0.



ADC Registers (continued)

表 46. ADC Register Map (continued)

REGISTER ADDRESS								REGISTE	ER DATA ⁽¹⁾							
(Hex)	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
19			GAIN_ADC50			0					OFFSET	_ADC5o				
1A			GAIN_ADC5e			0					OFFSET	T_ADC5e				
1B			GAIN_ADC60			0					OFFSET	T_ADC6o				
1C			GAIN_ADC6e			0					OFFSET	T_ADC6e				
1D			GAIN_ADC70			0					OFFSET	T_ADC7o				
1E			GAIN_ADC7e			0					OFFSET	_ADC7e				
1F			GAIN_ADC80			0					OFFSET	T_ADC8o				
20			GAIN_ADC8e			0					OFFSET	_ADC8e				
21	PAT_ PRBS_ LVDS5	PAT_ PRBS_ LVDS6	PAT_ PRBS_ LVDS7	PAT_ PRBS_ LVDS8		PAT_LVDS5			PAT_LVDS6		0		HPF_CORN	IER_ADC5-8		DIG_ HPF_EN_ ADC5-8
23	0	0	0	0	IN_16CH_ ADC5	IN_16CH_ ADC6	IN_16CH_ ADC7	IN_16CH_ ADC8		PAT_LVDS7			PAT_LVDS8		0	0
24	PDN_ DIG_ADC8	PDN_ DIG_ADC7	PDN_ DIG_ADC6	PDN_ DIG_ADC5	PDN_ LVDS8	PDN_ LVDS7	PDN_ LVDS6	PDN_ LVDS5	PDN_ ANA_ADC8	PDN_ ANA_ADC7	PDN_ ANA_ADC6	PDN_ ANA_ADC5	INVERT_ LVDS8	INVERT_ LVDS7	INVERT_ LVDS6	INVERT_ LVDS5
25			GAIN_ADC90			0				•	OFFSET	_ADC9o				
26			GAIN_ADC9e			0					OFFSET	_ADC9e				
27			GAIN_ADC10d)		0					OFFSET	_ADC10o				
28			GAIN_ADC10e)		0					OFFSET	_ADC10e				
29			GAIN_ADC11c)		0					OFFSET	_ADC11o				
2A			GAIN_ADC116)		0					OFFSET	_ADC11e				
2B			GAIN_ADC12d)		0					OFFSET	_ADC120				
2C			GAIN_ADC126)		0	OFFSET_ADC12e									
2D	PAT_ PRBS_ LVDS9	PAT_ PRBS_ LVDS10	PAT_ PRBS_ LVDS11	PAT_ PRBS_ LVDS12		PAT_LVDS9			PAT_LVDS10		HPF_ROUN D_EN_CH9- 16		HPF_CORNI	ER_ADC9-12		DIG_ HPF_EN_ ADC9-12
2F	0	0	0	0	IN_16CH_ ADC9	IN_16CH_ ADC10	IN_16CH_ ADC11	IN_16CH_ ADC12		PAT_LVDS11			PAT_LVDS12		0	0
30	PDN_ DIG_ADC12	PDN_ DIG_ADC11	PDN_ DIG_ADC10	PDN_ DIG_ADC9	PDN_ LVDS12	PDN_ LVDS11	PDN_ LVDS10	PDN_ LVDS9	PDN_ANA_ ADC12	PDN_ANA_ ADC11	PDN_ANA_ ADC10	PDN_ANA_ ADC9	INVERT_ LVDS12	INVERT_ LVDS11	INVERT_ LVDS10	INVERT_ LVDS9

ADC Registers (continued)

表 46. ADC Register Map (continued)

REGISTER ADDRESS								REGISTE	R DATA ⁽¹⁾							
(Hex)	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
31			GAIN_ADC13d)		0		•		•	OFFSET	ADC13o			•	
32			GAIN_ADC13e)		0					OFFSET	_ADC13e				
33			GAIN_ADC14d)		0					OFFSET	_ADC14o				
34			GAIN_ADC14e)		0					OFFSET	_ADC14e				
35			GAIN_ADC150)		0					OFFSET	_ADC150				
36			GAIN_ADC15e)		0	OFFSET_ADC15e									
37			GAIN_ADC16d)		0					OFFSET	_ADC16o				
38			GAIN_ADC16e)		0					OFFSET	_ADC16e				
39	PAT_ PRBS_ LVDS13	PAT_ PRBS_ LVDS14	PAT_ PRBS_ LVDS15	PAT_ PRBS_ LVDS16		PAT_LVDS13			PAT_LVDS14		0		HPF_CORNE	ER_ADC13-16		DIG_ HPF_EN_ ADC13-16
3B	0	0	0	0	IN_16CH_ ADC13	IN_16CH_ ADC14	IN_16CH_ ADC15	IN_16CH_ ADC16		PAT_LVDS15			PAT_LVDS16		0	0
3C	PDN_ DIG_ADC16	PDN_ DIG_ADC15	PDN_ DIG_ADC14	PDN_ DIG_ADC13	PDN_ LVDS16	PDN_ LVDS15	PDN_ LVDS14	PDN_ LVDS13	PDN_ANA_ ADC16	PDN_ANA_ ADC15	PDN_ANA_ ADC14	PDN_ANA_ ADC13	INVERT_ LVDS16	INVERT_ LVDS15	INVERT_ LVDS14	INVERT_ LVDS13
43	0	0	0	0	0	0	0	0	0	0	0		LVDS_	DCLK_DELAY	_PROG	



12.1.1 Description of Registers

12.1.1.1 Register 0h (address = 0h)

図 97. Register 0h

15	14	13	12	11	10	9	8
0	0	0	0	0	0	0	0
W-0h	W-0h						
7	6	5	4	3	2	1	0
0	0	0	0	0	0	REG_READ_ EN	RESET
W-0h	W-0h						

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

表 47. Register 0h Field Descriptions

Bit	Field	Туре	Reset	Description
15-2	0	W	0h	Must write 0
1	REG_READ_EN	W	Oh	Register readout enabled. 0 = Disabled 1 = Enabled; see the Serial Peripheral Interface (SPI) Operation section for further details.
0	RESET	W	0h	0 = Disabled 1 = Enabled (this setting returns the device to a reset state; this bit is self-clearing bit)



12.1.1.2 Register 1h (address = 1h)

図 98. Register 1h

15	14	13	12	11	10	9	8
0	LVDS_RATE_ 2X	0	0	0	0	0	0
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h
7	6	5	4	3	2	1	0
SEL_CH[2]	EN_JESD	DIS_LVDS	SEL_CH[1]	0	SEL_CH[0]	0	GLOBAL_PDN
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h

LEGEND: R/W = Read/Write; -n = value after reset

表 48. Register 1h Field Descriptions

Bit	Field	Туре	Reset	Description
15	0	R/W	0h	Must write 0
14	LVDS_RATE_2X	R/W	0h	0 = 1X rate; normal operation (default) 1 = 2X rate. This setting combines the data of two LVDS pairs into a single LVDS pair. This feature can be used when the ADC clock rate is low.
13-8	0	R/W	0h	Must write 0
7	SEL_CH[2]	R/W	0h	Input mode selection bit 3. 表 49 lists bit settings for the three input modes.
6	EN_JESD	R/W	0h	0 = JESD interface disabled 1 = JESD interface enabled; see 表 49
5	DIS_LVDS	R/W	0h	0 = LVDS interface is enabled (default) 1 = LVDS interface is disabled
4	SEL_CH[1]	R/W	0h	Input mode selection bit 2. 表 49 lists bit settings for the three input modes.
3	0	R/W	0h	Must write 0
2	SEL_CH[0]	R/W	0h	Input mode selection bit 1. 表 49 lists bit settings for the three input modes.
1	0	R/W	0h	Must write 0
0	GLOBAL_PDN	R/W	0h	0 = The device operates in normal mode (default) 1 = ADC enters complete power-down mode

表 49. 8-, 16-, and 32-Input Mode Selection

INPUT MODE	SEL_CH[2]	SEL_CH[1]	SEL_CH[0]
8-channel input	1	1	1
16-channel input	0	1	1
32-channel input	0	0	0

表 50. Output Interface Supported in 8-, 16-, and 32-Input Mode

INDUT MODE	OUTPUT INTERFACE SUPPORTED?					
INPUT MODE	LVDS	JESD204B				
8-channel input	Yes	No				
16-channel input	Yes	Yes				
32-channel input	Yes	Yes				



12.1.1.3 Register 2h (address = 2h)

図 99. Register 2h

15	14	13	12	11	10	9	8		
PAT	Γ_MODES_FCLK[2	2:0]			SEL_PRBS_ PAT_FCLK				
	R/W-0h		R/W-0h	R/W-0h	R/W-0h	R/W-0h			
7	6	5	4	3	2	1	0		
PAT_ MODES[2:0]	SEL_PRBS_ PAT_GBL	OFFSET_CORR_DELAY_FROM_TX_TRIG[5:0]							
R/W-0h	R/W-0h		R/W-0h						

LEGEND: R/W = Read/Write; -n = value after reset

表 51. Register 2h Field Descriptions

Bit	Field	Type	Reset	Description			
15-13	PAT_MODES_FCLK[2:0]	R/W	0h	These bits enable different test patterns on the frame clock line; see 表 52 for bit descriptions and the <i>LVDS Test Pattern Mode</i> section for further details.			
12	LOW_LATENCY_EN	R/W	0h	0 = Default latency with digital features supported 1 = Low-latency with digital features bypassed			
11	AVG_EN	R/W	0h	0 = No digital averaging 1 = Enables digital averaging of two channels to improve signal- to-noise ratio (SNR)			
10	SEL_PRBS_PAT_FCLK	R/W	0h	0 = Normal operation 1 = Enables the PRBS pattern to be generated on FCLK; see the <i>LVDS Test Pattern Mode</i> section for further details.			
9-7	PAT_MODES[2:0]	R/W	0h	These bits enable different test patterns on the LVDS data lines; see 表 52 for bit descriptions and the <i>LVDS Test Pattern Mode</i> section for further details.			
6	SEL_PRBS_PAT_GBL	R/W	Oh	0 = Normal operation 1 = Enables the PRBS pattern to be generated on all the LVDS data lines; see the <i>LVDS Test Pattern Mode</i> section for further details.			
5-0	OFFSET_CORR_DELAY_FROM_ TX_TRIG[5:0]	R/W	0h	This is a part of an 8-bit control that initiates offset correction after the TX_TRIG input pulse (each step is equivalent to one sample delay); the remaining two MSB bits are the OFFSET_CORR_DELAY_FROM_TX_TRIG[7:6] bits (bits 10-9) in register 3.			

表 52. Pattern Mode Bit Description⁽¹⁾

PAT_MODES[2:0] or PAT_MODES_FCLK[2:0] or PAT_LVDSx[2:0]	DESCRIPTION
000	Normal operation
001	Sync (half frame 1, half frame 0)
010	Deskew
011	Custom ⁽²⁾
100	All 1s
101	Toggle mode
110	All 0s
111	Ramp ⁽²⁾

⁽¹⁾ For detailed description, see 表 33.
(2) Either the custom or ramp pattern setting is required for PRBS pattern selection.



12.1.1.4 Register 3h (address = 3h)

図 100. Register 3h

15	14	13	12	11	10	9	8
	SER_DATA_RAT	E	DIG_GAIN_EN	0		_DELAY_FROM RIG[7:6]	DIG_ OFFSET_EN
	R/W-0h		R/W-0h	R/W-0h	R/W	/-0h	R/W-0h
7	6	5	4	3	2	1	0
0	0	JESD_WR_ SEL	0	0	0	0	0
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h

LEGEND: R/W = Read/Write; -n = value after reset

表 53. Register 3h Field Descriptions

D:4	Field	T	Dooot	Description
Bit	Field	Туре	Reset	Description
15-13	SER_DATA_RATE	R/W	Oh	These bits control the LVDS serialization rate. 000 = 12X 001 = 14X 100 = 16X 011 = 10X 101, 110, 111, 010 = Unused
12	DIG_GAIN_EN	R/W	0h	0 = Digital gain disabled 1 = Digital gain enabled
11	0	R/W	0h	Must write 0
10-9	OFFSET_CORR_DELAY_FROM_ TX_TRIG[7:6]	R/W	0h	This is a part of an 8-bit control that initiates offset correction after the TX_TRIG input pulse (each step is equivalent to one sample delay); the remaining six LSB bits are the OFFSET_CORR_DELAY_FROM_TX_TRIG[5:0] bits (bits 5-0) in register 2.
8	DIG_OFFSET_EN	R/W	0h	0 = Digital offset subtraction disabled 1 = Digital offset subtraction enabled
7-6	0	R/W	0h	Must write 0
5	JESD_WR_SEL	R/W	Oh	0 = Setting when writing to all registers except for registers with addresses in the decimal range of 115-119 and 134-138 1 = Setting when writing to registers with addresses in the decimal range of 115-119 and 134-138
4-0	0	R/W	0h	Must write 0



12.1.1.5 Register 4h (address = 4h)

図 101. Register 4h

15	14	13	12	11	10	9	8
OFFSET_ REMOVAL_ SELF	OFFSET_ REMOVAL_ START_ SEL	OFFEST_ REMOVAL_ START_ MANUAL	AUTO_OFFSET_REMOVAL_ACC_CYCLES[3:0]				PAT_ SELECT_ IND
R/W-0h	R/W-0h	R/W-0h		R/W	V-0h		R/W-0h
7	6	5	4	3	2	1	0
PRBS_ SYNC	PRBS_ MODE	PRBS_EN	MSB_FIRST	0	0	ADC	_RES
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/V	V-0h

LEGEND: R/W = Read/Write; -n = value after reset

表 54. Register 4h Field Descriptions

Zon Register III Total Zooon priorite							
Bit	Field	Туре	Reset	Description			
15	OFFSET_REMOVAL_SELF	R/W	0h	Auto offset removal mode is enabled when this bit is set to 1			
14	OFFSET_REMOVAL_START_SEL	R/W	0h	0 = Auto offset correction initiated when the OFFSET_REMOVAL_START_ MANUAL bit is set to 1. 1 = Auto offset correction initiated with a pulse on TX_TRIG pin.			
13	OFFSET_REMOVAL_START_ MANUAL	R/W	0h	This bit initiates offset correction when OFFSET_REMOVAL_START_SEL is set to 0.			
12-9	AUTO_OFFSET_REMOVAL_ACC_CYCLES	R/W	0h	These bits define the number of samples required to generate an offset in auto offset correction mode			
8	PAT_SELECT_IND	R/W	Oh	0 = All LVDS output data lines have the same pattern, as determined by the PAT_MODES[2:0] bits 1 = Different test patterns can be sent on different LVDS data lines; see the LVDS Test Pattern Mode section for further details			
7	PRBS_SYNC	R/W	0h	0 = Normal operation 1 = PRBS generator is in a reset state			
6	PRBS_MODE	R/W	0h	0 = 23-bit PRBS generator 1 = 9-bit PRBS generator			
5	PRBS_EN	R/W	0h	0 = PRBS sequence generation block disabled 1 = PRBS sequence generation block enabled; see the LVDS Test Pattern Mode section for further details			
4	MSB_FIRST	R/W	0h	0 = The LSB is transmitted first on serialized output data 1 = The MSB is transmitted first on serialized output data			
3-2	0	R/W	0h	Must write 0			
1-0	ADC_RES	R/W	Oh	These bits control the ADC resolution. 00 = 12-bit resolution 01 = 14-bit resolution 11 = 10-bit resolution 10 = Unused			



12.1.1.6 Register 5h (address = 5h)

図 102. Register 5h

15	14	13	12	11	10	9	8			
CUSTOM_PATTERN										
R/W-0h										
7	6	5	4	3	2	1	0			
	CUSTOM_PATTERN									
	R/W-0h									

LEGEND: R/W = Read/Write; -n = value after reset

表 55. Register 5h Field Descriptions

Bi	it	Field	Туре	Reset	Description
15-	-0	CUSTOM_PATTERN	R/W	Oh	If the pattern mode is programmed to a custom pattern mode, then the custom pattern value can be provided by programming these bits; see the <i>LVDS Test Pattern Mode</i> section for further details.

12.1.1.7 Register 7h (address = 7h)

図 103. Register 7h

15	14	13	12	11	10	9	8
	AUTO_OFFSE	T_REMOVAL_VA	0	0	0		
		R/W-0h			R/W-0h	R/W-0h	R/W-0h
7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	CHOPPER_EN
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h

LEGEND: R/W = Read/Write; -n = value after reset

表 56. Register 7h Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	AUTO_OFFSET_REMOVAL_VAL_ RD_CH_SEL	R/W	Oh	Write the channel number to read the offset value in auto offset correction mode for a corresponding channel number (read the offset value in AUTO_OFFSET_REMOVAL_VAL_RD. (1)
10-1	0	R/W	0h	Must write 0
0	CHOPPER_EN	R/W	Oh	The chopper can be used to move low-frequency, 1 / f noise to f _S / 2 frequency. 0 = Chopper disabled 1 = Chopper enabled

(1) In 32-channel input mode, the value written in this register corresponds to the channel number (minus 1). When operating in 8- and 16-input modes, the value can be mapped to the odd or even data streams of the 16 ADCs. For example, a value of 0 corresponds to the odd data stream of ADC1. Likewise, a value of 1 corresponds to the even data stream of ADC1, and so on respectively.



12.1.1.8 Register 8h (address = 8h)

図 104. Register 8h

15	14	13	12	11	10	9	8	
0	0	AUTO_OFFSET_REMOVAL_VAL_RD[13:0]						
R/W-0h	R/W-0h	R/W-0h						
7	6	5	4	3	2	1	0	
AUTO_OFFSET_REMOVAL_VAL_RD[13:0]								
	R/W-0h							

LEGEND: R/W = Read/Write; -n = value after reset

表 57. Register 8h Field Descriptions

Bit	Field	Туре	Reset	Description
15-14	0	R/W	0h	Must write 0
13-0	AUTO_OFFSET_REMOVAL_VAL_ RD	R/W	0h	Read the offset value applied in auto offset correction mode for a specific channel number as defined in AUTO_OFFSET_REMOVAL_VAL_RD_CH_SEL

12.1.1.9 Register Ah (address = Ah)

図 105. Register Ah

15	14	13	12	11	10	9	8
0	0	INIT2	INIT1	0	0	0	0
R/W-0h							
7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0
R/W-0h							

LEGEND: R/W = Read/Write; -n = value after reset

表 58. Register Ah Field Descriptions

Bit	Field	Туре	Reset	Description
15-14	0	R/W	0h	Must write 0
13	INIT2	R/W	0h	Write 1 as part of the initialization after power-up ⁽¹⁾
12	INIT1	R/W	0h	Write 1 as part of the initialization after power-up ⁽¹⁾
11-0	0	R/W	0h	Must write 0

(1) See 表 43.



12.1.1.10 Register Bh (address = Bh)

図 106. Register Bh

15	14	13	12	11	10	9	8
0	0	0	0	EN_DITHER	0	0	0
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h
7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h

LEGEND: R/W = Read/Write; -n = value after reset

表 59. Register Bh Field Descriptions

Bit	Field	Туре	Reset	Description
15-12	0	R/W	0h	Must write 0
11	EN_DITHER	R/W	0h	Dither can be used to reduce the power in higher-order harmonics. 0 = Dither disabled 1 = Dither enabled Note: Enabling the dither converts higher-order harmonics power into noise. Thus, enabling this mode reduce the power in higher-order harmonics but degrades SNR.
10-0	0	R/W	0h	Must write 0



12.1.1.11 Register Dh (address = Dh)

図 107. Register Dh

15	14	13	12	11	10	9	8
GAIN_ADC10 0 OFFSET_ADC10							Γ_ADC1o
R/W-0h R/W-0h R/W-0h							V-0h
7	6	5	4	3	2	1	0
OFFSET_ADC1o							
R/W-0h							

LEGEND: R/W = Read/Write; -n = value after reset

表 60. Register Dh Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC1o	R/W	0h	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the odd sample of ADC1 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC10	R/W	0h	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the odd sample of ADC1 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.

12.1.1.12 Register Eh (address = Eh)

図 108. Register Eh

15	14	13	12	11	10	9	8
		GAIN_ADC1e		0	OFFSET	Γ_ADC1e	
R/W-0h R/W-0h R/W-0h							V-0h
7	6	5	4	3	2	1	0
	OFFSET_ADC1e						
	R/W-0h						

LEGEND: R/W = Read/Write; -n = value after reset

表 61. Register Eh Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC1e	R/W	0h	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the even sample of ADC1 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC1e	R/W	0h	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the even sample of ADC1 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.



12.1.1.13 Register Fh (address = Fh)

図 109. Register Fh

15	14	13	12	11	10	9	8
GAIN_ADC2o 0 OFFSET_ADC2o							Γ_ADC2o
R/W-0h R/W-0h R/W-0h							V-0h
7	6	5	4	3	2	1	0
OFFSET_ADC20							
R/W-0h							

LEGEND: R/W = Read/Write; -n = value after reset

表 62. Register Fh Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC2o	R/W	0h	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the odd sample of ADC2 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC20	R/W	0h	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the odd sample of ADC2 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.

12.1.1.14 Register 10h (address = 10h)

図 110. Register 10h

15	14	13	12	11	10	9	8
		GAIN_ADC2e	0	OFFSET	_ADC2e		
R/W-0h R/W-0h R						R/V	V-0h
7	6	5	4	3	2	1	0
OFFSET_ADC2e							
R/W-0h							

LEGEND: R/W = Read/Write; -n = value after reset

表 63. Register 10h Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC2e	R/W	0h	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the even sample of ADC2 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC2e	R/W	0h	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the even sample of ADC2 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.



12.1.1.15 Register 11h (address = 11h)

図 111. Register 11h

15	14	13	12	11	10	9	8
		GAIN_ADC3o		0	OFFSET	_ADC3o	
R/W-0h R/W-0h						R/V	V-0h
7	6	5	4	3	2	1	0
OFFSET_ADC3o							
R/W-0h							

LEGEND: R/W = Read/Write; -n = value after reset

表 64. Register 11h Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC3o	R/W	0h	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the odd sample of ADC3 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC3o	R/W	0h	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the odd sample of ADC3 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.

12.1.1.16 Register 12h (address = 12h)

図 112. Register 12h

15	14	13	12	11	10	9	8
GAIN_ADC3e 0 OFFSET_ADC3e							_ADC3e
R/W-0h R/W-0h						R/V	V-0h
7	6	5	4	3	2	1	0
OFFSET_ADC3e							
R/W-0h							

LEGEND: R/W = Read/Write; -n = value after reset

表 65. Register 12h Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC3e	R/W	0h	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the even sample of ADC3 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC3e	R/W	0h	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the even sample of ADC3 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.



12.1.1.17 Register 13h (address = 13h)

図 113. Register 13h

15	14	13	12	11	10	9	8
		GAIN_ADC4o	0	OFFSET	_ADC4o		
R/W-0h						R/W	/-0h
7	6	5	4	3	2	1	0
OFFSET_ADC40							
R/W-0h							

LEGEND: R/W = Read/Write; -n = value after reset

表 66. Register 13h Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC4o	R/W	Oh	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the odd sample of ADC4 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC4o	R/W	Oh	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the odd sample of ADC4 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.

12.1.1.18 Register 14h (address = 14h)

図 114. Register 14h

15	14	13	12	11	10	9	8
GAIN_ADC4e 0 OFFSET_ADC4							Γ_ADC4e
R/W-0h R/W-						R/V	V-0h
7	6	5	4	3	2	1	0
OFFSET_ADC4e							
R/W-0h							

LEGEND: R/W = Read/Write; -n = value after reset

表 67. Register 14h Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC4e	R/W	Oh	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the even sample of ADC4 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N × 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC4e	R/W	Oh	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the even sample of ADC4 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.



12.1.1.19 Register 15h (address = 15h)

図 115. Register 15h

15	14	13	12	11	10	9	8
PAT_PRBS_ LVDS1	PAT_PRBS_ LVDS2	PAT_PRBS_ LVDS3	PAT_PRBS_ LVDS4	PAT_LVDS1			PAT_ LVDS2
R/W-0h	R/W-0h	R/W-0h	R/W-0h		R/W-0h		R/W-0h
7	6	5	4	3	2	1	0
PAT_L	_VDS2	HPF_ROUND_ EN_CH1-8		HPF_COR	NER_ADC1-4		DIG_HPF_EN_ ADC1-4
R/W	V-0h	R/W-0h		R/	W-0h		R/W-0h

LEGEND: R/W = Read/Write; -n = value after reset

表 68. Register 15h Field Descriptions

& oc. Register 1311 Field Descriptions								
Bit	Field	Туре	Reset	Description				
15	PAT_PRBS_LVDS1	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the PRBS pattern on LVDS output 1 can be enabled with this bit; see the <i>LVDS Test Pattern Mode</i> section for further details.				
14	PAT_PRBS_LVDS2	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the PRBS pattern on LVDS output 2 can be enabled with this bit; see the <i>LVDS Test Pattern Mode</i> section for further details.				
13	PAT_PRBS_LVDS3	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the PRBS pattern on LVDS output 3 can be enabled with this bit; see the <i>LVDS Test Pattern Mode</i> section for further details.				
12	PAT_PRBS_LVDS4	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the PRBS pattern on LVDS output 4 can be enabled with this bit; see the <i>LVDS Test Pattern Mode</i> section for further details.				
11-9	PAT_LVDS1	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the pattern on LVDS output 1 can be programmed with these bits; see 表 33 for bit descriptions.				
8-6	PAT_LVDS2	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the pattern on LVDS output 2 can be programmed with these bits; see 表 33 for bit descriptions.				
5	HPF_ROUND_EN_CH1-8	R/W	Oh	 0 = Rounding in the ADC HPF is disabled for channel 1 to 8. HPF output is truncated to be mapped to the ADC resolution bits. 1 = HPF output of channel 1 to 8 is mapped to the ADC resolution bits by the round-off operation. 				
4-1	HPF_CORNER_ADC1-4	R/W	Oh	When the DIG_HPF_EN_ADC1-4 bit is set to 1, the digital HPF characteristic for the corresponding ADCs can be programmed by setting the value of k with these bits. The value of k can be from 2 to 10 (0010b to 1010b); see the Digital HPF section for further details.				
0	DIG_HPF_EN_ADC1-4	R/W	0h	0 = Digital HPF disabled for ADCs 1 to 4 (default) 1 = Enables digital HPF for ADCs 1 to 4				



12.1.1.20 Register 17h (address = 17h)

図 116. Register 17h

15	14	13	12	11	10	9	8
0	0	0	0	IN_16CH_ ADC1	IN_16CH_ ADC2	IN_16CH_ ADC3	IN_16CH_ ADC4
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h
7	6	5	4	3	2	1	0
	PAT_LVDS3			PAT_LVDS4		0	0
	R/W-0h			R/W-0h		R/W-0h	R/W-0h

LEGEND: R/W = Read/Write; -n = value after reset

表 69. Register 17h Field Descriptions

	2 con regions. The result of the second seco							
Bit	Field	Туре	Reset	Description				
15-12	0	R/W	0h	Must write 0				
11	IN_16CH_ADC1	R/W	0h	Selects the input pair sampled by ADC1 in 16-input mode. 0 = ADC1 samples the signal on INP1, INM1 1 = ADC1 samples the signal on INP2, INM2				
10	IN_16CH_ADC2	R/W	0h	Selects the input pair sampled by ADC2 in 16-input mode. 0 = ADC2 samples the signal on INP3, INM3 1 = ADC2 samples the signal on INP4, INM4				
9	IN_16CH_ADC3	R/W	0h	Selects the input pair sampled by ADC3 in 16-input mode. 0 = ADC3 samples the signal on INP5, INM5 1 = ADC3 samples the signal on INP6, INM6				
8	IN_16CH_ADC4	R/W	0h	Selects the input pair sampled by ADC4 in 16-input mode. 0 = ADC4 samples the signal on INP7, INM7 1 = ADC4 samples the signal on INP8, INM8				
7-5	PAT_LVDS3	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the pattern on LVDS output 3 can be programmed with these bits; see 表 33 for bit descriptions.				
4-2	PAT_LVDS4	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the pattern on LVDS output 4 can be programmed with these bits; see 表 33 for bit descriptions.				
1-0	0	R/W	0h	Must write 0				



12.1.1.21 Register 18h (address = 18h)

図 117. Register 18h

15	14	13	12	11	10	9	8
PDN_DIG_ ADC4	PDN_DIG_ ADC3	PDN_DIG_ ADC2	PDN_DIG_ ADC1	PDN_LVDS4	PDN_LVDS3	PDN_LVDS2	PDN_LVDS1
R/W-0h							
7	6	5	4	3	2	1	0
PDN_ANA_ ADC4	PDN_ANA_ ADC3	PDN_ANA_ ADC2	PDN_ANA_ ADC1	INVERT_ LVDS4	INVERT_ LVDS3	INVERT_ LVDS2	INVERT_ LVDS1
R/W-0h							

LEGEND: R/W = Read/Write; -n = value after reset

表 70. Register 18h Field Descriptions

	表 70. Register fon Field Descriptions								
Bit	Field	Туре	Reset	Description					
15	PDN_DIG_ADC4	R/W	0h	0 = Normal operation (default) 1 = Powers down the digital block for ADC4					
14	PDN_DIG_ADC3	R/W	0h	0 = Normal operation (default) 1 = Powers down the digital block for ADC3					
13	PDN_DIG_ADC2	R/W	0h	0 = Normal operation (default) 1 = Powers down the digital block for ADC2					
12	PDN_DIG_ADC1	R/W	0h	0 = Normal operation (default) 1 = Powers down the digital block for ADC1					
11	PDN_LVDS4	R/W	0h	0 = Normal operation (default) 1 = Powers down LVDS output line 4					
10	PDN_LVDS3	R/W	0h	0 = Normal operation (default) 1 = Powers down LVDS output line 3					
9	PDN_LVDS2	R/W	0h	0 = Normal operation (default) 1 = Powers down LVDS output line 2					
8	PDN_LVDS1	R/W	0h	0 = Normal operation (default) 1 = Powers down LVDS output line 1					
7	PDN_ANA_ADC4	R/W	0h	0 = Normal operation (default) 1 = Powers down the analog block for ADC4					
6	PDN_ANA_ADC3	R/W	0h	0 = Normal operation (default) 1 = Powers down the analog block for ADC3					
5	PDN_ANA_ADC2	R/W	0h	0 = Normal operation (default) 1 = Powers down the analog block for ADC2					
4	PDN_ANA_ADC1	R/W	0h	0 = Normal operation (default) 1 = Powers down the analog block for ADC1					
3	INVERT_LVDS4	R/W	0h	0 = Normal operation (default) 1 = Inverts ADC data sent on LVDS output line 4. Has no effect on Test patterns.					
2	INVERT_LVDS3	R/W	0h	0 = Normal operation (default) 1 = Inverts ADC data sent on LVDS output line 3. Has no effect on Test patterns.					
1	INVERT_LVDS2	R/W	0h	0 = Normal operation (default) 1 = Inverts ADC data sent on LVDS output line 2. Has no effect on Test patterns.					
0	INVERT_LVDS1	R/W	0h	0 = Normal operation (default) 1 = Inverts ADC data sent on LVDS output line 1. Has no effect on Test patterns.					



12.1.1.22 Register 19h (address = 19h)

図 118. Register 19h

15	14	13	12	11	10	9	8
	GAIN_ADC50 0 OFFSET_ADC50						
	R/W-0h R/W-0h R/W-0h						
7	6	5	4	3	2	1	0
	OFFSET_ADC50						
	R/W-0h						

LEGEND: R/W = Read/Write; -n = value after reset

表 71. Register 19h Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC50	R/W	Oh	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the odd sample of ADC5 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC50	R/W	Oh	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the odd sample of ADC5 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.

12.1.1.23 Register 1Ah (address = 1Ah)

図 119. Register 1Ah

15	14	13	12	11	10	9	8	
	GAIN_ADC5e 0 OFFSET_ADC5e							
	R/W-0h R/W-0h R/W-0h							
7	7 6 5 4 3 2						0	
	OFFSET_ADC5e							
	R/W-0h							

LEGEND: R/W = Read/Write; -n = value after reset

表 72. Register 1Ah Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC5e	R/W	0h	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the even sample of ADC5 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC5e	R/W	0h	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the even sample of ADC5 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.



12.1.1.24 Register 1Bh (address = 1Bh)

図 120. Register 1Bh

15	14	13	12	11	10	9	8	
	GAIN_ADC60 0 OFFSET_ADC60							
	R/W-0h R/W-0h							
7	6	5	4	3	2	1	0	
	OFFSET_ADC60							
	R/W-0h							

LEGEND: R/W = Read/Write; -n = value after reset

表 73. Register 1Bh Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC6o	R/W	Oh	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the odd sample of ADC6 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC60	R/W	Oh	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the odd sample of ADC6 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.

12.1.1.25 Register 1Ch (address = 1Ch)

図 121. Register 1Ch

15	14	13	12	11	10	9	8
GAIN_ADC6e 0 OFFSET_ADC6e							
	R/W-0h R/W-0h R/W-0h						
7	7 6 5 4 3 2 1 0						0
	OFFSET_ADC6e						
	R/W-0h						

LEGEND: R/W = Read/Write; -n = value after reset

表 74. Register 1Ch Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC6e	R/W	0h	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the even sample of ADC6 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC6e	R/W	Oh	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the even sample of ADC6 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.



12.1.1.26 Register 1Dh (address = 1Dh)

図 122. Register 1Dh

15	14	13	12	11	10	9	8
GAIN_ADC70 0 OFFSET_ADC70							Γ_ADC7o
	R/W-0h R/W-0h R/W-0h						
7	6	5	4	3	2	1	0
	OFFSET_ADC7o						
	R/W-0h						

LEGEND: R/W = Read/Write; -n = value after reset

表 75. Register 1Dh Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC7o	R/W	Oh	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the odd sample of ADC7 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC70	R/W	Oh	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the odd sample of ADC7 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.

12.1.1.27 Register 1Eh (address = 1Eh)

図 123. Register 1Eh

15	14	13	12	11	10	9	8
GAIN_ADC7e 0 OFFSET_ADC7e							_ADC7e
	R/W-0h R/W-0h R/W-0h						
7	6	5	4	3	2	1	0
	OFFSET_ADC7e						
	R/W-0h						

LEGEND: R/W = Read/Write; -n = value after reset

表 76. Register 1Eh Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC7e	R/W	0h	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the even sample of ADC7 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC7e	R/W	0h	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the even sample of ADC7 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.



12.1.1.28 Register 1Fh (address = 1Fh)

図 124. Register 1Fh

15	14	13	12	11	10	9	8
GAIN_ADC80 0 OFFSET_ADC80							_ADC8o
	R/W-0h R/W-0h R/W-0h						
7	6	5	4	3	2	1	0
	OFFSET_ADC80						
	R/W-0h						

LEGEND: R/W = Read/Write; -n = value after reset

表 77. Register 1Fh Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC80	R/W	Oh	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the odd sample of ADC8 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC80	R/W	Oh	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the odd sample of ADC8 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.

12.1.1.29 Register 20h (address = 20h)

図 125. Register 20h

15	14	13	12	11	10	9	8
GAIN_ADC8e 0 OFFSET_ADC8e							
	R/W-0h R/W-0h R/W-0h						
7	7 6 5 4 3 2 1 0						0
	OFFSET_ADC8e						
	R/W-0h						

LEGEND: R/W = Read/Write; -n = value after reset

表 78. Register 20h Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC8e	R/W	Oh	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the even sample of ADC8 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N × 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC8e	R/W	Oh	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the even sample of ADC8 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.



12.1.1.30 Register 21h (offset = 21h)

図 126. Register 21h

15	14	13	12	11	10	9	8
PAT_PRBS_ LVDS5	PAT_PRBS_ LVDS6	PAT_PRBS_ LVDS7	PAT_PRBS_ LVDS8	PAT_LVDS5		PAT_ LVDS6	
R/W-0h	R/W-0h	R/W-0h	R/W-0h		R/W-0h		R/W-0h
7	6	5	4	3	2	1	0
PAT_I	LVDS6	0		HPF_COR	NER_ADC5-8		DIG_HPF_EN_ ADC5-8
R/V	V-0h	R/W-0h		R/	/W-0h		R/W-0h

LEGEND: R/W = Read/Write; -n = value after reset

表 79. Register 21h Field Descriptions

D:4	Field	Tomas	Danet	Description
Bit	Field	Туре	Reset	Description
15	PAT_PRBS_LVDS5	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the PRBS pattern on LVDS output 5 can be enabled with this bit; see the <i>LVDS Test Pattern Mode</i> section for further details.
14	PAT_PRBS_LVDS6	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the PRBS pattern on LVDS output 6 can be enabled with this bit; see the <i>LVDS Test Pattern Mode</i> section for further details.
13	PAT_PRBS_LVDS7	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the PRBS pattern on LVDS output 7 can be enabled with this bit; see the <i>LVDS Test Pattern Mode</i> section for further details.
12	PAT_PRBS_LVDS8	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the PRBS pattern on LVDS output 8 can be enabled with this bit; see the <i>LVDS Test Pattern Mode</i> section for further details.
11-9	PAT_LVDS5	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the pattern on LVDS output 5 can be programmed with these bits; see 表 33 for bit descriptions.
8-6	PAT_LVDS6	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the pattern on LVDS output 6 can be programmed with these bits; see 表 33 for bit descriptions.
5	0	R/W	0h	Must write 0
4-1	HPF_CORNER_ADC5-8	R/W	Oh	When the DIG_HPF_EN_ADC5-8 bit is set to 1, the digital HPF characteristic for the corresponding ADCs can be programmed by setting the value of k with these bits. The value of k can be from 2 to 10 (0010b to 1010b); see the Digital HPF section for further details.
0	DIG_HPF_EN_ADC5-8	R/W	0h	0 = Digital HPF disabled for ADCs 5 to 8 (default) 1 = Enables digital HPF for ADCs 5 to 8



12.1.1.31 Register 23h (register = 23h)

図 127. Register 23h

15	14	13	12	11	10	9	8
0	0	0	0	IN_16CH_ ADC5	IN_16CH_ ADC6	IN_16CH_ ADC7	IN_16CH_ ADC8
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h
7	6	5	4	3	2	1	0
	PAT_LVDS7			PAT_LVDS8		0	0
	R/W-0h			R/W-0h		R/W-0h	R/W-0h

LEGEND: R/W = Read/Write; -n = value after reset

表 80. Register 23h Field Descriptions

Bit	Field	Туре	Reset	Description
15-12	0	R/W	0h	Must write 0
11	IN_16CH_ADC5	R/W	0h	Selects the input pair sampled by ADC5 in 16-input mode. 0 = ADC5 samples the signal on INP9, INM9 1 = ADC5 samples the signal on INP10, INM10
10	IN_16CH_ADC6	R/W	0h	Selects the input pair sampled by ADC6 in 16-input mode. 0 = ADC6 samples the signal on INP11, INM11 1 = ADC6 samples the signal on INP12, INM12
9	IN_16CH_ADC7	R/W	0h	Selects the input pair sampled by ADC7 in 16-input mode. 0 = ADC7 samples the signal on INP13, INM13 1 = ADC7 samples the signal on INP14, INM14
8	IN_16CH_ADC8	R/W	0h	Selects the input pair sampled by ADC8 in 16-input mode. 0 = ADC8 samples the signal on INP15, INM15 1 = ADC8 samples the signal on INP16, INM16
7-5	PAT_LVDS7	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the pattern on LVDS output 7 can be programmed with these bits; see 表 33 for bit descriptions.
4-2	PAT_LVDS8	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the pattern on LVDS output 8 can be programmed with these bits; see 表 33 for bit descriptions.
1-0	0	R/W	0h	Must write 0



12.1.1.32 Register 24h (address = 24h)

図 128. Register 24h

15	14	13	12	11	10	9	8
PDN_DIG_ ADC8	PDN_DIG_ ADC7	PDN_DIG_ ADC6	PDN_DIG_ ADC5	PDN_LVDS8	PDN_LVDS7	PDN_LVDS6	PDN_LVDS5
R/W-0h							
7	6	5	4	3	2	1	0
PDN_ANA_ ADC8	PDN_ANA_ ADC7	PDN_ANA_ ADC6	PDN_ANA_ ADC5	INVERT_ LVDS8	INVERT_ LVDS7	INVERT_ LVDS6	INVERT_ LVDS5
R/W-0h							

LEGEND: R/W = Read/Write; -n = value after reset

表 81. Register 24h Field Descriptions

Bit	Field	Туре	Reset	Description
15	PDN_DIG_ADC8	R/W	0h	0 = Normal operation (default) 1 = Powers down the digital block for ADC8
14	PDN_DIG_ADC7	R/W	0h	0 = Normal operation (default) 1 = Powers down the digital block for ADC7
13	PDN_DIG_ADC6	R/W	0h	0 = Normal operation (default)1 = Powers down the digital block for ADC6
12	PDN_DIG_ADC5	R/W	0h	0 = Normal operation (default)1 = Powers down the digital block for ADC5
11	PDN_LVDS8	R/W	0h	0 = Normal operation (default) 1 = Powers down LVDS output line 8
10	PDN_LVDS7	R/W	0h	0 = Normal operation (default) 1 = Powers down LVDS output line 7
9	PDN_LVDS6	R/W	0h	0 = Normal operation (default) 1 = Powers down LVDS output line 6
8	PDN_LVDS5	R/W	0h	0 = Normal operation (default) 1 = Powers down LVDS output line 5
7	PDN_ANA_ADC8	R/W	0h	0 = Normal operation (default) 1 = Powers down the analog block for ADC8
6	PDN_ANA_ADC7	R/W	0h	0 = Normal operation (default) 1 = Powers down the analog block for ADC7
5	PDN_ANA_ADC6	R/W	0h	0 = Normal operation (default) 1 = Powers down the analog block for ADC6
4	PDN_ANA_ADC5	R/W	0h	0 = Normal operation (default) 1 = Powers down the analog block for ADC5
3	INVERT_LVDS8	R/W	0h	0 = Normal operation (default) 1 = Inverts ADC data sent on LVDS output line 8. Has no effect on Test patterns.
2	INVERT_LVDS7	R/W	0h	0 = Normal operation (default) 1 = Inverts ADC data sent on LVDS output line 7. Has no effect on Test patterns.
1	INVERT_LVDS6	R/W	Oh	0 = Normal operation (default) 1 = Inverts ADC data sent on LVDS output line 6. Has no effect on Test patterns.
0	INVERT_LVDS5	R/W	0h	0 = Normal operation (default) 1 = Inverts ADC data sent on LVDS output line 5. Has no effect on Test patterns.



12.1.1.33 Register 25h (address = 25h)

図 129. Register 25h

15	14	13	12	11	10	9	8
GAIN_ADC9o 0 OFFSET_ADC9o							Γ_ADC9o
	R/W-0h R/W-0h R/W-0h						
7	6	5	4	3	2	1	0
	OFFSET_ADC9o						
R/W-0h							

LEGEND: R/W = Read/Write; -n = value after reset

表 82. Register 25h Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC9o	R/W	0h	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the odd sample of ADC9 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC9o	R/W	Oh	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the odd sample of ADC9 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.

12.1.1.34 Register 26h (address = 26h)

図 130. Register 26h

15	14	13	12	11	10	9	8	
	GAIN_ADC9e 0 OFFSET_ADC9e							
	R/W-0h R/W-0h							
7	7 6 5 4 3					1	0	
	OFFSET_ADC9e							
	R/W-0h							

LEGEND: R/W = Read/Write; -n = value after reset

表 83. Register 26h Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC9e	R/W	0h	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the even sample of ADC9 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC9e	R/W	0h	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the even sample of ADC9 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.



12.1.1.35 Register 27h (address = 27h)

図 131. Register 27h

15	14	13	12	11	10	9	8
GAIN_ADC100 0 OFFSET_ADC100							_ADC10o
	R/W-0h R/W-0h R/W-0h						
7	6	5	4	3	2	1	0
	OFFSET_ADC10o						
R/W-0h							

LEGEND: R/W = Read/Write; -n = value after reset

表 84. Register 27h Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC10o	R/W	0h	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the odd sample of ADC10 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC10o	R/W	0h	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the odd sample of ADC10 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.

12.1.1.36 Register 28h (address = 28h)

図 132. Register 28h

15	14	13	12	11	10	9	8
GAIN_ADC10e 0 OFFSE							_ADC10e
R/W-0h R/W-0h R/W-0h							V-0h
7	6	5	4	3	2	1	0
	OFFSET_ADC10e						
	R/W-0h						

LEGEND: R/W = Read/Write; -n = value after reset

表 85. Register 28h Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC10e	R/W	0h	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the even sample of ADC10 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC10e	R/W	Oh	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the even sample of ADC10 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.



12.1.1.37 Register 29h (address = 29h)

図 133. Register 29h

15	14	13	12	11	10	9	8
	GAIN_ADC110 0 OFFSET_ADC110						
	R/W-0h R/W-0h R/W-0h						
7	6	5	4	3	2	1	0
	OFFSET_ADC110						
R/W-0h							

LEGEND: R/W = Read/Write; -n = value after reset

表 86. Register 29h Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC11o	R/W	Oh	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the odd sample of ADC11 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC110	R/W	Oh	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the odd sample of ADC11 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.

12.1.1.38 Register 2Ah (address = 2Ah)

図 134. Register 2Ah

15	14	13	12	11	10	9	8
	GAIN_ADC11e 0						_ADC11e
R/W-0h R/W-0h						V-0h	
7	6	5	4	3	2	1	0
	OFFSET_ADC11e						
	R/W-0h						

LEGEND: R/W = Read/Write; -n = value after reset

表 87. Register 2Ah Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC11e	R/W	0h	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the even sample of ADC11 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC11e	R/W	Oh	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the even sample of ADC11 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.



12.1.1.39 Register 2Bh (address = 2Bh)

図 135. Register 2Bh

15	14	13	12	11	10	9	8
	GAIN_ADC120 0 OFFSET_ADC120						
		R/W-0h			R/W-0h	R/V	V-0h
7	6	5	4	3	2	1	0
	OFFSET_ADC12o						
	R/W-0h						

LEGEND: R/W = Read/Write; -n = value after reset

表 88. Register 2Bh Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC12o	R/W	0h	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the odd sample of ADC12 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC120	R/W	0h	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the odd sample of ADC12 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.

12.1.1.40 Register 2Ch (address = 2Ch)

図 136. Register 2Ch

15	14	13	12	11	10	9	8
		GAIN_ADC12e	0	OFFSET	_ADC12e		
	R/W-0h R/W-0h R/W-0h						V-0h
7	6	5	4	3	2	1	0
	OFFSET_ADC12e						
	R/W-0h						

LEGEND: R/W = Read/Write; -n = value after reset

表 89. Register 2Ch Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC12e	R/W	0h	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the even sample of ADC12 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC12e	R/W	Oh	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the even sample of ADC12 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.



12.1.1.41 Register 2Dh (address = 2Dh)

図 137. Register 2Dh

15	14	13	12	11	10	9	8
PAT_PRBS_ LVDS9	PAT_PRBS_ LVDS10	PAT_PRBS_ LVDS11	PAT_PRBS_ LVDS12		PAT_LVDS9		PAT_ LVDS10
R/W-0h	R/W-0h	R/W-0h	R/W-0h		R/W-0h		R/W-0h
7	6	5	4	3	2	1	0
PAT_L	VDS10	HPF_ROUND_ EN_CH9-16		HPF_CORM	NER_ADC9-12		DIG_HPF_EN_ ADC9-12
R/V	V-0h	R/W-0h		R/	W-0h		R/W-0h

LEGEND: R/W = Read/Write; -n = value after reset

表 90. Register 2Dh Field Descriptions

	2 00. Register 2511 Feld 5000 liptions							
Bit	Field	Туре	Reset	Description				
15	PAT_PRBS_LVDS9	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the PRBS pattern on LVDS output 9 can be enabled with this bit; see the <i>LVDS Test Pattern Mode</i> section for further details.				
14	PAT_PRBS_LVDS10	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the PRBS pattern on LVDS output 10 can be enabled with this bit; see the LVDS Test Pattern Mode section for further details.				
13	PAT_PRBS_LVDS11	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the PRBS pattern on LVDS output 11 can be enabled with this bit; see the LVDS Test Pattern Mode section for further details.				
12	PAT_PRBS_LVDS12	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the PRBS pattern on LVDS output 12 can be enabled with this bit; see the LVDS Test Pattern Mode section for further details.				
11-9	PAT_LVDS9	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the pattern on LVDS output 9 can be programmed with these bits; see表 33 for bit descriptions.				
8-6	PAT_LVDS10	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the pattern on LVDS output 10 can be programmed with these bits; see表 33 for bit descriptions.				
5	HPF_ROUND_EN_CH9-16	R/W	Oh	 0 = Rounding in the ADC HPF is disabled for channels 9-16. The HPF output is truncated to be mapped to the ADC resolution bits. 1 = HPF output of channels 9-16 is mapped to the ADC resolution bits by the round-off operation. 				
4-1	HPF_CORNER_ADC9-12	R/W	Oh	When the DIG_HPF_EN_CH9-12 bit is set to 1, the digital HPF characteristic for the corresponding ADCs can be programmed by setting the value of k with these bits. The value of k can be from 2 to 10 (0010b to 1010b); see the Digital HPF section for further details.				
0	DIG_HPF_EN_ADC9-12	R/W	0h	0 = Digital HPF disabled for ADCs 9 to 12 (default) 1 = Enables digital HPF for ADCs 9 to 12				



12.1.1.42 Register 2Fh (address = 2Fh)

図 138. Register 2Fh

15	14	13	12	11	10	9	8
0	0	0	0	IN_16CH_ ADC9	IN_16CH_ ADC10	IN_16CH_ ADC11	IN_16CH_ ADC12
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h
7	6	5	4	3	2	1	0
	PAT_LVDS11			PAT_LVDS12		0	0
	R/W-0h			R/W-0h		R/W-0h	R/W-0h

LEGEND: R/W = Read/Write;-n = value after reset

表 91. Register 2Fh Field Descriptions

D:4	Et al.	T	D 1	December 1
Bit	Field	Туре	Reset	Description
15-12	0	R/W	0h	Must write 0
11	IN_16CH_ADC9	R/W	Oh	Selects the input pair sampled by ADC9 in 16-input mode. 0 = ADC9 samples the signal on INP17, INM17 1 = ADC9 samples the signal on INP18, INM18
10	IN_16CH_ADC10	R/W	0h	Selects the input pair sampled by ADC10 in 16-input mode. 0 = ADC10 samples the signal on INP19, INM19 1 = ADC10 samples the signal on INP20, INM20
9	IN_16CH_ADC11	R/W	0h	Selects the input pair sampled by ADC11 in 16-input mode. 0 = ADC11 samples the signal on INP21, INM21 1 = ADC11 samples the signal on INP22, INM22
8	IN_16CH_ADC12	R/W	0h	Selects the input pair sampled by ADC12 in 16-input mode. 0 = ADC12 samples the signal on INP23, INM23 1 = ADC12 samples the signal on INP24, INM24
7-5	PAT_LVDS11[2:0]	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the pattern on LVDS output 11 can be programmed with these bits; see表 33 for bit descriptions.
4-2	PAT_LVDS12[2:0]	R/W	Oh	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the pattern on LVDS output 12 can be programmed with these bits; see表 33 for bit descriptions.
1-0	0	R/W	0h	Must write 0



12.1.1.43 Register 30h (address = 30h)

図 139. Register 30h

15	14	13	12	11	10	9	8
PDN_DIG_ ADC12	PDN_DIG_ ADC11	PDN_DIG_ ADC10	PDN_DIG_ ADC9	PDN_ LVDS12	PDN_ LVDS11	PDN_ LVDS10	PDN_ LVDS9
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h
7	6	5	4	3	2	1	0
PDN_ANA_ ADC12	PDN_ANA_ ADC11	PDN_ANA_ ADC10	PDN_ANA_ ADC9	INVERT_ LVDS12	INVERT_ LVDS11	INVERT_ LVDS10	INVERT_ LVDS9
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h

LEGEND: R/W = Read/Write; W = Write only; = value after reset

表 92. Register 30h Field Descriptions

	表 92. Register 30ff Field Descriptions							
Bit	Field	Туре	Reset	Description				
15	PDN_DIG_ADC12	R/W	0h	0 = Normal operation (default) 1 = Powers down the digital block for ADC12				
14	PDN_DIG_ADC11	R/W	0h	0 = Normal operation (default) 1 = Powers down the digital block for ADC11				
13	PDN_DIG_ADC10	R/W	0h	0 = Normal operation (default) 1 = Powers down the digital block for ADC10				
12	PDN_DIG_ADC9	R/W	0h	0 = Normal operation (default)1 = Powers down the digital block for ADC9				
11	PDN_LVDS12	R/W	0h	0 = Normal operation (default) 1 = Powers down LVDS output line 12				
10	PDN_LVDS11	R/W	0h	0 = Normal operation (default) 1 = Powers down LVDS output line 11				
9	PDN_LVDS10	R/W	0h	0 = Normal operation (default) 1 = Powers down LVDS output line 10				
8	PDN_LVDS9	R/W	0h	0 = Normal operation (default) 1 = Powers down LVDS output line 9				
7	PDN_ANA_ADC12	R/W	0h	0 = Normal operation (default) 1 = Powers down the analog block for ADC12				
6	PDN_ANA_ADC11	R/W	0h	0 = Normal operation (default) 1 = Powers down the analog block for ADC11				
5	PDN_ANA_ADC10	R/W	0h	0 = Normal operation (default) 1 = Powers down the analog block for ADC10				
4	PDN_ANA_ADC9	R/W	0h	0 = Normal operation (default)1 = Powers down the analog block for ADC9				
3	INVERT_LVDS12	R/W	0h	0 = Normal operation (default)1 = Inverts ADC data sent on LVDS output line 12. Has no effect on Test patterns.				
2	INVERT_LVDS11	R/W	0h	0 = Normal operation (default) 1 = Inverts ADC data sent on LVDS output line 11. Has no effect on Test patterns.				
1	INVERT_LVDS10	R/W	0h	0 = Normal operation (default) 1 = Inverts ADC data sent on LVDS output line 10. Has no effect on Test patterns.				
0	INVERT_LVDS9	R/W	0h	0 = Normal operation (default) 1 = Inverts ADC data sent on LVDS output line 9. Has no effect on Test patterns.				



12.1.1.44 Register 31h (address = 31h)

図 140. Register 31h

15	14	13	12	11	10	9	8
GAIN_ADC130 0 OFFSET_ADC130							_ADC13o
R/W-0h R/W-0h							V-0h
7	6	5	4	3	2	1	0
OFFSET_ADC130							
	R/W-0h						

LEGEND: R/W = Read/Write; -n = value after reset

表 93. Register 31h Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC13o	R/W	Oh	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the odd sample of ADC13 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC130	R/W	Oh	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the odd sample of ADC13 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.

12.1.1.45 Register 32h (address = 32h)

図 141. Register 32h

15	14	13	12	11	10	9	8
GAIN_ADC13e 0 OFFSET_ADC13e							_ADC13e
R/W-0h R/W-0h							V-0h
7	6	5	4	3	2	1	0
OFFSET_ADC13e							
	R/W-0h						

LEGEND: R/W = Read/Write; -n = value after reset

表 94. Register 32h Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC13e	R/W	0h	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the even sample of ADC13 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC13e	R/W	Oh	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the even sample of ADC13 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.



12.1.1.46 Register 33h (address = 33h)

図 142. Register 33h

15	14	13	12	11	10	9	8
GAIN_ADC140 0 OFFSET_ADC140							_ADC14o
R/W-0h R/W-0h R/W-0h							V-0h
7	6	5	4	3	2	1	0
	OFFSET_ADC140						
	R/W-0h						

LEGEND: R/W = Read/Write; -n = value after reset

表 95. Register 33h Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC14o	R/W	0h	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the odd sample of ADC14 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC140	R/W	Oh	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the odd sample of ADC14 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.

12.1.1.47 Register 34h (address = 34h)

図 143. Register 34h

15	14	13	12	11	10	9	8
GAIN_ADC14e 0 OFFSET_ADC14e							_ADC14e
R/W-0h R/W-0h R/W-0h							V-0h
7	6	5	4	3	2	1	0
OFFSET_ADC14e							
	R/W-0h						

LEGEND: R/W = Read/Write; -n = value after reset

表 96. Register 34h Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC14e	R/W	0h	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the even sample of ADC14 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC14e	R/W	Oh	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the even sample of ADC14 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.



12.1.1.48 Register 35h (address = 35h)

図 144. Register 35h

15	14	13	12	11	10	9	8
GAIN_ADC150 0 OFFSET_ADC150							_ADC15o
R/W-0h R/W-0h R/W-0h							V-0h
7	6	5	4	3	2	1	0
OFFSET_ADC150							
R/W-0h							

LEGEND: R/W = Read/Write; -n = value after reset

表 97. Register 35h Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC15o	R/W	0h	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the odd sample of ADC15 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC150	R/W	0h	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the odd sample of ADC15 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.

12.1.1.49 Register 36h (address = 36h)

図 145. Register 36h

15	14	13	12	11	10	9	8
GAIN_ADC15e 0 OFFSET_ADC15e							_ADC15e
	R/W-0h R/W-0h R/W-0h						
7	7 6 5 4 3 2 1 0						0
	OFFSET_ADC15e						
	R/W-0h						

LEGEND: R/W = Read/Write; -n = value after reset

表 98. Register 36h Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC15e	R/W	0h	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the even sample of ADC15 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N × 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC15e	R/W	Oh	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the even sample of ADC15 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.



12.1.1.50 Register 37h (address = 37h)

図 146. Register 37h

15	14	13	12	11	10	9	8
	GAIN_ADC160 0 OFFSET_ADC160						
	R/W-0h R/W-0h R/W-0h						
7	7 6 5 4 3 2					1	0
	OFFSET_ADC160						
R/W-0h							

LEGEND: R/W = Read/Write; -n = value after reset

表 99. Register 37h Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC16o	R/W	Oh	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the odd sample of ADC16 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC160	R/W	Oh	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the odd sample of ADC16 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.

12.1.1.51 Register 38h (address = 38h)

図 147. Register 38h

15	14	13	12	11	10	9	8
GAIN_ADC16e 0 OFFSET_ADC16e							_ADC16e
R/W-0h R/W-0h							V-0h
7	7 6 5 4 3 2 1 0						0
	OFFSET_ADC16e						
	R/W-0h						

LEGEND: R/W = Read/Write; -n = value after reset

表 100. Register 38h Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	GAIN_ADC16e	R/W	0h	When the DIG_GAIN_EN bit (register 3, bit 12) is set to 1, the digital gain value for the even sample of ADC16 can be obtained with this register. For a value of N (decimal equivalent of binary) written to these bits, the digital gain gets set to N \times 0.2 dB.
10	0	R/W	0h	Must write 0
9-0	OFFSET_ADC16e	R/W	Oh	When the DIG_OFFSET_EN bit (register 3, bit 8) is set to 1, the offset value to be subtracted from the even sample of ADC16 can be obtained with this 10-bit register. The offset value is in twos complement format and its LSB corresponds to a 14-bit LSB.

TEXAS INSTRUMENTS

12.1.1.52 Register 39h (address = 39h)

図 148. Register 39h

15	14	13	12	11	10	9	8
PAT_PRBS_ LVDS13	PAT_PRBS_ LVDS14	PAT_PRBS_ LVDS15	PAT_PRBS_ LVDS16		PAT_LVDS13		PAT_LVDS14
R/W-0h	R/W-0h	R/W-0h	R/W-0h		R/W-0h		R/W-0h
7	6	5	4	3	2	1	0
PAT_L	VDS14	0		HPF_CORN	NER_ADC13-16		DIG_HPF_EN_ ADC13-16
R/W	V-0h	R/W-0h		R	/W-0h		R/W-0h

LEGEND: R/W = Read/Write; -n = value after reset

表 101. Register 39h Field Descriptions

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Bit	Field	Type	Reset	Description
15	PAT_PRBS_LVDS13	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the PRBS pattern on LVDS output 13 can be enabled with this bit; see the LVDS Test Pattern Mode section for further details.
14	PAT_PRBS_LVDS14	R/W	Oh	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the PRBS pattern on LVDS output 14 can be enabled with this bit; see the LVDS Test Pattern Mode section for further details.
13	PAT_PRBS_LVDS15	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the PRBS pattern on LVDS output 15 can be enabled with this bit; see the LVDS Test Pattern Mode section for further details.
12	PAT_PRBS_LVDS16	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the PRBS pattern on LVDS output 16 can be enabled with this bit; see the LVDS Test Pattern Mode section for further details.
11-9	PAT_LVDS13[2:0]	R/W	Oh	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the pattern on LVDS output 13 can be programmed with these bits; see 表 33 for bit descriptions.
8-6	PAT_LVDS14[2:0]	R/W	Oh	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the pattern on LVDS output 14 can be programmed with these bits; see 表 33 for bit descriptions.
5	0	R/W	0h	Must write 0
4-1	HPF_CORNER_ADC13-16	R/W	Oh	When the DIG_HPF_EN_CH13-16 bit is set to 1, the digital HPF characteristic for the corresponding ADCs can be programmed by setting the value of k with these bits. The value of k can be from 2 to 10 (0010b to 1010b); see the Digital HPF section for further details.
0	DIG_HPF_EN_ADC13-16	R/W	0h	0 = Digital HPF disabled for ADCs 13 to 16 (default) 1 = Enables digital HPF for ADCs 13 to 16



12.1.1.53 Register 3Bh (address = 3Bh)

図 149. Register 3Bh

15	14	13	12	11	10	9	8
0	0	0	0	IN_16CH_ ADC13	IN_16CH_ ADC14	IN_16CH_ ADC15	IN_16CH_ ADC16
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h
7	6	5	4	3	2	1	0
	PAT_LVDS15			PAT_LVDS16		0	0
	R/W-0h			R/W-0h	·	R/W-0h	R/W-0h

LEGEND: R/W = Read/Write; -n = value after reset

表 102. Register 3Bh Field Descriptions

Bit	Field	Туре	Reset	Description
15-12	0	R/W	0h	Must write 0
11	IN_16CH_ADC13	R/W	0h	Selects the input pair sampled by ADC13 in 16-input mode. 0 = ADC13 samples the signal on INP25, INM25 1 = ADC13 samples the signal on INP26, INM26
10	IN_16CH_ADC14	R/W	0h	Selects the input pair sampled by ADC14 in 16-input mode. 0 = ADC14 samples the signal on INP27, INM27 1 = ADC14 samples the signal on INP28, INM28
9	IN_16CH_ADC15	R/W	0h	Selects the input pair sampled by ADC15 in 16-input mode. 0 = ADC15 samples the signal on INP29, INM29 1 = ADC15 samples the signal on INP30, INM30
8	IN_16CH_ADC16	R/W	0h	Selects the input pair sampled by ADC16 in 16-input mode. 0 = ADC16 samples the signal on INP31, INM31 1 = ADC16 samples the signal on INP32, INM32
7-5	PAT_LVDS15[2:0]	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the pattern on LVDS output 15 can be programmed with these bits; see 表 33 for bit descriptions.
4-2	PAT_LVDS16[2:0]	R/W	0h	When the PAT_SELECT_IND bit (register 4, bit 8) is set to 1, the pattern on LVDS output 16 can be programmed with these bits; see 表 33 for bit descriptions.
1-0	0	R/W	0h	Must write 0



12.1.1.54 Register 3Ch (address = 3Ch)

図 150. Register 3Ch

15	14	13	12	11	10	9	8
PDN_DIG_ ADC16	PDN_DIG_ ADC15	PDN_DIG_ ADC14	PDN_DIG_	PDN_LVDS16	PDN_LVDS15	PDN_LVDS14	PDN_LVDS13
R/W-0h							
7	6	5	4	3	2	1	0
PDN_ANA_ ADC16	PDN_ANA_ ADC15	PDN_ANA_ ADC14	PDN_ANA_ ADC13	INVERT_ LVDS16	INVERT_ LVDS15	INVERT_ LVDS14	INVERT_ LVDS13
R/W-0h							

LEGEND: R/W = Read/Write; -n = value after reset

表 103. Register 3Ch Field Descriptions

	表 103. Register 3Ch Field Descriptions								
Bit	Field	Туре	Reset	Description					
15	PDN_DIG_ADC16	R/W	0h	0 = Normal operation (default) 1 = Powers down the digital block for ADC16					
14	PDN_DIG_ADC15	R/W	0h	0 = Normal operation (default) 1 = Powers down the digital block for ADC15					
13	PDN_DIG_ADC14	R/W	0h	0 = Normal operation (default) 1 = Powers down the digital block for ADC14					
12	PDN_DIG_ADC13	R/W	0h	0 = Normal operation (default) 1 = Powers down the digital block for ADC13					
11	PDN_LVDS16	R/W	0h	0 = Normal operation (default) 1 = Powers down LVDS output line 16					
10	PDN_LVDS15	R/W	0h	0 = Normal operation (default) 1 = Powers down LVDS output line 15					
9	PDN_LVDS14	R/W	0h	0 = Normal operation (default) 1 = Powers down LVDS output line 14					
8	PDN_LVDS13	R/W	0h	0 = Normal operation (default) 1 = Powers down LVDS output line 13					
7	PDN_ANA_ADC16	R/W	0h	0 = Normal operation (default) 1 = Powers down the analog block for ADC16					
6	PDN_ANA_ADC15	R/W	0h	0 = Normal operation (default) 1 = Powers down the analog block for ADC15					
5	PDN_ANA_ADC14	R/W	0h	0 = Normal operation (default) 1 = Powers down the analog block for ADC14					
4	PDN_ANA_ADC13	R/W	0h	0 = Normal operation (default) 1 = Powers down the analog block for ADC13					
3	INVERT_LVDS16	R/W	0h	0 = Normal operation (default) 1 = Inverts ADC data sent on LVDS output line 16. Has no effect on Test patterns.					
2	INVERT_LVDS15	R/W	0h	0 = Normal operation (default) 1 = Inverts ADC data sent on LVDS output line 15. Has no effect on Test patterns.					
1	INVERT_LVDS14	R/W	0h	0 = Normal operation (default) 1 = Inverts ADC data sent on LVDS output line 14. Has no effect on Test patterns.					
0	INVERT_LVDS13	R/W	0h	0 = Normal operation (default) 1 = Inverts ADC data sent on LVDS output line 13. Has no effect on Test patterns.					



12.1.1.55 Register 43h (address = 43h)

図 151. Register 43h

15	14	13	12	11	10	9	8
0	0	0	0	0	0	0	0
R/W-0h							
7	6	5	4	3	2	1	0
0	0	0		0			
R/W-0h	R/W-0h	R/W-0h	·	R/W	/-0h	·-	R/W-0h

LEGEND: R/W = Read/Write; -n = value after reset

表 104. Register 43h Field Descriptions

Bit	Field	Туре	Reset	Description
15-5	0	R/W	0h	Must write 0
4-1	LVDS_DCLK_DELAY_PROG	R/W	Oh	The LVDS DCLK output delay is programmable with 110-ps steps. Delay values are in twos complement format. Increasing the positive delay increases setup time and reduces hold time, and vice-versa for the negative delay. 0000 = No delay 0001 = 110 ps 0010 = 220 ps 1110 = -220 ps 1111 = -110ps
0	0	R/W	0h	Must write 0

Texas Instruments

12.2 JESD Serial Interface Registers

This section discusses the JESD registers. A register map is available in 表 105.

表 105. JESD Register Map

REGIST ADDRE									REGISTE	R DATA ⁽¹⁾							
DECIMAL	HEX	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
70	46	0	0	0	0	0	0	0	0	0	0	0	0	0	MASK_TX_ TRIG	JESD_ RESET1	0
73	49	IDLE_ MODE	0	0	LANE_ ALIGN	FRAME_ ALIGN	LINK_ CONFIG_ DIS	0	0	0	0	0	0	0	FORCE_K	0	0
74	4A	LINK_I	_AYER_TESTI	MODES	TX_SYNC_ REQ	RELEA	SE_ILA	0	JESD_RES ET2	JESD_RES ET3	0	0	0	0	0	0	0
75	4B	0	0	0	0	0	0	0	SING_ CONV_ PER_OCT	NUM	/I_ADC_PER_I	LANE	0	0	0	0	0
77	4D	0	0	0	0	0 0 0 0 0			0		PRE	_EMP		0	0	0	0
80	50	0	0	0	0	0	0	0	0	0	0	0	0	0	0	INC_ JESD_ VDD	0
81	51				DEVICE_ID			0	0	0			BANK_ID	,			
82	52	0	0	0	0	0	0	0	0	SCR_EN	0	0	0	0	0	0	0
83	53	0	0	0	0	0	0	0	0	0	0 0 0 K_VALUE_TO_FORCE						
85	55	JE	SD_SUBCLA	SS	0	0	0	0	0	JESD_VER 0			0	0	0	0	0
115 ⁽²⁾	73	EN_LANE_ ID1	EN_LANE_ ID2	EN_LANE_ ID3	EN_LANE_ ID4	EN_ CHECK SUM_ LANE1	EN_ CHECK SUM_ LANE2	EN_ CHECK SUM_ LANE3	EN_ CHECK SUM_ LANE4	0	0	0	ENABLE_ JESD_VER _CONTROL	0	0	0	0
116 ⁽²⁾	74				CHECK	_SUM1							CHECK	SUM2	1		
117 ⁽²⁾	75				CHECK	C_SUM3							CHECK	_SUM4			
118(2)	76	0	0	0			LANE_ID1			0	0	0			LANE_ID2		
119 ⁽²⁾	77	0	0	0			LANE_ID3			0	0	0			LANE_ID4		
120	78	FORCE_ LMFC_ COUNT		LMFC_C	OUNTER_INIT	_VALUE		0	0	0	0	0	0	0	0	0	0
134 ⁽²⁾	86	EN_LANE_ ID5	EN_LANE_ ID6	EN_LANE_ ID7	EN_LANE_ ID8	EN_ CHECK SUM_ LANE5	EN_ CHECK SUM_ LANE6	EN_ CHECK SUM_ LANE7	EN_ CHECK SUM_ LANE8	0	0	0	0	0	0	0	0
135 ⁽²⁾	87	CHECK_SUM5									CHECK	SUM6					
136 ⁽²⁾	88				CHECK	C_SUM7							CHECK	_SUM8			
137 ⁽²⁾	89	0	0	0			LANE_ID5			0	0	0	LANE_ID6				
138 ⁽²⁾	8A	0	0	0			LANE_ID7			0	0	0			LANE_ID8		

 ⁽¹⁾ Default value of all registers is 0.
 (2) These registers must only be written to after setting the JESD_WR_SEL register bit (register 3, bit 5) to 1. To write any other registers, set the JESD_WR_SEL bit to 0.



12.2.1 Description of JESD Serial Interface Registers

12.2.1.1 Register 70 (address = 46h)

図 152. Register 70

15	14	13	12	11	10	9	8
0	0	0	0	0	0	0	0
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h
7	6	5	4	3	2	1	0
0	0	0	0	0	MASK_TX_ TRIG	JESD_RESET1	0
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h

LEGEND: R/W = Read/Write; -n = value after reset

表 106. Register 70 Field Descriptions

Bit	Field	Туре	Reset	Description
15-3	0	R/W	0h	Must write 0
2	MASK_TX_TRIG	R/W	0h	0 = TX_TRIG affects internal clock-phase resets 1 = TX_TRIG does not affect internal clock-phase resets
1	JESD_RESET1	R/W	0h	0 = SYNC~ and SYSREF events reset non-JESD blocks (such as the clock dividers, demodulator, and test pattern generator) 1 = SYNC~ and SYSREF events do not reset non-JESD blocks (such as the clock dividers, demodulator, and test pattern generator)
0	0	R/W	0h	Must write 0



12.2.1.2 Register 73 (address = 49h)

図 153. Register 73

15	14	13	12	11	10	9	8
IDLE_MODE	0	0	LANE_ALIGN	FRAME_ALIGN	LINK_CONFIG _DIS	0	0
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h
7	6	5	4	3	2	1	0
0	0	0	0	0	FORCE_K	0	0
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h

LEGEND: R/W = Read/Write; -n = value after reset

表 107. Register 73 Field Descriptions

Bit	Field	Туре	Reset	Description
15	IDLE_MODE	R/W	0h	0 = Idle mode disabled (normal operation) 1 = Device sends a continuous pattern (BC50h) on all lanes
14-13	0	R/W	0h	Must write 0
12	LANE_ALIGN	R/W	Oh	0 = Character replacement disabled. Data are sent without inserting a lane alignment control character. 1 = If the last octet of the multiframe is the same as the last octet of the previous multiframe, then the last octet is replaced with a /K28.3/ character that can be used by the receiver for lane alignment monitoring and correction; see the JESD204B document., section 5.3.3.4 for details.
11	FRAME_ALIGN	R/W	Oh	0 = Character replacement is disabled. Data are sent without inserting a frame alignment control character. 1 = If the last octet of the frame is the same as the last octet of the previous frame, then the octet is replaced with /K28.7/. Character replacement is not performed if a control character was already sent in the previous frame; see the JESD204B document., section 5.3.3.4 for details.
10	LINK_CONFIG_DIS	R/W	0h	0 = ILA transmission enabled. The initial lane alignment data are sent, as per section 5.3.3.5 and 8.3 of the JESD204B document. 1 = ILA transmission disabled. The device starts sending payload data immediately after the code group synchronization.
9-3	0	R/W	0h	Must write 0
2	FORCE_K	R/W	Oh	0 = Value of K (number of frames per multiframe) minus 1 is automatically calculated and set 1 = Value of K (number of frames per multiframe) minus 1 is set by the K_VALUE_TO_FORCE register setting
1-0	0	R/W	0h	Must write 0



12.2.1.3 Register 74 (address = 4Ah)

図 154. Register 74

15	14	13	12	11	10	9	8
LINK_	_LAYER_TESTM(ODES	TX_SYNC_ REQ	RELEA	SE_ILA	0	JESD_RESET2
R/W-0h			R/W-0h	R/W	/-0h	R/W-0h	R/W-0h
7	6	5	4	3	2	1	0
JESD_RESET3	0	0	0	0	0	0	0
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h

LEGEND: R/W = Read/Write; -n = value after reset

表 108. Register 74 Field Descriptions

Bit	Field	Tuna	Reset	Description
	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	Туре		Description
15-13	LINK_LAYER_TESTMODES	R/W	Oh	000 = Normal operation 001 = D21.5 (1010101010) is transmitted on all lanes 010 = /K28.5/ is transmitted on all lanes 011 = ILA sequence is continuously transmitted on all lanes 100 = Pseudo-random pattern of 120 bits is transmitted on all lanes All other combinations are invalid.
12	TX_SYNC_REQ	R/W	Oh	0 = Sync reinitialization request disabled (normal operation) 1 = A stream of /K28.5/ symbols are transmitted, requesting link reinitialization. After transmission, the /K28.5/ characters enter into a link initialization state; see section 5.3.3.7 of the JESD204B document for further details.
11-10	RELEASE_ILA	R/W	Oh	000 = Default value The value of this register determines the LMFC edge that the transmitter enters in the ILA phase from the code group synchronization. This setting is useful for adjusting the deterministic latency value; see the <i>Data Link Layer</i> section.
9	0	R/W	0h	Must write 0
8	JESD_RESET2	R/W	Oh	0 = SYNC~ and SYSREF events reset the phase of JESD and non-JESD blocks (demodulator, test pattern generator, and clock dividers) 1 = SYNC~ and SYSREF events do not reset the phase of JESD block and clock dividers but do reset the phase of the demodulator and test pattern generator
7	JESD_RESET3	R/W	Oh	0 = SYNC~ and SYSREF events reset the phase of JESD and non-JESD blocks (demodulator, test pattern generator, and clock dividers) 1 = Immediately after setting this bit to 1, the first SYNC~ and SYSREF event resets the phase of the JESD and non-JESD blocks. Subsequent SYNC~ and SYSREF events do not reset the phase of the JESD block and clock dividers but do reset the phase of the demodulator and test pattern generator.
6-0	0	R/W	0h	Must write 0



12.2.1.4 Register 75 (address = 4Bh)

図 155. Register 75

15	14	13	12	11	10	9	8
0	0	0	0	0	0	0	SING_CONV_ PER_OCT
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h
7	6	5	4	3	2	1	0
NUM_ADC_PER_LANE			0	0	0	0	0
	R/W-0h		R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h

LEGEND: R/W = Read/Write; -n = value after reset

表 109. Register 75 Field Descriptions

Bit	Field	Туре	Reset	Description
15-9	0	R/W	0h	Must write 0
8	SING_CONV_PER_OCT	R/W	0h	0 = Data are packed efficiently and transmitted over the link 1 = Each ADC data are packed in two octets [that is, each ADC data are transmitted as 16 bits (12-, 14-, and 16-bit mode) by the appropriate zero padding]; see the <i>User Data Format</i> section for further details.
7-5	NUM_ADC_PER_LANE	R/W	Oh	000 = Four ADCs per lane mode: data from four ADCs are packed into a lane. Four lanes are active and four lanes are powered down. 001 = Eight ADCs per lane mode: data from eight ADCs are packed into a lane. Two lanes are active and six lanes are powered down. 100 = Two ADCs per lane mode: data from two ADCs are packed into a lane. All eight lanes are active. All other settings are invalid.
4-0	0	R/W	0h	Must write 0



12.2.1.5 Register 77 (address = 4Dh)

図 156. Register 77

15	14	13	12	11	10	9	8
0	0	0	0	0	0	0	0
R/W-0h							
7	6	5	4	3	2	1	0
	PRE_	_EMP		0	0	0	0
	R/W	/-0h	·	R/W-0h	R/W-0h	R/W-0h	R/W-0h

LEGEND: R/W = Read/Write; -n = value after reset

表 110. Register 77 Field Descriptions

Bit	Field	Туре	Reset	Description
15-8	0	R/W	0h	Must write 0
7-4	PRE_EMP	R/W	Oh	The extra current during pre-emphasis is equal to the decimal equivalent of the programmed value multiplied by 0.25 mA. A value corresponding to 0 refers to no pre-emphasis.
3-0	0	R/W	0h	Must write 0

12.2.1.6 Register 80 (address = 50h)

図 157. Register 80

15	14	13	12	11	10	9	8
0	0	0	0	0	0	0	0
R/W-0h	R/W-0h						
7	6	5	4	3	2	1	0
0	0	0	0	0	0	INC_JESD_ VDD	0
R/W-0h	R/W-0h						

LEGEND: R/W = Read/Write; -n = value after reset

表 111. Register 80 Field Descriptions

Bit	Field	Туре	Reset	Description
15-2	0	R/W	0h	Must write 0
1	INC_JESD_VDD	R/W	0h	0 = Default value for the internal LDO driving the JESD PLL 1 = Increased value for the internal LDO driving the JESD PLL
0	0	R/W	0h	Must write 0



12.2.1.7 Register 81 (address = 51h)

図 158. Register 81

15	14	13	12	11	10	9	8		
DEVICE_ID									
	R/W-0h								
7	6	5	4	3	2	1	0		
0	0 0 0 BANK_ID								
R/W-0h	R/W-0h	R/W-0h			R/W-0h				

LEGEND: R/W = Read/Write; -n = value after reset

表 112. Register 81 Field Descriptions

Bit	Field	Туре	Reset	Description
15-8	DEVICE_ID	R/W	0h	These bits force the device ID value.
7-5	0	R/W	0h	Must write 0
4-0	BANK_ID	R/W	0h	These bits force the bank ID value.

12.2.1.8 Register 82 (address = 52h)

図 159. Register 82

15	14	13	12	11	10	9	8
0	0	0	0	0	0	0	0
R/W-0h							
7	6	5	4	3	2	1	0
SCR_EN	0	0	0	0	0	0	0
R/W-0h							

LEGEND: R/W = Read/Write; -n = value after reset

表 113. Register 82 Field Descriptions

Bit	Field	Туре	Reset	Description
15-8	0	R/W	0h	Must write 0
7	SCR_EN	R/W	0h	0 = Scrambler disabled 1 = Scrambler enabled; see the <i>Scrambler</i> section for further details
6-0	0	R/W	0h	Must write 0



12.2.1.9 Register 83 (address = 53h)

図 160. Register 83

15	14	13	12	11	10	9	8
0	0	0	0	0	0	0	0
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h
7	6	5	4	3	2	1	0
0	0	0		K_	VALUE_TO_FOR	CE	
R/W-0h	R/W-0h	R/W-0h			R/W-0h		

LEGEND: R/W = Read/Write; -n = value after reset

表 114. Register 83 Field Descriptions

Bit	Field	Туре	Reset	Description
15-5	0	R/W	0h	Must write 0
4-0	K_VALUE_TO_FORCE	R/W	0h	Specifies the value of K (number of frames per multiframe) minus 1 to be forced when the FORCE_K bit is set to 1.

12.2.1.10 Register 85 (address = 55h)

図 161. Register 85

15	14	13	12	11	10	9	8
	JESD_SUBCLASS		0	0	0	0	0
	R/W-0h		R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h
7	6	5	4	3	2	1	0
	JESD_VER		0	0	0	0	0
	R/W-0h		R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h

LEGEND: R/W = Read/Write; -n = value after reset

表 115. Register 85 Field Descriptions

Bit	Field	Туре	Reset	Description
15-13	JESD_SUBCLASS	R/W	Oh	000 = Subclass 0 001 = Subclass 1 010 = subclass 2 See the JESD Version and Subclass section for further details.
12-8	0	R/W	0h	Must write 0
7-5	JESD_VER	R/W	0h	000 = JESD204A 001 = JESD204B See the JESD Version and Subclass section for further details.
4-0	0	R/W	0h	Must write 0



12.2.1.11 Register 115 (address = 73h)

図 162. Register 115

15	14	13	12	11	10	9	8
EN_LANE_ID1	EN_LANE_ID2	EN_LANE_ID3	EN_LANE_ID4	EN_ CHECKSUM_ LANE1	EN_ CHECKSUM_ LANE2	EN_ CHECKSUM_ LANE3	EN_ CHECKSUM_ LANE4
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h
7	6	5	4	3	2	1	0
0	0	0	ENABLE_JESD _VER_ CONTROL	0	0	0	0
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h

LEGEND: R/W = Read/Write; -n = value after reset

表 116. Register 115 Field Descriptions

				. Iola Docompilono
Bit	Field	Type	Reset	Description
15	EN_LANE_ID1	R/W	0h	0 = Lane 1 default ID (00001) is set 1 = Lane 1 default ID (00001) can be forced with register 118, bits 12-8
14	EN_LANE_ID2	R/W	0h	0 = Lane 2 default ID (00010) is set 1 = Lane 2 default ID (00010) can be forced with register 118, bits 4-0
13	EN_LANE_ID3	R/W	0h	0 = Lane 3 default ID (00011) is set 1 = Lane 3 default ID (00011) can be forced with register 119, bits 12-8
12	EN_LANE_ID4	R/W	0h	0 = Lane 4 default ID (00100) is set 1 = Lane 4 default ID (00100) can be forced with register 119, bits 4-0
11	EN_CHECKSUM_LANE1	R/W	0h	0 = The default checksum value is calculated by the device 1 = Checksum value (FCHK field in 表 15) is forced from register 116, bits 15-8
10	EN_CHECKSUM_LANE2	R/W	0h	0 = The default checksum value is calculated by the device 1 = Checksum value (FCHK field in 表 15) is forced from register 116, bits 7-0
9	EN_CHECKSUM_LANE3	R/W	0h	0 = The default checksum value is calculated by the device 1 = Checksum value (FCHK field in 表 15) is forced from register 117, bits 15-8
8	EN_CHECKSUM_LANE4	R/W	0h	0 = The default checksum value is calculated by the device 1 = Checksum value (FCHK field in 表 15) is forced from register 117, bits 7-0
7-5	0	R/W	0h	Must write 0
4	ENABLE_JESD_VER_CONTROL	R/W	0h	0 = The device is in JESD204B, subclass 1 mode 1 = JESD version and subclass can be changed; see the 表 15 section for further details.
3-0	0	R/W	0h	Must write 0



12.2.1.12 Register 116 (address = 74h)

図 163. Register 116

15	14	13	12	11	10	9	8		
CHECK_SUM1									
R/W-0h									
7	6	5	4	3	2	1	0		
CHECK_SUM2									
R/W-0h									

LEGEND: R/W = Read/Write; -n = value after reset

表 117. Register 116 Field Descriptions

Bit	Field	Туре	Reset	Description
15-8	CHECK_SUM1	R/W	0h	These bits determine the lane 1 checksum value; see register 135.
7-0	CHECK_SUM2	R/W	0h	These bits determine the lane 2 checksum value; see register 135.

12.2.1.13 Register 117 (address = 75h)

図 164. Register 117

15	14	13	12	11	10	9	8		
CHECK_SUM3									
R/W-0h									
7	6	5	4	3	2	1	0		
	CHECK_SUM4								
	R/W-0h								

LEGEND: R/W = Read/Write; -n = value after reset

表 118. Register 117 Field Descriptions

Bit	Field	Туре	Reset	Description
15-8	CHECK_SUM3	R/W	0h	These bits determine the lane 3 checksum value; see register 136.
7-0	CHECK_SUM4	R/W	0h	These bits determine the lane 4 checksum value; see register 136.



12.2.1.14 Register 118 (address = 76h)

図 165. Register 118

15	14	13	12	11	10	9	8
0	0	0			LANE_ID1		
R/W-0h	R/W-0h	R/W-0h			R/W-0h		
7	6	5	4	3	2	1	0
0	0	0			LANE_ID2		
R/W-0h	R/W-0h	R/W-0h			R/W-0h		

LEGEND: R/W = Read/Write; -n = value after reset

表 119. Register 118 Field Descriptions

Bit	Field	Туре	Reset	Description
15-13	0	R/W	0h	Must write 0
12-8	LANE_ID1	R/W	0h	These bits determine the lane 1 ID value; see register 137.
7-5	0	R/W	0h	Must write 0
4-0	LANE_ID2	R/W	0h	These bits determine the lane 2 ID value; see register 137.

12.2.1.15 Register 119 (address = 77h)

図 166. Register 119

15	14	13	12	11	10	9	8
0	0	0			LANE_ID3		
R/W-0h	R/W-0h	R/W-0h			R/W-0h		
7	6	5	4	3	2	1	0
0	0	0			LANE_ID4		
R/W-0h	R/W-0h	R/W-0h			R/W-0h		

LEGEND: R/W = Read/Write; -n = value after reset

表 120. Register 119 Field Descriptions

Bit	Field	Туре	Reset	Description
15-13	0	R/W	0h	Must write 0
12-8	LANE_ID3	R/W	0h	These bits determine the lane 3 ID value; see register 138.
7-5	0	R/W	0h	Must write 0
4-0	LANE_ID4	R/W	0h	These bits determine the lane 4 ID value; see register 138.



12.2.1.16 Register 120 (address = 78h)

図 167. Register 120

15	14	13	12	11	10	9	8
FORCE_LMFC _COUNT		LMFC_	0	0			
R/W-0h				R/W-0h	R/W-0h		
7	6	5	4	3	2	1	0
0	0 0 0 0					0	0
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h			

LEGEND: R/W = Read/Write; -n = value after reset

表 121. Register 120 Field Descriptions

		•		•
Bit	Field	Туре	Reset	Description
15	FORCE_LMFC_COUNT	R/W	0h	0 = Default value 1 = The LMFC counter value is forced, as per register 120, bits 14-10.
14-10	LMFC_COUNTER_INIT_VALUE	R/W	0h	These bits specify the initial value of the LMFC counter. This option is useful when the multiframe size must be different than the default value; see the <i>Synchronization Using SYNC~ and SYSREF</i> section.
9-0	0	R/W	0h	Must write 0



12.2.1.17 Register 134 (address = 86h)

図 168. Register 134

15	14	13	12	11	10	9	8
EN_LANE_ID5	EN_LANE_ID6	EN_LANE_ID7	EN_LANE_ID8	EN_ CHECKSUM_ LANE5	EN_ CHECKSUM_ LANE6	EN_ CHECKSUM_ LANE7	EN_ CHECKSUM_ LANE8
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h
7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h

LEGEND: R/W = Read/Write; -n = value after reset

(1) This register is valid when JESD_WR_SEL (register 3, bit 5) is 1.

表 122. Register 134 Field Descriptions

Bit	Field	Туре	Reset	Description
15	EN_LANE_ID5	R/W	0h	0 = Lane 5 default ID (00101) is set 1 = Lane 5 default ID (00101) can be forced with register 137, bits 12-8
14	EN_LANE_ID6	R/W	0h	0 = Lane 6 default ID (00110) is set 1 = Lane 6 default ID (00110) can be forced with register 137, bits 4-0
13	EN_LANE_ID7	R/W	0h	0 = Lane 7 default ID (00111) is set 1 = Lane 7 default ID (00111) can be forced with register 138, bits 12-8
12	EN_LANE_ID8	R/W	0h	0 = Lane 8 default ID (01000) is set 1 = Lane 8 default ID (01000) can be forced with register 138, bits 4-0
11	EN_CHECKSUM_LANE5	R/W	0h	0 = Default checksum value calculated by device 1 = Checksum value (FCHK field in 表 15) from register 135, bits 15-8
10	EN_CHECKSUM_LANE6	R/W	0h	0 = The default checksum value is calculated by the device 1 = Checksum value (FCHK field in 表 15) from register 135, bits 7-0
9	EN_CHECKSUM_LANE7	R/W	0h	0 = The default checksum value is calculated by the device 1 = Checksum value (FCHK field in 表 15) from register 135, bits 15-8
8	EN_CHECKSUM_LANE8	R/W	0h	0 = The default checksum value is calculated by the device 1 = Checksum value (FCHK field in 表 15) from register 135, bits 7-0
7-0	0	R/W	0h	Must write 0

12.2.1.18 Register 135 (address = 87h)

図 169. Register 135

15	14	13	12	11	10	9	8				
CHECK_SUM5											
R/W-0h											
7	6	5	4	3	2	1	0				
	CHECK_SUM6										
	R/W-0h										

LEGEND: R/W = Read/Write; -n = value after reset

表 123. Register 135 Field Descriptions

Bit	Field	Туре	Reset	Description
15-8	CHECK_SUM5	R/W	0h	These bits determine the lane 5 checksum value.
7-0	CHECK_SUM6	R/W	0h	These bits determine the lane 6 checksum value.



12.2.1.19 Register 136 (address = 88h)

図 170. Register 136

15	14	13	12	11	10	9	8				
CHECK_SUM7											
R/W-0h											
7	6	5	4	3	2	1	0				
	CHECK_SUM8										
	R/W-0h										

LEGEND: R/W = Read/Write; -n = value after reset

表 124. Register 136 Field Descriptions

Bit	Field	Туре	Reset	Description		
15-8	CHECK_SUM7	R/W	0h	These bits determine the lane 7 checksum value.		
7-0	CHECK_SUM8	R/W	0h	These bits determine the lane 8 checksum value.		

12.2.1.20 Register 137 (address = 89h)

図 171. Register 137

15	14	13	12	11	10	9	8					
0	0	0	LANE_ID5									
R/W-0h	R/W-0h	R/W-0h	R/W-0h									
7	6	5	4	3	2	1	0					
0	0	0	LANE_ID6									
R/W-0h	R/W-0h	R/W-0h	R/W-0h									

LEGEND: R/W = Read/Write; -n = value after reset

表 125. Register 137 Field Descriptions

Bit	Field	Туре	Reset	Description
15-13	0	R/W	0h	Must write 0
12-8	LANE_ID5	R/W	0h	These bits determine the lane 5 ID value.
7-5	0	R/W	0h	Must write 0
4-0	LANE_ID6	R/W	0h	These bits determine the lane 6 ID value.



12.2.1.21 Register 138 (address = 8Ah)

図 172. Register 138

15	14	13	12	11	10	9	8				
0	0	0	LANE_ID7								
R/W-0h	R/W-0h	R/W-0h	R/W-0h								
7	6	5	4	3	2	1	0				
0	0	0	LANE_ID8								
R/W-0h	R/W-0h	R/W-0h	R/W-0h								

LEGEND: R/W = Read/Write; -n = value after reset

表 126. Register 138 Field Descriptions

Bit	Field	Туре	Reset	Description
15-13	0	R/W	0h	Must write 0
12-8	LANE_ID7	R/W	0h	These bits determine the lane 7 ID value.
7-5	0	R/W	0h	Must write 0
4-0	LANE_ID8	R/W	0h	These bits determine the lane 8 ID value.



13 デバイスおよびドキュメントのサポート

13.1 ドキュメントのサポート

13.1.1 関連資料

CDCE72010データシート、SCAS858

CDCM7005データシート、SCAS793

LMK048Xデータシート、SNAS605

SN74AUP1T04データシート、SCES800

『高速データ・コンバータのクロック供給』、SLYT075

13.2 コミュニティ・リソース

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

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13.5 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

14 メカニカル、パッケージ、および注文情報

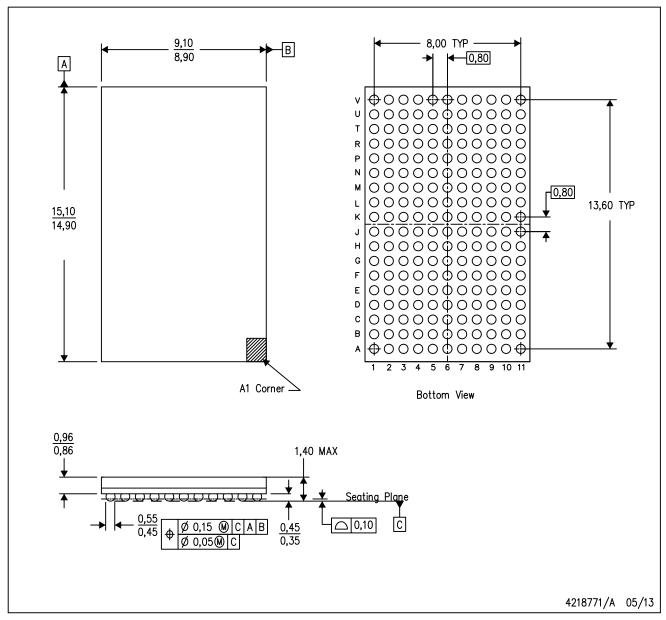
以降のページには、メカニカル、パッケージ、および注文に関する情報が記載されています。これらの情報は、指定のデバイスに対して提供されている最新のデータです。このデータは予告なく変更されることがあり、ドキュメントが改訂される場合もあります。本データシートのブラウザ版を使用されている場合は、画面左側の説明をご覧ください。



MECHANICAL DATA

ZZE (R-PBGA-N198)

PLASTIC BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- 3. This drawing is subject to change without notice.
- C. This is a Pb-free solder ball design.

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PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
						(4)	(5)		
ADS52J90ZZE	Active	Production	NFBGA (ZZE) 198	160 JEDEC TRAY (5+1)	Yes	SNAGCU	Level-3-260C-168 HR	-40 to 85	ADS52J90
ADS52J90ZZE.A	Active	Production	NFBGA (ZZE) 198	160 JEDEC TRAY (5+1)	Yes	SNAGCU	Level-3-260C-168 HR	-40 to 85	ADS52J90

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

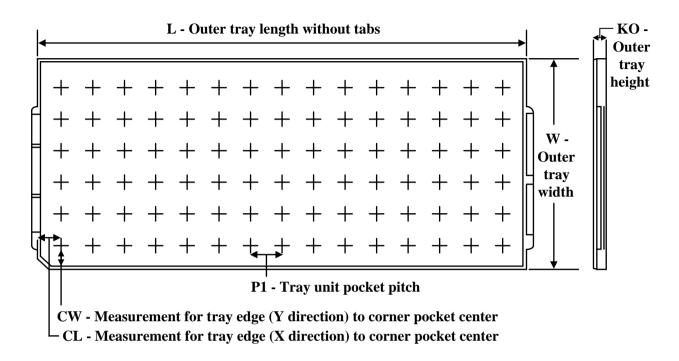
⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



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TRAY



Chamfer on Tray corner indicates Pin 1 orientation of packed units.

*All dimensions are nominal

	Device	Package Name	Package Type	Pins	SPQ	Unit array matrix	Max temperature (°C)	L (mm)	W (mm)	Κ0 (μm)	P1 (mm)	CL (mm)	CW (mm)
	ADS52J90ZZE	ZZE	NFBGA	198	160	10 x 16	150	315	135.9	7620	19.2	13.5	10.35
ı	ADS52J90ZZE.A	ZZE	NFBGA	198	160	10 x 16	150	315	135.9	7620	19.2	13.5	10.35

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